

Elektor Electronics

Peak indicator for loudspeakers
ZAP51 - an 8751 programmer
Build the opticalock
Fiber optics - Part 1
Central car locking control
Understanding the EDIF standard

FREE in this issue:
wall chart of PC connectors



In next month's issue

- Electronic hygrometer
- AC detector
- Function generator [1]
- 50 MHz 8-bit DAC
- A review of coding theory
- Four-terminal networks
- Audio spectrum shift techniques

Front cover

Maps and charts on a constantly changing video wall—at 25 m (80 ft) the largest in Europe—give up-to-the-minute pictures of how Britain's telephone networks are performing, highlighting potential trouble spots. BT's World-wide Network Management Centre at Oswestry receives every six hours data equivalent to the contents of the *Encyclopædia Britannica*. BT says that its digital network is more comprehensive in comparative terms than that of any major operator. The centre currently monitors all the organization's processor-controlled System X exchanges—57 in the trunk network and 373 local units. It also monitors the company's three digital international exchanges and 1500 routes linking its UK network to 199 countries.

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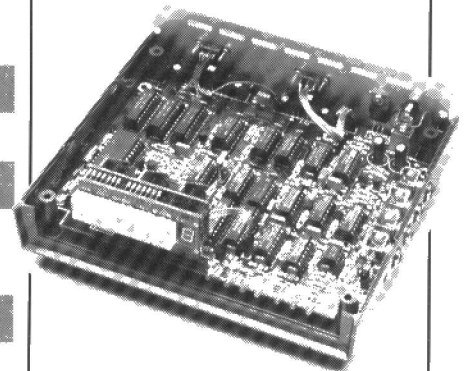
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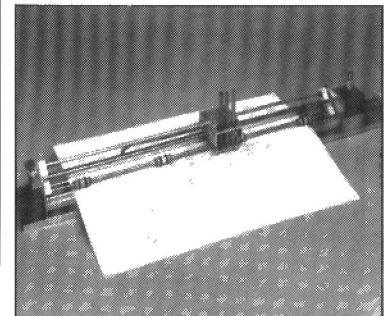
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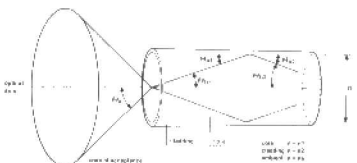
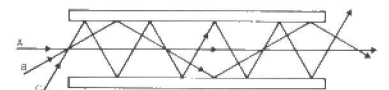
Electronics scene 12, 13; Events 13; Corrections 28; Letters 56;
New books 57; Readers services 61; Switchboard 62;
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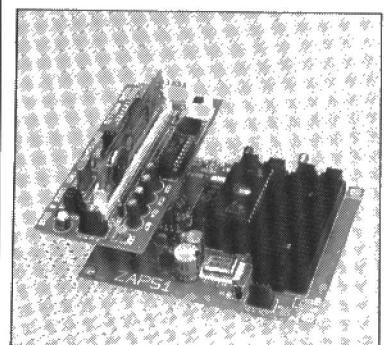
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COMPUTERS MADE EXPERT IN REAL TIME

IN A large processing plant it is often the case that no one person can completely comprehend what is happening at any given time. Even where such an expert does exist, he or she will not always be on hand, so there must be some dependence on less experienced people.

A particular problem is that the large amount of data available from increasingly complex plant can hinder corrective action in an emergency, because its sheer volume obscures the real problems.

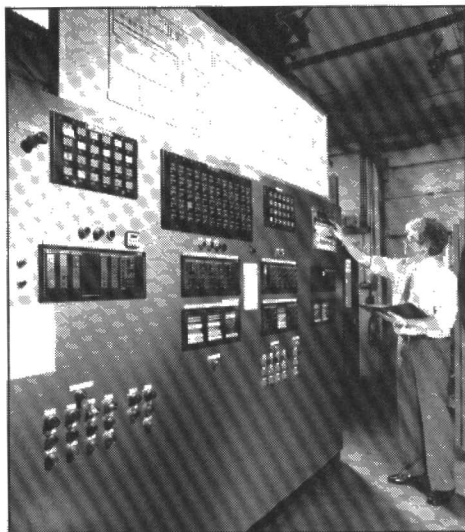
Computer-driven expert systems will be used more and more widely as aids to operators to control and monitor process plant safely as it becomes more complex and located over a larger area. Using data captured automatically from the process by the computer, the expert system will carry out much of the basic decision-making, supporting the superior reasoning of the operator.

An expert system is a computer program that contains the distilled knowledge of an expert or experts. This knowledge is in the form of rules the computer uses to mimic the human decision-making process, most commonly on the lines of the formula IF-THEN-ELSE, that is, 'if these conditions apply, then take this action, or else ...'.

In this way, the expert system aids the user in making decisions in a given set of circumstances, bringing both speed and confidence to the process.

Real time system

It is also conceivable that expert systems, which are a leading-edge application of the futuristic computer technology of artificial intelligence, could make simple decisions unaided. This possibility is closely related to the trend of running some types of processing plant unmanned, for example, for week-end or overnight operation.



The control room at the British Gas Midlands Research Station.

To make unmanned running feasible, the controlling system would need a primitive form of decision-making intelligence like that of an expert system. For an expert system to assist effectively in the on-line monitoring and control of a continuous process, it has to operate in real time. A real-time system is one that can receive continuously changing data from outside sources and, to process that data sufficiently rapidly, is capable of influencing those sources.

A new British product, Cogsys, is said to be the first generally available expert system for industrial plant monitoring that takes the time factor into account. Its ability to reason in real time means it 'knows' that, if a certain situation is seen to be developing, the plant operator should be advised within a given interval. It can also be programmed to follow trends in monitored plant parameters on a

time basis, and is able to predict future developments in the light of continuously changing plant readings.

Supervisory role

Cogsys comprises an expert system shell – that is, the basic software program, excluding the process-specific expert knowledge that makes it an expert system – into which is fed information acquired from a human expert about each particular plant where it is used. It also has a run-time system to monitor the plant. A general-purpose interface allows direct access to plant data as well as communication with devices such as programmable logic controllers.

The expert system does not provide direct digital control of a process plant; rather, it has a supervisory role with or without operator intervention. It is capable of general alarm analysis and fault-finding, data validation and reduction, and it can use historical data to maintain product quality and analyse plant performance. An important feature of Cogsys is its ease of configuring, so plant engineers can operate it after only a brief period of training.

Two British companies representing two very different areas of industrial process control were selected to pioneer the application of Cogsys.

Monitoring and control

The first was CBM Technology, where the expert system has been applied to a plastics blow moulding machine making laminated plastics bottles. Cogsys is used to monitor and control the complex relationship between the variables that control bottle weight.

Cogsys is interfaced with the blow moulding machine's existing control system, based on Intel single-chip microcomputers and multibus equipment linked to a DEC 3100

Produced and published by **ELEKTOR ELECTRONICS (Publishing)**

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Broomhill Road
LONDON SW18 4JQ
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or +44 81877 1688 (International)
Telex: 917003 (LPC G)
Fax: 081-874 9153 (National)
or +44 81874 9153 (International)

Advertising: PRB Limited
3 Wolsley Terrace
CHELTENHAM GL50 1TH
Telephone: (0242) 510760
Fax: (0242) 226626

Subscriptions:
World Wide Subscription Service Ltd.
Unit 4, Gibbs Reed Farm
Pashley Road
TICEHURST TN5 7HE
Telephone: (0580) 200657 (National)

or +44 580 200 657 (International)
Telefax: (0580) 200616 (National)
or +44 580 200 616 (International)

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Postbus 75
6190 AB BEEK
The Netherlands
Telephone: +31 46 38 94 44
Telex: 56617 (elekt.nl)
Fax: +31 46 37 01 61
Managing Director: M.M.J. Landman

Distribution:
SEYMOUR
1270 London Road
LONDON SW16 4DH

Printed in the Netherlands by NDB,
Zoeterwoude

Overseas editions:
FRANCE
Elektor sarl
Les Trois Tilleuls
B.P. 59: 59850 NIEPPE
Editors: D.R.S. Meyer; G.C.P. Raedersdorf

GERMANY
Elektor Verlag GmbH
Süsterfeld Straße 25
5100 AACHEN
Editor: E.J.A. Krempelsauer
GREECE
Elektor EPE
Kariskaki 14
16673 Voula - ATHENA
Editor: E. Xanthoulis
HUNGARY
Elektor Elektronikai folyóirat
1015 Budapest
Batthyány u. 13
Editor: Lakatos András
INDIA
Elektor Electronics PVT Ltd
Chhotani Building
52C, Proctor Road, Grant Road (E)
BOMBAY 400 007
Editor: C.R. Chandarana
ISRAEL
Elektorcal
P.O. Box 41096
TEL AVIV 61410
Publisher: M. Avraham

NETHERLANDS
Elektuur BV
Peter Treckpoelstraat 2-4
6191 VK BEEK
Editor: P.E.L. Kersemakers
PORTUGAL
Ferreira & Bento Lda.
R.D. Estefani, 32-1^{oo}
1000 LISBOA
Editor: Jeremias Sequeira
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Resistor Electronica Aplicada
Calle Maudes 15 Entlo C.
28003 MADRID
Editor: Agustin Gonzales Buelta
SWEDEN
Electronic Press AB
Box 5505
14105 HUDDINGE
Editor: Bill Cedrum
USA & CANADA
Elektor Electronics USA
P.O. Box 876
PETERBOROUGH NH 03458-0876
Publisher: Edward T. Dell

(Digital Equipment Corporation) workstation. Interfacing with the machine's controllers and with a stand-alone workstation allows Cogsys to collect real-time data and data input by the operator.

The expert system is backed up by statistical process control techniques used to provide a graphical representation of product quality.

The second pioneer is British Gas which, at its research station in the Midlands, has also applied the Cogsys expert system to real-time process control. Specifically, it is using an expert system to provide decision support to process engineers operating a small gas synthesis plant supplying research and development staff with gas for research activities.

The roles of the expert system include advising on optimum control strategy, monitoring alarms, and providing a detailed operating procedure consistent with the state of the plant.

At the research station, the expert system interfaces with 15 control devices within the plant, and with some 100 analogue and digital points through a serial link to a DEC MicroVax computer, enabling the plant to be monitored and controlled by non-expert personnel.

Computer language

The objective of this application is to show how less-skilled staff, aided by an expert

system, could in future operate a complex plant safely and efficiently. Cogsys gives advice on plant efficiency, and offers alarm handling and analysis. It also provides control loop optimization at a supervisor set-point level and analyses trends for condition monitoring and operational guidance. Operating procedure advice is given by text animation.

Currently, Cogsys is written to run on DEC computers using the DEC VMS operating system. It is planned to make the software available to run on other computers.

The widely used artificial intelligence language POPLOG, originally developed at Sussex University, was selected to develop the expert system shell and interfaces, with C as the language chosen for the run-time system. Easy input of data into the run-time system by plant operators was a fundamental design requirement.

Joint venture

Cogsys is the result of several years research and development involving 37 companies, including Rolls-Royce, Shell, Courtaulds and British Gas. It is one of the first commercial joint ventures to result from the government-sponsored Alvey Project set up in the early 1980s to stimulate joint university and industry research and development projects.

Cogsys was developed by SD-Scicon, a company working on the application of artificial intelligence to industrial automation

since the early 1980s and with one of the largest artificial intelligence development groups in Europe. The company was recently called on by the Department of Trade and Industry to carry out a study of the uses to which expert systems are being put in Britain.

To market Cogsys and other industrial automation software based on artificial intelligence, a new venture company, Cogsys Ltd, has been formed by British Gas, SD-Scicon and Salford University Business Enterprises.

CBM Packaging Technology PLC,
Denchworth Road, Wantage OX12 9BP,
Telephone (0235) 772 929.

British Gas PLC, Midlands Research Station,
Wharf Lane, Solihull B91 2JW,
Telephone 021 705 7581.

SD-Scicon Ltd, Pembroke House, Pembroke
Broadway, Camberley, Surrey,
Telephone (0276) 686 200.

Cogsys Ltd, Enterprise House, Unit 37,
Salford University Business Park,
Salford M6 6AJ, Telephone 061 745 7604.

Salford University Business Enterprises –
same address as Cogsys Ltd, above.

BOOST FOR AUTOMOTIVE ELECTRONICS SALES?

A REPORT from Frost & Sullivan predicts that new legislation in western Europe governing vehicle exhaust emissions and passenger safety will cause spiralling sales of non-entertainment automotive electronics (OE) in coming years, reaching an annual revenue of well over £2 billion by 1995.

Since the market for OE in western Europe is still in its infancy compared with North America and Japan, penetration levels, which will bring with them a drop in prices, will appear even more impressive.

INTELLECTUAL PROPERTY RIGHTS

DURING the European Telecommunications Standards Institute's 10th Technical Assembly at Nice in June, concern was expressed to reconcile the needs of standardization with the world of Intellectual Property Rights. After a debate lasting a full day, the Assembly agreed on the direction it wants its Intellectual Property Rights Committee to take to overcome the defects of the guidelines currently used by the International Standards Organization—ISO. The Assembly decided that the transparency needed to ensure its standards should not be blocked by patent holders making unreasonable demands. These conditions could no longer be guaranteed by a purely voluntary IPR policy.

The ETSI Intellectual Property Rights Committee will produce a draft undertaking

ELECTRONICS SCENE

that will be legally binding on its members. This will require a delicate balance between the rights of patent holder and the benefits of widely applied ETSI standards. The aim is for patent holders to have a fair and reasonable reward if their patents are infringed. At the same time, other members would have assurances that licences would never be withheld or discriminatory.

ETSI aims to finalize its policy by the end of the year.

NEW DIGITAL LOGIC CIRCUIT SIMULATOR PROGRAM

NUMBER One Systems Ltd have announced a new Digital Logic Circuit Simulator Program, called PULSAR, which is aimed at freeing engineers from the frustrations of designing with a scope and soldering iron.

PULSAR enables a design to be tested and proved before a single component is soldered, and without the need of expensive test equipment. It will handle bistables, monostables, latches, three-state and open-collector gates in addition to normal types.

The program contains a full component library facility that allows the user to add components, modules and sub-circuits to the full range of 74LS and 4000 series models supplied with it.

PULSAR may be operated independently, entering and modifying circuit data through an interactive Netlist Editor, but is also ready to link in with the forthcoming EASY-PC Professional Schematic Capture package and the ANALYSER III Linear Circuit Analyser to form a completely integrated Electronics Engineering Design System.

The program is priced at £195.00, complete with comprehensive manual. It is not copy-protected.

Number One Systems Ltd, Harding Way, Somersham Road, St. Ives, Huntingdon PE17 4WR, Telephone (0480) 61778.

IBC: CALL FOR PAPERS

A CALL for papers has been issued by the organizers of the Fourteenth International Broadcasting Convention—IBC—to be held in Amsterdam from 3 to 7 July 1992.

IBC has a reputation for high-quality papers on state-of-the-art developments and the convention proceedings are an essential work of reference for all aspects of current and future broadcast technology.

To allow for comprehensive coverage of the widest range of topics possible, there will be two parallel streams with time allocated for discussion. Among the many topics to be covered are advanced, compatible and higher definition television systems; analogue and digital audio recording; studio and network distribution; encryption, subscription and pay-TV; terrestrial transmission and reception; cable distribution systems; and

test and measurement technology.

Synopses of about 800 words are invited, which must reach the IBC Convention Office by 11 November 1991. Full papers, which will be vetted independently, will be required by 1 March 1992.

IBC Convention Office, Savoy Place, London WC2R 0BL.

GREEN LIGHT FOR ENGINEERING MERGER

IN A move that strengthens the UK engineering profession, members of both the Institution of Electrical Engineers and the Institution of Manufacturing Engineers (formerly the Institution of Production Engineers) have voted to join forces and create a combined institution to meet the challenges presented by rapidly changing technologies.

The proposals will come into effect on 1 October 1991. The IEE (110,000 members) and the IMfGE (20,000) will jointly form the largest of the 46 British engineering institutions. A new Manufacturing Division will be created within the new institution that, with some 40,000 members, will be one of the most powerful voices for the UK manufacturing industry.

NEW BOARDMAKER-2 PCB CAD PACKAGE

TSIEN has announced a new release of its Boardmaker-2 PCB CAD package for electronics professionals—Version 2.4—building on proven benefits of the system to further boost productivity and speed design

cycles. Among new facilities for the PC-based software are more schematic capture inputs, artwork output options and numerous powerful CAD functions, including top-down modification, providing an efficient and comprehensive design-to-manufacture environment for just £295.00. The top-down modification makes it simple to introduce modifications to existing designs. Schematic changes now automatically modify PCB layout and netlist files, leaving unchanged sections of the PCB layout alone and presenting the designer with just the modified areas for rework.

Tsien (UK) Ltd, Cambridge Research Laboratories, 181A Huntingdon Road, Cambridge CB3 0DJ, Telephone (0223) 277777.

ANIMATED CIRCUITS FOR EDUCATION

AT THE recent Leetronex Electronics Exhibition at Leeds University, Labcenter Electronics introduced their Animated Circuits for Education—ACE—software package for the IBM PC that combines circuit simulation with animation to produce animated circuit diagrams. Colour shows voltage, while dot motion shows current flow. The result is an instantly comprehensible, time-evolving view of circuit operation: something that even banks of test gear connected to a real circuit can not give you.

The program was presented by its author, Dr Bob Gomersall, Head of Physics, Bradford Grammar School.

Labcenter Electronics, 14 Mariners Drive, Bradford BD9 4JT, Telephone (0274) 542868, Fax (0274) 481078.

NEW PORTABLE SURFACE CONDUCTIVITY METER

THE measurement of surface conductivity of static dissipative or insulating materials is important for the elimination of static electricity that can destroy sensitive semiconductors and form a hazard in areas where flammable or explosive substances are handled. Hiltek's new portable surface conductivity test set is designed for use in factories, warehouses and laboratories, and measures from 10^7 to $10^{13} \Omega \text{ m}^{-1}$. This is the resistivity range where static build-up can be a problem, but also where it can be eliminated.

Hiltek Ltd, Breedhurst Road, Detling, Maidstone ME14 3EB, Telephone (0622) 47472.

CDR FILTERING MADE EASY

SILICON Systems's new 32F8020, with a frequency range of 1.5–8.0 MHz and programmable pulse slimming equalization (0–9 dB high-frequency boost), greatly eases Constant Density Recording—CDR—filtering. It also extends the company's line of filter ICs to include audio/video tape, floppy and optical drives and ultrasound imaging applications.

The new chip provides an electronically controlled low-pass filter with a separate differentiated low-pass output. A seven-pole, 0.05° Equiripple-type linear-phase, low-pass filter comes with a single-pole, single-zero differentiator. Both outputs have matched delays.

Silicon Systems, 14351 Myford Road, Tustin, CA 92680, USA, Telephone (714) 731-7110, Fax (714) 669 8814.

EVENTS

IEE AND IEEIE PROGRAMME

- 2–5 Sept—Digital processing of signals in communications (sixth international conference at Loughborough University)
- 2–6 Sept—Circuit theory and design (tenth European conference at Copenhagen)
- 9–12 Sept—Microwave (twenty-first European conference at Stuttgart)
- 9–12 Sept—Optical communication (seventeenth European conference in Paris)
- 9–13 Sept—Railway signalling and train control systems (vacation school at University of Birmingham)
- 11–13 Sept—Electrical machines and drives (fifth international conference at Savoy Place)
- 11–13 Sept—Algorithms and architectures for real-time control (workshop at the University of Wales, Bangor)
- 15–20 Sept—Electromagnetic compatibility (vacation school at University of Kent)
- 16–18 Sept—Software engineering for real-time systems (third international conference at Cirencester)
- 16–18 Sept—Analogue-to-digital and digital-to-analogue conversion (international conference at University College Swansea)
- 17–20 Sept—AC and DC power transmission (fifth international conference at Savoy Place)

- 22–25 Sept—Sensors and their applications (IoP Fifth conference in Edinburgh)
- 22–27 Sept—Microwave measurements (vacation school at University of Kent)
- 23–24 Sept—Personal, indoor and mobile radio communications (international symposium at King's College, London)

Information on these, and many other, events may be obtained from the IEE, Savoy Place, London WC2R 0BL, Telephone 071 240 1871 or from the IEEIE, Savoy Hill House, Savoy Hill, London WC2R 0BS, Telephone 071 836 3357.

Haverling College of Further and Higher Education will run a **Radio Amateur Examination** preparation class starting on Monday 9 September and a **Morse Examination** class starting on Thursday 12 September. For more information write to Stuart Woosnam, G0NKP, or Chris Potarzycki, G0NJR, at Haverling College of F & HE, Quarles Campus, Tring Gardens, Harold Hill, Romford RM3 9ES,

or ring the Department of Electronics and Engineering Technology on 04023 81460, ext. 7131.

The International Electronics Design Conference will be held at the National Exhibition Centre, Birmingham, from 24 to 26 September in conjunction with the 1991 Electronics Design Show. For more information, contact MGB Exhibitions Ltd, Marlowe House, 109 Station Road, Sidcup DA15 7ET, Telephone 081 302 8585.

During September, Frost & Sullivan will conduct seminars on, among others, Novell Local Area Networks. Further information from Frost & Sullivan, Sullivan House, 4 Grosvenor Gardens, London SW1W 0DH, Telephone 071 730 3438.

Vision & Audio '91 will return to London's Earls Court, running from 15 to 18 September in the brand new No. 2 exhibition hall. For more information, contact Denise Pritchard or Lucinda de Freitas at EGA Communications, 11 Jew Street, Brighton BN1 1UT, Telephone (0273) 23889.

This little circuit, designed and marketed as a kit by ELV, provides a visual warning when the maximum drive power to a loudspeaker is approached. The sensitivity of the circuit can be set to power levels between 1 W and 300 W. Connected in parallel with the loudspeaker terminals, the peak indicator is simple to build, and does not require a separate power supply.



THE power applied to a loudspeaker drive unit is disproportional to the volume, which is a subjective quantity. In practice, this means that doubling the volume requires more than double the drive power. It is for this, and other, reasons that the maximum permissible power applied to a loudspeaker is difficult to determine subjectively, i.e., by listening. Unfortunately, this has caused the destruction of many an expensive loudspeaker drive unit, although we must hasten to add that many drive unit manufacturers and suppliers state peak power ratings that are, to put it mildly, on the high side.

Adjusted to a sensible indication level, the present peak indicator gives you ease of mind as far as the protection of your costly loudspeakers is concerned. First, however, consider the difference between the following power specifications of a loudspeaker: continuous power, music power, peak power and pulse power. In general, the indication level of the peak power monitor should be based on the continuous power rating of the loudspeaker — but only if you have reason to believe that this value makes sense, in other words, that it is not grossly exaggerated by the manufacturer. In some cases, this means that you have to set an indication level as low as 50% of the continuous power rating stated by the manufacturer.

Such a 'conservative' setting of the peak power indication may cause the LED on the unit to light briefly at times, that is, when the corresponding volume is at all desired. When the volume is increased further, the LED starts to flash shorter and at a lower rate. This is an indication that the maximum safe power level has been reached, and that

the volume should be reduced to prevent damage to the loudspeaker (and, even more importantly, your ears).

The circuit

Two flexible wires are used to connect the input of the peak indication circuit in parallel with the loudspeaker terminals. This results in the loudspeaker drive voltage being applied to PCB terminals ST1 and ST2. The polarity of the drive signal is irrelevant, since the input signal is rectified by D1-D2 (see

Fig. 1), and assumed to be symmetrical.

The input voltage (supplied by the amplifier) also serves to power the circuit. This is achieved by rectifying and smoothing the input signal with the aid of diode D2 and smoothing capacitor C2. Resistor R4 serves to increase the internal resistance of the circuit, and so prevents waveform distortion of the input signal.

The input voltage is also applied to a potential divider, R1-R2, via diode D1. The signal at junction R1-R2 is fed to the base of transistor T1 via a series resistor, R3, and a

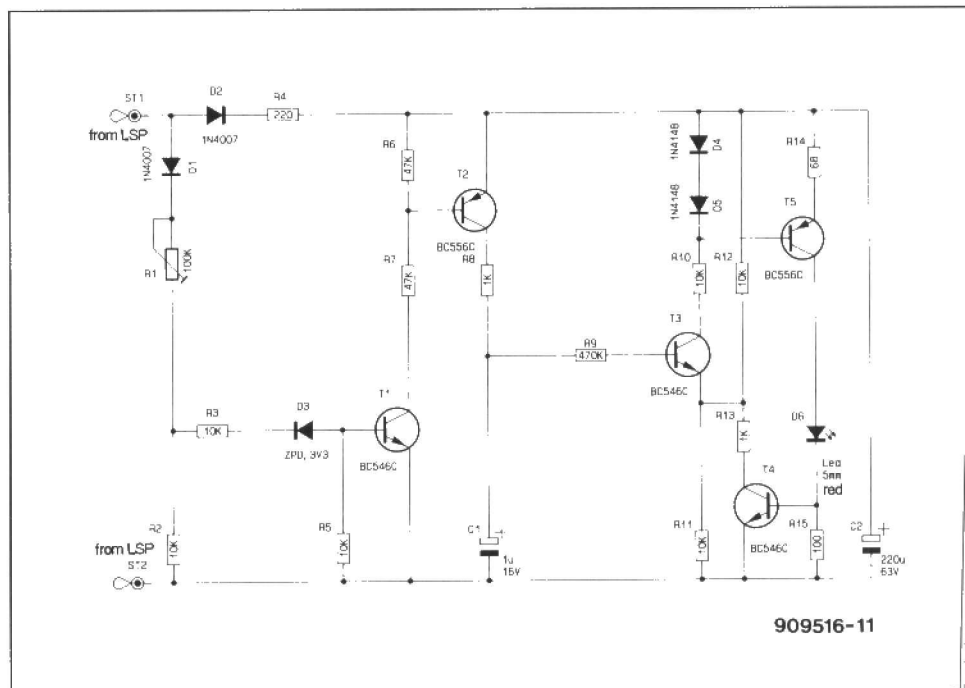


Fig. 1. Circuit diagram of the peak indicator. Note that the circuit is powered by the drive signal supplied by the amplifier.

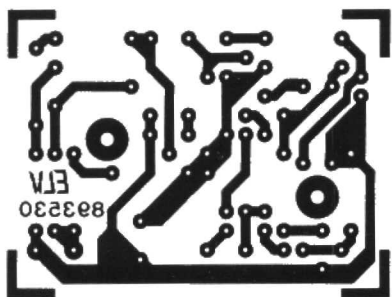
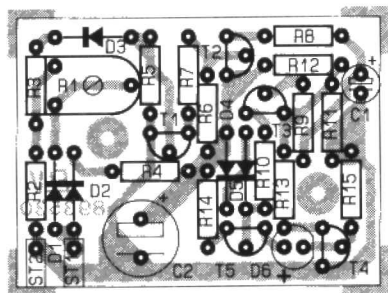


Fig. 2. The printed-circuit board for the peak indicator is small and single-sided.

zener diode, D3. The diode serves to set up a well-defined switching threshold. Resistors R5 and R3 are dimensioned such that T1 is kept off in the absence of an input signal.

When the voltage at junction R1-R2 exceeds 4.5 V, T₁ starts to conduct. Consequently, T₂ is driven via R₇, which causes capacitor C₁ to be charged via R₈. As soon as the charge voltage exceeds about half the supply voltage (measured across C₂), transistor T₃ starts to drive a constant current

Table 1. Circuit actuation levels

U_{LSP} (V)	Power (W)		
	4 Ω	8 Ω	16 Ω
5.7	4	2	1
6.3	5	2.5	1.25
8.9	10	5	2.5
11.0	15	7.5	3.75
12.6	20	10	5
15.5	30	15	7.5
17.9	40	20	10
20.0	50	25	12.5
25.3	80	40	20
28.3	100	50	25
34.6	150	75	37.5
40.0	200	100	50
44.7	250	125	62.5
49.0	300	150	75

COMPONENTS LIST

Content of kit supplied by ELV

Resistors:

- | | | |
|---|----------------|--------------------------|
| 1 | 68Ω | R14 |
| 1 | 100Ω | R15 |
| 1 | 220Ω | R4 |
| 2 | 1kΩ | R8;R13 |
| 6 | 10kΩ | R2;R3;R5;R10;
R11;R12 |
| 2 | 47kΩ | R6;R7 |
| 1 | 470kΩ | R9 |
| 1 | 100kΩ preset H | R1 |

Capacitors:

- | | | |
|---|-----------------|----|
| 1 | 2 μ F 63V | C1 |
| 1 | 220 μ F 63V | C2 |

Semiconductors:

- | | | |
|---|----------------------|----------|
| 2 | BC556 | T2;T5 |
| 3 | BC546 | T1;T3;T4 |
| 1 | 3V3 0.4W zener diode | D3 |
| 2 | 1N4007 | D1;D2 |
| 2 | 1N4148 | D4;D5 |
| 1 | red LED | D6 |

Miscellaneous:

- 2 PCB soldering pin
1 printed-circuit board

source, D4-D5-T5-R14, which in turn sends a current of about 10 mA through the indicator LED, D6. This lights to signal the overload condition.

At the same time, the constant current causes T4 to start conducting, so that the potential at the emitter of T3 drops to a fraction of the previously established half supply voltage. This creates an amount of hysteresis sufficient to cause the indicator to light for about half a second, even when the overload condition at the input was pulse-like. When no further overload levels are detected, C1 is no longer charged, and starts to discharge via R9, the base-emitter junction of T3, and R11-R13-T4, until the voltage drops below the switching threshold of T3. When that happens, transistors T3, T4 and T5 are switched off, and the LED, D6, goes out.

Preset R1 allows the sensitivity of the circuit to be set between 1 W and 300 W. The corresponding input voltage levels are summarized in Table 1.

Construction

All components are accommodated on the small printed circuit board shown in Fig. 2 (size: approx. 35×48 mm, or 0.14×0.19 inch). Start the construction by fitting and soldering the low-profile parts shown on the component overlay. Then follow the taller components. Take care to fit the polarized components (the diodes, electrolytic capacitors, transistors and the LED) the right way around. The cathode (negative connection) of the LED is the terminal with the tab near the underside of the plastic body. Fortunately, the LED will not normally be damaged when fitted the wrong way around, at

A complete kit of parts for the peak indicator is available from the designers' exclusive worldwide distributors:

ELV France

B.P. 40

F-57480 Sierck-Les-Bains
FRANCE

Telephone: +33 82837213

Fax: +33 82838180

least, so long as the reverse voltage is not excessive.

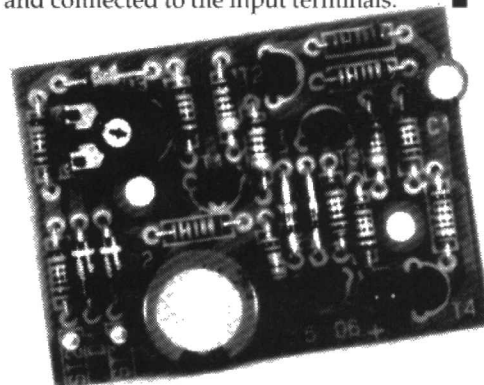
Adjustment

Run a thorough visual check on the completed printed circuit board before carrying out the first electrical tests. These require a stabilized, adjustable d.c. power supply. Depending on the supply voltage, the circuit draws a few milliamps when the LED is out, or 10 mA or so when the LED is on. In any case, the current requirement is never higher than 20 mA.

Determine the power at which you want the indication to be actuated, and take the required switching threshold from Table 1. For instance, when a level of 100 W is required for a loudspeaker with an impedance of 4 Ω , the threshold works out at 28.3 V. Similarly, for 10 W into 16 Ω , the switching threshold is 17.9 V.

Set the desired threshold voltage on the stabilized PSU, and connect the positive output to ST1 of the peak indicator, and the negative output to ST2. Set preset R1 to its maximum value, i.e., turn it fully clockwise. The LED must remain off at this point. Next, carefully turn R1 anti-clockwise until D6 lights. Leave R1 at this setting. Reduce the test voltage. The LED should remain on for a while as a result of the relatively large hysteresis. When it goes out, increase the test voltage again. Keep an eye on the applied voltage. The LED should light at the previously set voltage level. If not, carefully redo the adjustment of R1.

Since the LED is supplied from a constant current source, it will light at a virtually constant intensity irrespective of the actually measured loudspeaker voltage. After the adjustment, the circuit may be fitted at a suitable position in the loudspeaker enclosure, and connected to the input terminals. ■



CENTRAL LOCKING CONTROL

by Dip. Eng. S. Zipp

Most new cars are now provided with a central locking system, either as standard (most) or as an optional extra, sometimes combined with an anti-theft system. If you are one of the unfortunate many who can not (yet) afford a new car, but would like the many benefits of a central locking system, the project described in this article may well be for you.

NOT all variants of a particular model of car are fitted with central locking. It is possible to have such variants modified at a late date, but that is invariably more expensive than buying a relevant kit from a car accessory dealer. In many countries, there are two DIY kits of parts available: one for the front doors only, and the other for all four doors. We don't know of a kit that also caters for the boot or, in case of a hatchback, the fifth door.

The two-door kit contains two master modules that must be coupled to the opening mechanism in each door. Each module contains an electric motor that via suitable gearing raises or lowers a lock shaft by about 50 mm. The lock shafts must be mechanically coupled to the existing doorlock mechanism. When the modules are fitted to both front doors, simultaneous locking or unlocking of both doors can be done from either doorlock.

The four-door kit contains two master modules and two slave modules. All four doors can be locked and unlocked from either front door, but neither of the rear door locks can control the other doors.

The main difference between a master module and a slave module is that the former has an additional electrical change-over contact that ascertains the position of the key in the lock.

The kits also contain a small PCB, on which the electronic control circuits are housed. These circuits interpret the position of the switch contacts and control the power required by the motors. They can not be modified for the control of say, four or five masters, and, in some cases, are not infallible.

In view of the limitations of the electronics part of these kits, it was felt that a far more sophisticated circuit would not come amiss. Moreover, the proposed circuit also offers the possibility of being operated by an infra-red remote control.

Circuit description

The circuit—see Fig. 1—is fairly straightforward and uses only a handful of components. It is suitable for the control of up to four master modules and two slave modules.

When the lock on a master-controlled door



is operated, the ensuing signal from the relevant change-over contacts in the master module is applied to one of the inputs of quadruple Schmitt trigger IC₁ via an RC-type low-pass filter. This manifests itself as a voltage jump at one of the outputs of the Schmitt trigger, and this is registered at inputs A0–A3 and B0–B3 of comparator IC₂. Because of the RC-type low-pass filters at inputs B0–B3, the signal at these inputs is delayed slightly. Consequently, the level at the A=B output of the comparator changes from high to low and this triggers monostable IC₃, which is a non-retriggerable type 4538.

During the monotime, which is determined by time-constant R₁₃–C₉, the output of the monostable is high, so that transistor T₁ is switched on and relay Re₃ is energized. As long as this condition pertains, and only for so long, the battery supply line to the motors of all modules is completed via the rest contacts of relays Re₁ and Re₂.

It follows that the mono time must be long enough to allow the motors operating the lock shaft, thereby locking or unlocking all the doors. On the other hand, the mono time must not be too long, since the motors in their stop position draw maximum cur-

rent and overheat quickly. The proposed time of 220 ms has proved ideal in use with a number of different kits. If, nevertheless, problems are experienced, the time can be made longer by increasing the value of R₁₃ and/or C₉, and made shorter by reducing the value of these components.

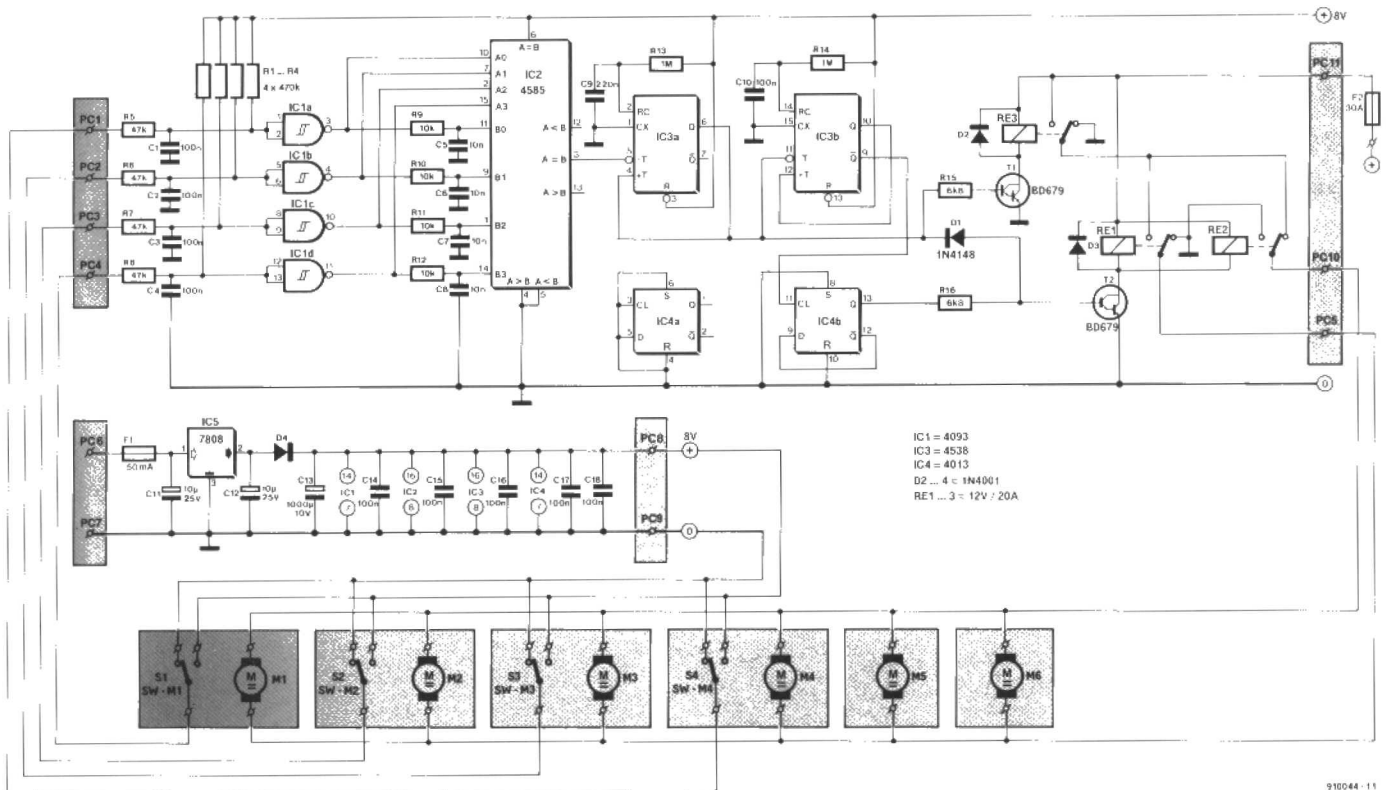
The direction of rotation of the motors depends on the position of the contacts of Re₂ and Re₃. The change-over contacts of these relays are arranged as reversing switches. Since the motors have to change direction every time a key is turned, their latest direction is stored in D-bistable (US: flip-flop) IC_{4b}, which functions as a binary scaler (US: scale-of-two counter). When the Q-output of this stage is high and the monostable is active (AND-gated via D₁), transistor T₂ toggles and relays Re₁ and Re₂ are energized.

When the Q-output of IC_{4b} is low, relays Re₁ and Re₂ are quiescent and the polarity of the voltage across the motors is reversed.

The status of IC_{4b} changes at every leading edge at the Q-output of IC_{3b}. This has the advantage that the next direction of rotation of the motors is determined only when the motors have reached their end-stop.

The power supply of a circuit that is used

1



910044-11

in a car must be designed to overcome the problems that can occur in a car's electrical

system. The present circuit requires 8 V and this is derived from the car battery via an

8-V regulator, IC₅, followed by a 1000 μ F capacitor, C₁₃, to earth. Diode D₄ prevents the capacitor being discharged via the regulator when the engine is started. The capacitor ensures that the circuit remains operational for at least 10 seconds after the battery voltage fails.

If remote control is wanted, one of the four masters must be forgone and the ensuing free input at the Schmitt trigger used as the remote control input. Suitable remote control transmitters and receiver units can be obtained from most car accessory dealers.

Construction

The circuit is best built on a suitable piece of prototyping board (veroboard) —see Fig. 2. Decoupling capacitors C₁₄–C₁₈ must be located as close as possible to the relevant pins of IC₁–IC₃ to make certain that any noise on the supply lines does not enter these CMOS devices.

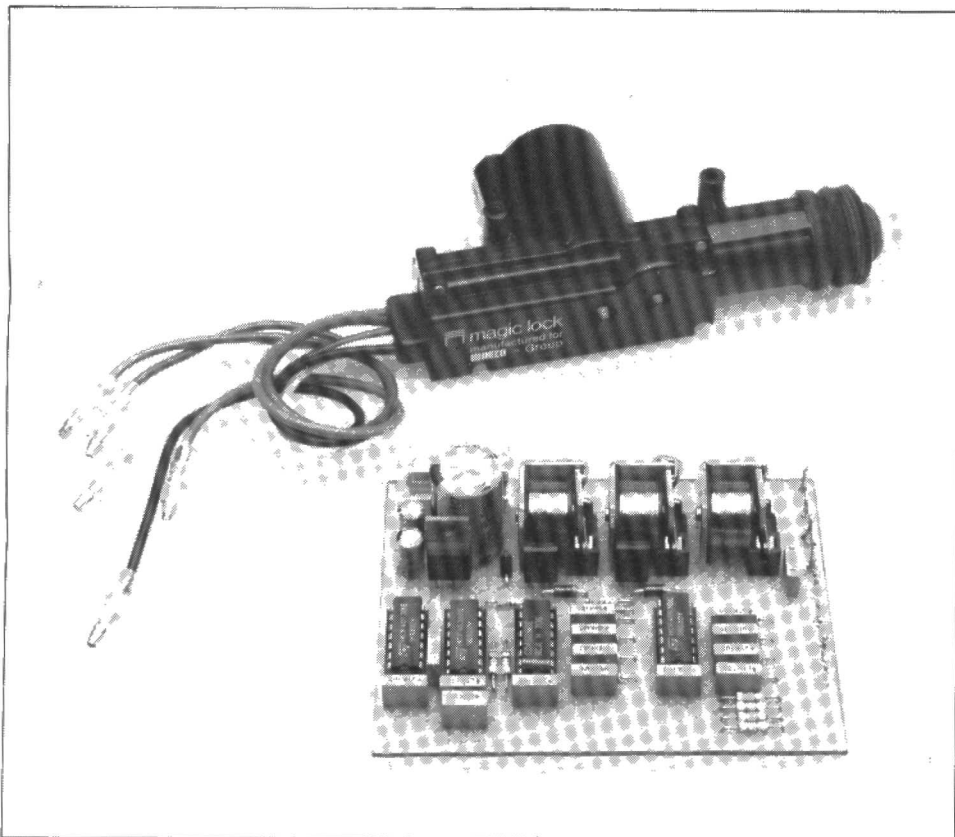
The relays can be of the type used for flashing indicators, which are fairly small, yet have contacts that are rated at 20 A.

Connections between the board and the modules and the battery are best made with the aid of standard car-type connectors.

The board may be housed in a simple ABS or other man-made fibre enclosure.

Full fitting instructions are enclosed with the DIY central locking kits. The main additional work involves preparing and laying the cables to the various locations. You should set aside about 2–2½ hours per door. ■

2



TIMECODE INTERFACE FOR SLIDE CONTROL

PART 2: CONSTRUCTION

As discussed last month, the timecode interface is an ingenious piece of electronics capable of putting time codes on a magnetic tape at 0.1-second intervals. Here, this system is used to control slide projectors. This month we finish the article with details on the construction and practical use of the unit.



by A. Rigby

Continued from the July/August 1991 issue

If you felt a little put off by the complexity of the timing diagrams shown last month, rest assured that you need not understand these in detail to be able to build and use the timecode interface. The purpose of including the timing diagrams in last month's installment was to set out the operation of the circuit in sufficient detail whilst avoiding a

very long circuit description.

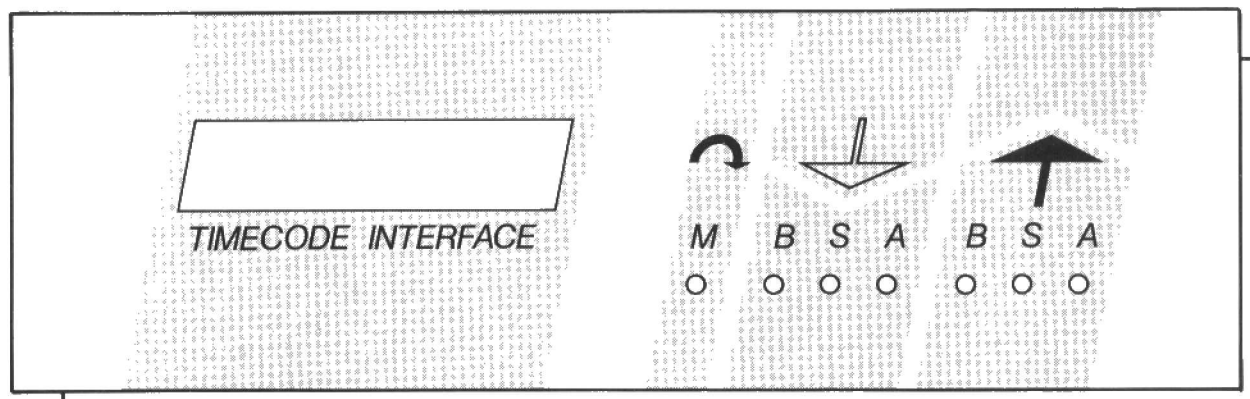
Fortunately, the construction and practical use of the timecode interface are not as complex as the actual circuit. The unit is controlled by a program supplied on disk through our Readers Services (order code 1611). The program enables you to run a test on the timecode interface with the aid of the Universal I/O Interface for PCs. Also on the disk are a number of source files, written in Turbo Pascal, that contain all the routines necessary for the practical use of the timecode interface.

Construction

The layout of the front panel designed for the timecode interface is shown in Fig. 7. The self-adhesive foil that gives the front panel a professional look is available ready-made through our Readers Services.

Motherboard

The double-sided, through-plated printed circuit board (Fig. 8) is cut to separate it from the three support pieces at the side of the arrow.



910055-F

Fig. 7. The front panel foil designed for the timecode interface gives the unit an attractive, professional finish (shown at true size).

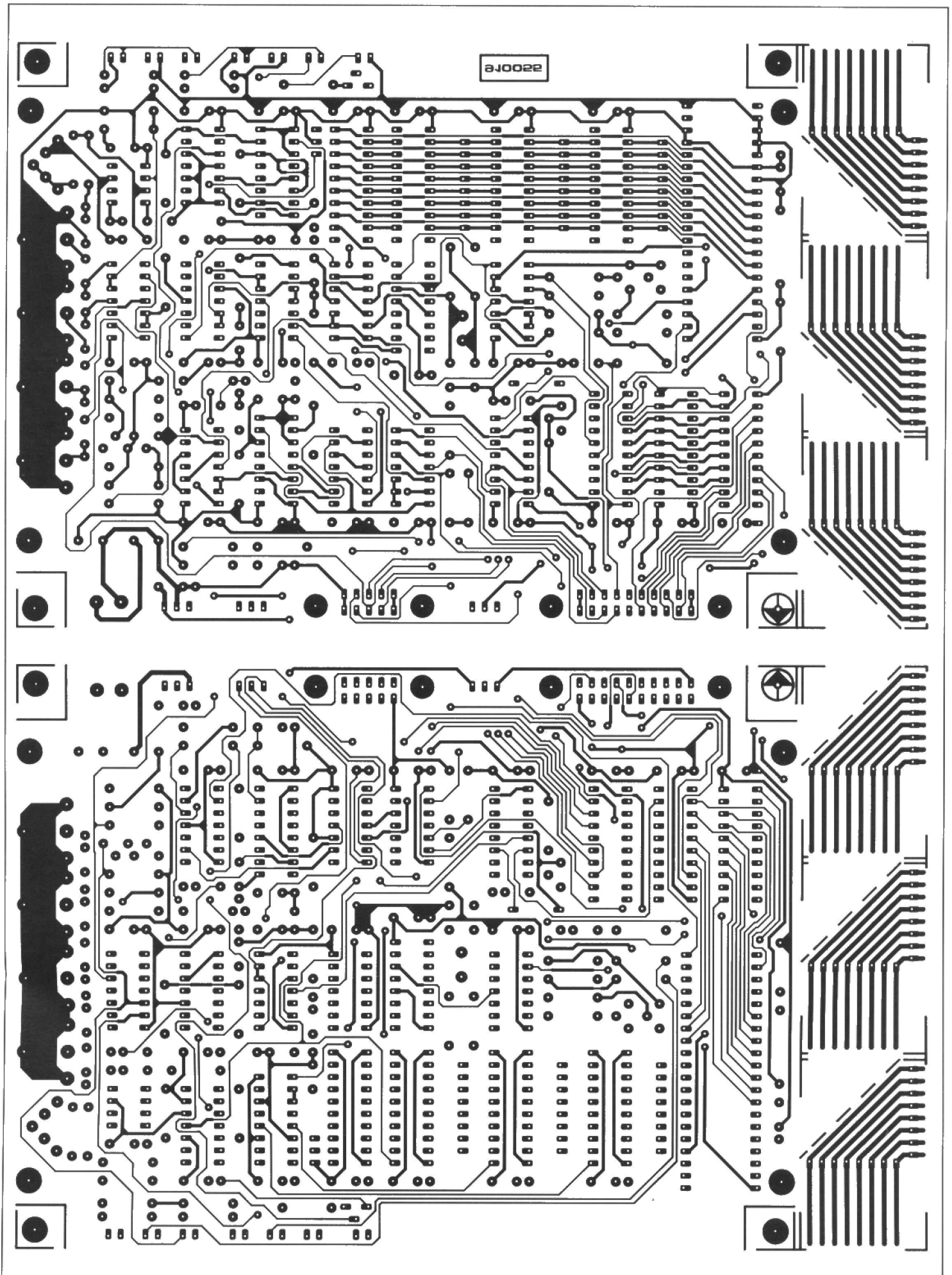
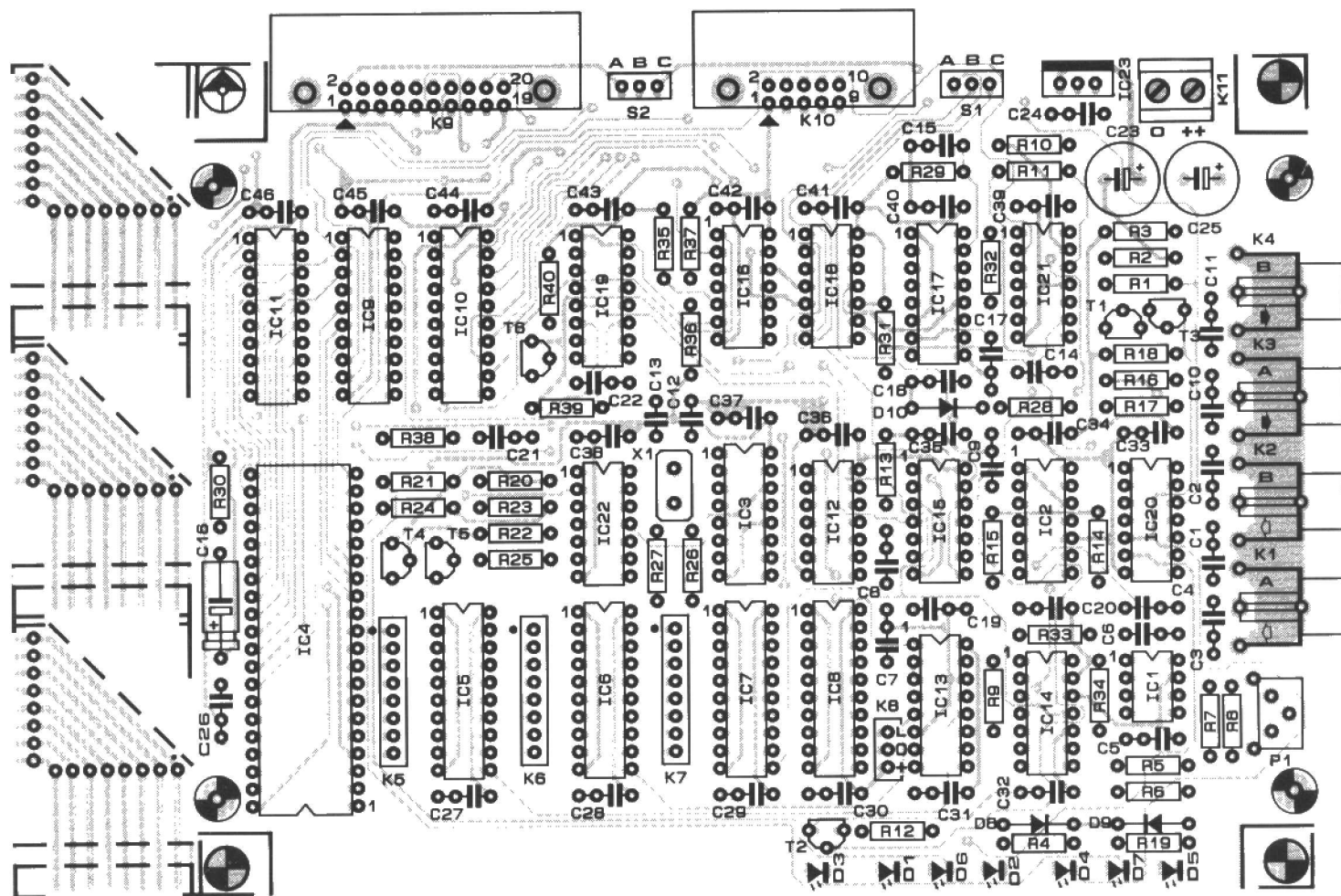


Fig. 8. Double-sided through-plated PCB for the timecode interface. The three corner pieces for the display unit are cut off from the main board.



COMPONENTS LIST

TIMECODE INTERFACE — MOTHERBOARD

Resistors:

6 470Ω	R4;R12;R19;R21; R24;R30
8 1kΩ	R2;R13;R17;R27; R33;R34;R39
1 1kΩ2	R15
1 3kΩ9	R14
2 4kΩ7	R1;R16
15 10kΩ	R3;R7;R10;R11; R18;R20;R22; R23;R25;R28; R35-R38;R40
1 18kΩ	R9
1 22kΩ	R29
1 39kΩ	R8
4 100kΩ	R5;R6;R31;R32
1 1MΩ	R26
1 100kΩ preset V	P1

Capacitors:

2 27pF	C12;C13
1 100pF	C4
5 1nF	C6;C8;C14;C19; C20
1 10nF	C15
1 18nF	C7
1 33nF	C9
1 68nF	C17
2 22nF	C21;C22
28 100nF	C1;C2;C3;C5;C10; C11;C18;C24;

1 100μF; 10V; axial	C26-C46
1 100μF; 16V; radial	C16
1 100μF; 25V; radial	C25

Semiconductors:

7 LED 3 mm red	D1-D7
3 1N4148	D8;D9;D10
6 BC547B	T1-T6
1 AY-3-1015	IC4
1 3130	IC1
1 74HCT00	IC12
1 74HCT32	IC16
2 74HCT74	IC14;IC18
1 74HCT93	IC2
2 74HCT123	IC13;IC17
1 74HC132	IC15
1 74HCT139	IC19
1 74HCT245	IC11
2 74HCT541	IC8;IC9
4 74HCT574	IC5;IC6;IC7;IC10
1 74HCT4060	IC3
3 74HCT4066	IC20;IC21;IC22
1 7805	IC23

Miscellaneous:

4 PCB-mount line (RCA) socket	K1-K4
3 8-pin SIL pin header	K5;K6;K7
1 3-pin SIL pin header	K8
1 20-way PCB mount IDC connector with angled pins and side latches	K9

1 10-way PCB mount IDC connector with angled pins and side latches	K10
1 2-way PCB terminal block (5mm pitch)	K11
2 slide switch with changeover contact	S1;S2
1 5.2 MHz quartz crystal	X1
1 enclosure Retex * Re2 (145x171x56mm)	
1 printed circuit board	910055
1 front panel foil	910055-F
1 control software on disk	ESS 1611

* Imhof-Bedco Standard Products Ltd., Ashley Works, Ashley Road, Uxbridge, Middlesex UB8 2SQ.

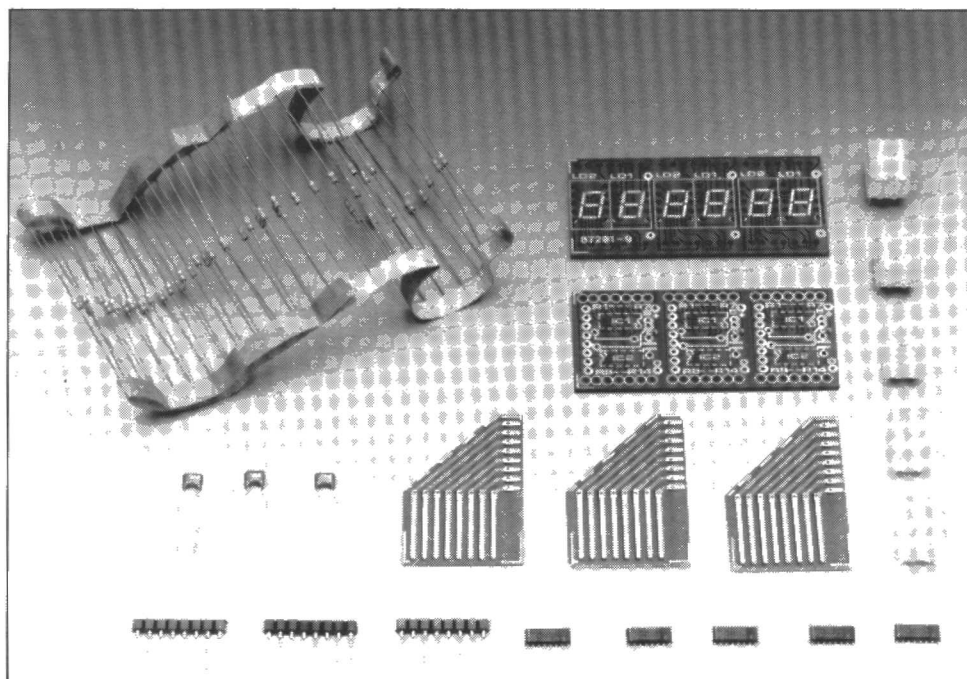


Fig. 9. All parts required to build the display. Note the IC pin strips with long pins.

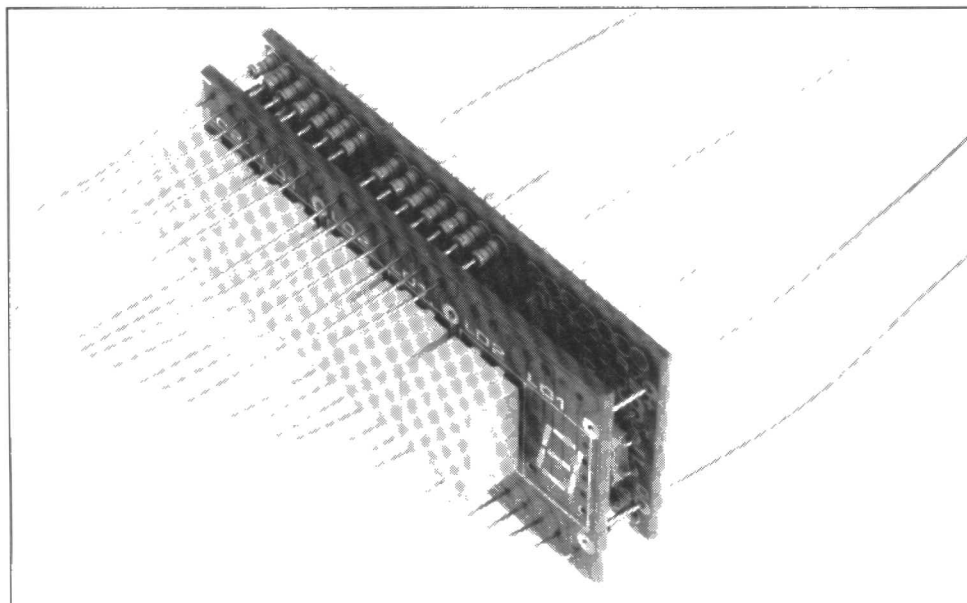


Fig. 10. In this way the display and the SMA boards can be joined easily.

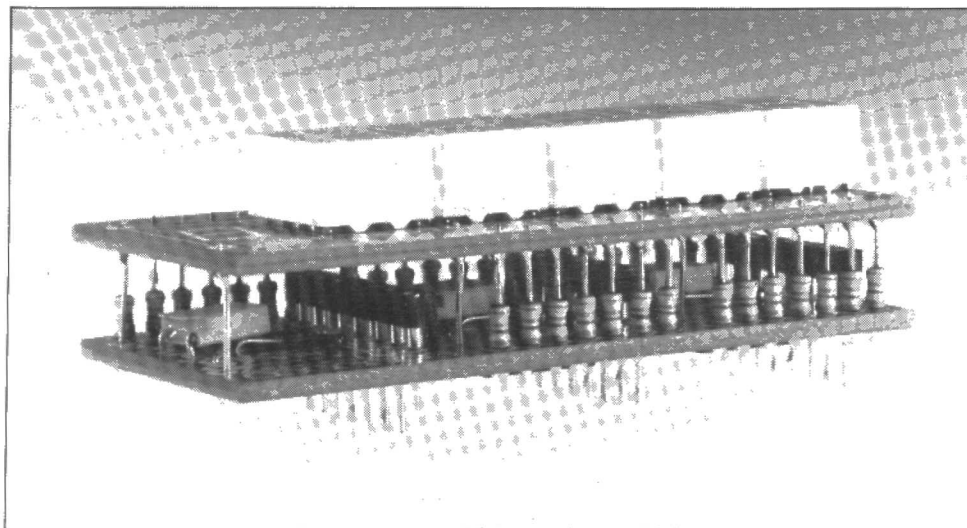


Fig. 11. The completed display. The IC pin strip is visible here.

Although fairly large and densely populated, the motherboard is easily built with the aid of the component overlay and the components list. The PCB accommodates all components, with the exception of switches S1 and S2. Its size is geared to the inside dimensions of the enclosure mentioned in the components list.

The construction of the display boards is a little more complicated than that of the motherboard, and discussed separately below. Note that the displays are optional — they are not strictly required when a computer is used to control the unit. They do, however, allow incorrect settings of, for instance, switch S1, the baudrate or preset P1, to be noticed immediately. The small PCB pieces you have already cut off allow the display module to be mounted to the motherboard in a simple and secure manner. The supply voltage and the LOAD signal are fed to the display via connector K8.

Display

As already noted, the read-out used is based on an earlier design developed for the Elektor Electronics Digital Train System (EEDTS). The construction of this display unit is discussed in Ref. 2 (see Part 1). There are, however, a number of points that deserve your attention.

1. The PCB used for the address display is the triple version, order code 87291-9a, which accommodates six displays. Here, we use only five displays, so that the display section at the extreme right — LD1, IC1 and R1-R7 of the associated SMA section — must not be fitted.
2. Before you start the construction of the display module, cut off the display section from the SMA section. Next, mount the wire links, capacitors, SMA ICs and the displays on the boards (note that the bevelled edge of the ICs marks the position of pin 1). The SMA parts are best soldered with thin solder wire of a diameter smaller than 1 mm. The SMA ICs are best fitted by first soldering two diagonal corner pins, and then aligning the other pins with the copper pads below before they are soldered. Those of you who want a clear separation between the minutes and the seconds indications may fit the two 680-Ω resistors between pins 6 of the two LD1 displays and ground (see Fig. 13).
3. To enable the display units to be connected to the corner pieces, use IC pin strips with long pins (1 cm; see Fig. 9). These pin strips must be fitted before the two PCBs are joined.
4. On the SMA PCB, all parts are fitted as closely together as possible. If you use the enclosure mentioned in the components list, you must use ultra-miniature resistors (max. length 5 mm). When the display board and the SMA board are joined, these resistors are inserted simultaneously. This is easiest done when the wire ends are cut such that they form an oblique line from one side of the board to the other (see Fig. 10).
5. The supply wires are soldered to the display board.
6. Check the complete construction before

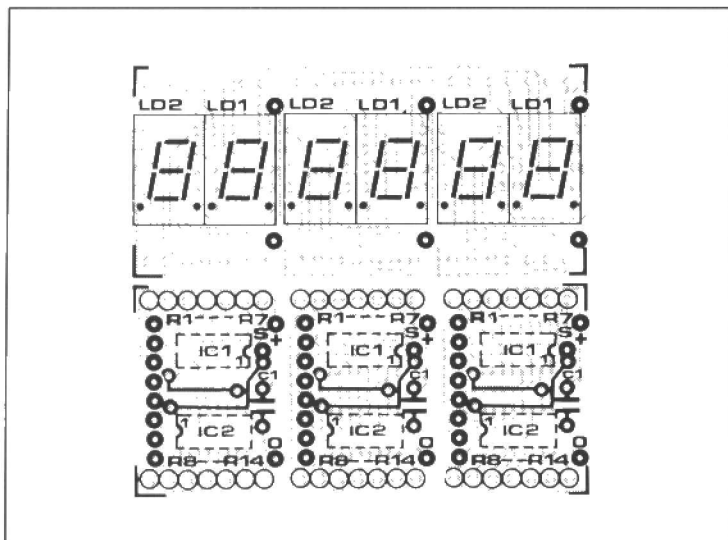


Fig. 12. Printed circuit board for the 5-digit address readout. The surface-mount assembly (SMA) ICs are fitted at the track side.

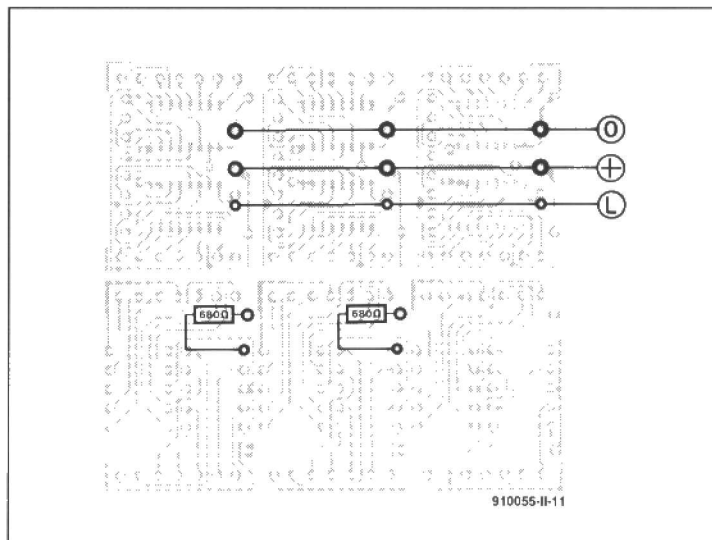


Fig. 13. These connection must be made at the rear of the SMA PCB, and wired to connector K8. Also shown here is how the two decimal points of two display can be joined.

COMPONENTS LIST

TIMECODE INTERFACE — DISPLAY BOARD

Parts list for 2½ display sections = 5 digits.

Resistors:

35 680Ω miniature R1-R14

Capacitors:

3 47nF C1

Semiconductors:

5 4543 (SMA) IC1, IC2
5 HD1105R LD1, LD2

Miscellaneous:

1 printed circuit board 87291-9a

you put the two PCBs together. First, solder the four resistors at the edges. Check that the PCBs align, and that there is sufficient room to solder the resistors properly. Also ensure that there remains sufficient space between

the IC pin strip and the display PCB, so that short-circuits can not occur. When the Retex RE2 enclosure is used, the distance between the two PCBs is about 8 mm. Finally, solder the remaining resistors and the supply wires (see Fig. 11).

7. As shown in Fig. 14, the supply and the LOAD connections are interconnected between the PCB sections. They are connected to wires that allow the display to be driven from the main board via connector K8.

Putting it together

Cut the clearance in the front panel to size before you mount the completed display unit on to the motherboard. The clearance should be carefully cut (with a jig-saw) and widened (with a small file) so that the displays just about pass. The corner pieces are fitted on to the PCB with the aid of a straight header or short pieces of solid wire. The dashed lines on the corner pieces indicate the length to which they must be cut to obtain the correct height for the Retex enclosure. If you use a different enclosure, determine the

required size of the corner pieces before cutting them.

Start the assembly by fitting the headers (or the wire pieces) on to the motherboard. Next, secure the motherboard in the enclosure. Insert the display into the clearance in the front panel. Solder each of the three corner pieces at one point, so that their tops are level with the pins of the display. Next, solder the display unit on to the four corner points, so that the front panel is positioned straight.

Before soldering the remaining points, run a thorough check on the assembly to make sure everything remains in place when the enclosure is closed.

Note that the front panel is designed such that the display unit is fitted as far as possible to the left. As shown in Fig. 14, each corner piece is at the left of the header, while the display section is fitted with its left side to the corner pieces.

The timecode interface is best powered by a mains adaptor with an output voltage of between 9 V and 12 V d.c. The current con-

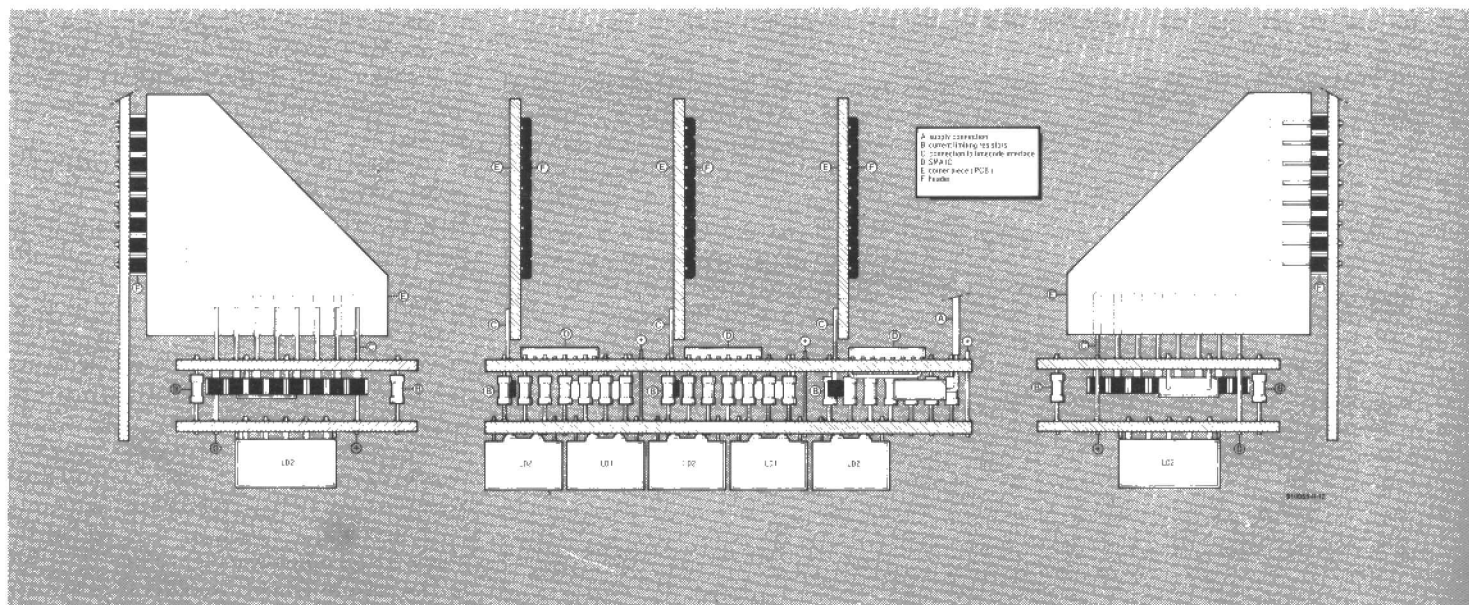


Fig. 14. Showing how the display and the corner pieces are mounted on to the main board.

THE MULTITRACK SYSTEM

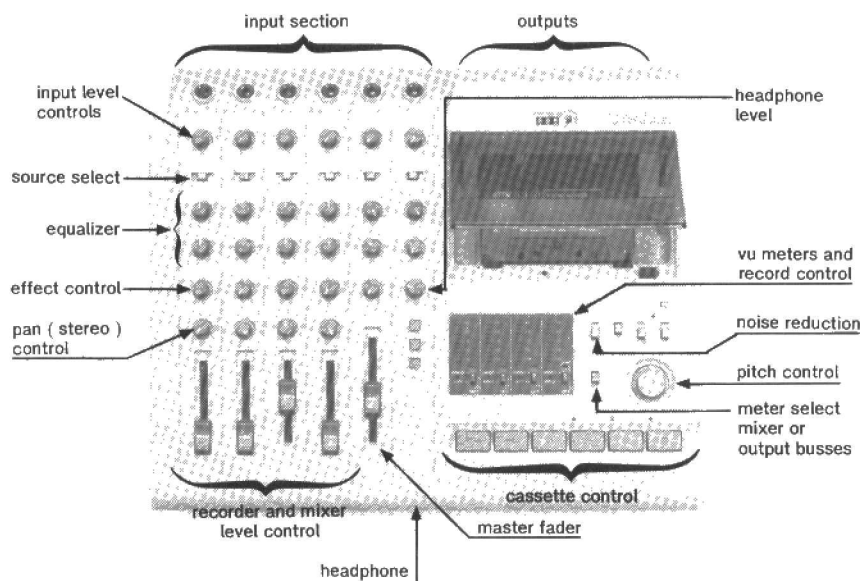
Multitrack cassette recorders are popular with musicians, disk-jockeys and others who want to mix existing as well as original sound material on tape. It is well known that many pop bands and 'budding' artists use multitrack recorders for the production of demo tapes that are offered as promotion material to radio stations and record companies. In the hi-fi audio scene, the multitrack cassette deck is rarely used as its sound reproduction quality is, in principle, not better than that of a stereo cassette deck. Because of this, the multitrack recorder may be unfamiliar to many of you, whence the following basic description. In its basic form, the multitrack recorder is a standard cassette recorder. It has all the familiar functions like recording, noise suppression and a tape transport mechanism. The first difference, however, is found when we look inside the cassette compartment. The recording/playback head is not a 2-track type, but a 4-track or even 6- or 8-track type. Looking at the tape erase function we find that there are a corresponding number of individual heads. The use of more than two recording and erase heads allows each track to be recorded and erased individually. This is arranged with the aid of a number of switches and input and output sockets that enable you to use any individual track for recording or playing back. Since the tracks are physically distributed over the full tape width, the cassette can be used in one direction only.

A multitrack recorder alone is not sufficient to produce, say, a demo tape for an artist — you will also need a mixing console to control the level of the individual sources (whether new or already recorded signals), and mix them down to a complete production ('post mixing', although this term is really used with 40+ channel mixing consoles only), or to another track. In the days when mixers and multitrack recorders were separate units, such a production job meant struggling with a lot of plugs and cables, with a great risk of errors occurring at all stages of the production line. The introduction of the so-called portastudio put an end to all this trouble by combining a simple mixing console and a multitrack cassette recorder in a single lightweight case. From then on, producing demo tapes with acceptable quality no longer required a sound engineer doing his bit with lots of wires and plugs — a great advantage for artists and pop bands, witness the start of the 'garage rock' period. From its introduction, the portastudio was a real success, combining ease of use with good sound quality and the freedom to record music, or mix it with existing sound material, almost

anywhere, from the attic or basement to the garage or local music club. The term dubbing refers to using an existing recording to make a new one. By making clever use of a portastudio, up to 10 sources can be recorded while only one dub is required. This is accomplished by first recording three signals, either simultaneously or one after the other, on tracks 1-3. Next, these three signals are mixed with a fourth signal, and the result is recorded on track 4. This dubbing operation allows tracks 1-3 to be used again for new recordings. After repeating this operation three times, a total of 10 signals have been recorded. When it is time for the final mix, the panorama ('pan') control is used to give each track its place in the stereo image. The advantage of this way of

working is that the previously recorded signal can be listened to while playing along and recording an additional signal (i.e., instrument or voice).

Besides level and pan controls, most portastudios have loop-through connections for effects equipment. A headphone output is standard, and inputs can be switched between line and microphone signals. A pitch control or tape speed switch is sometimes provided for the purpose of playing along at low speed. An increasing number of portastudios offer a tape speed of 9.5 cm/s, which provides significantly better reproduction quality.



The differences between portastudio units are mainly the number of inputs of the mixing console, the control system (mechanically or electronically), the noise suppression system (Dolby or DBX), and whether or not all tracks are accessible.

The timecode interface described in this article is preferably used with a 4-track recorder that has outputs for all four tracks (some multitrack recorders have only three outputs). In general, noise suppression should not be used because it may affect the frequencies of the control signals recorded on the tape. Problems are likely to occur at relatively high recording levels when the noise suppression is switched on. Simply try out the effect on your recorder — if problems occur, you will have to make do without the noise suppression. Unfortunately, this means that the music programme with your slide presentation has to be recorded without noise suppression.

Finally, use good quality cassette tapes, and have your recorder adjusted to these. The little extra money spent on a quality cassette is a good investment because it prevents many problems. ■

sumption of the unit, including the display, is about 250 mA when it is not powered by another circuit or by a computer via connector K9.

The right track

You will need at least a stereo tape recorder to be able to use the timecode interface. The sound channel is then recorded in mono, while the other track is used for the timecode signal. The sound programme must be mixed prior to recording the timecode.

The timecode signal is recorded and played back via the normal cinch-, line- or DIN socket of one of the channels available

on the recorder.

For more sophisticated work, use a multitrack tape recorder which enables you to record or play back four tracks either simultaneously or individually. This has the advantage of allowing the sound programme to be recorded and played back in stereo. The timecode is put on one of the remaining tracks, and this can be done independently of the sound programme. By the way, you can not use the (optional) special data format provided by the timecode interface unless you have a multitrack recorder.

Another advantage of a multitrack recorder is that it usually features a simple mixing console. After mixing and recording

the sound programme for the slide series, the timecode signals are recorded on track 4. When this is done, you have an absolute time reference relative to the music. This time reference is independent of tape stretch and tracking. Track 3 then remains free to record a special data format.

Finally, a remark on the system timing: if you want to change the frequency of quartz crystal X1, remember that the time constant of R9-C7 must be changed accordingly. Capacitor C9 will need to be changed, too. Clock frequencies higher than 5.2 MHz are not recommended, however, since they increase the error rate. ■

FIBER OPTICS — Part 1

Fiber optics are the latest transmission media in communications and instrumentation technology. Fibers are showing up in telecommunications, in computer data communications, and all manner of scientific, engineering and medical instruments. Briefly stated, fiber optics is that technology in which light is passed through a plastic or glass fiber so that it can be directed to a specific destination. If the light is encoded (modulated) with an information signal, then that signal is transmitted over the fiber optical path.

Joseph J. Carr

THERE are many advantages to the fiber optical communications or data link, including:

- Very high bandwidth (accommodates video signals, many voice channels, or high data rates in computer communications).
- Very low weight and small size.
- Low loss compared with other media.
- Freedom from electromagnetic interference (EMI).
- High degree of electrical isolation.
- Explosion proof.
- Good data security
- Improved 'fail-safe' capability.

The utility of the high bandwidth capability of the fiber optical data link is that it can handle a tremendous amount of electronically transmitted information simultaneously. For example, it can handle more than one video signal (which typically requires 500 kHz to 10 MHz of bandwidth, depending on resolution). Alternatively, it can handle a tremendous number of voice communication telephony channels (which is why you see those advertisements on television). High speed computer data communications capability is also possible. Either a few channels can be operated at extremely high speeds, or a larger number of low-speed parallel data channels are available on the fiber. Fiber optics are so significant, that one can expect to see them proliferate in the communications industry for years to come. Indeed, some futurists are calling for an extensive nationwide fiber optic communications network for data communications that is the info-age equivalent of the interstate highway system.

The light weight and small size of fiber optics, coupled with relatively low loss, makes the fiber optic communications link a very good economic advantage when large numbers of channels are contemplated. To obtain the same number of channels using coaxial cables or 'paired wires' the system would require a considerably larger, bulkier and heavier, infrastructure.

Electromagnetic interference (EMI) has been a destructive factor in electronics since Marconi and DeForest interfered with each other in radio

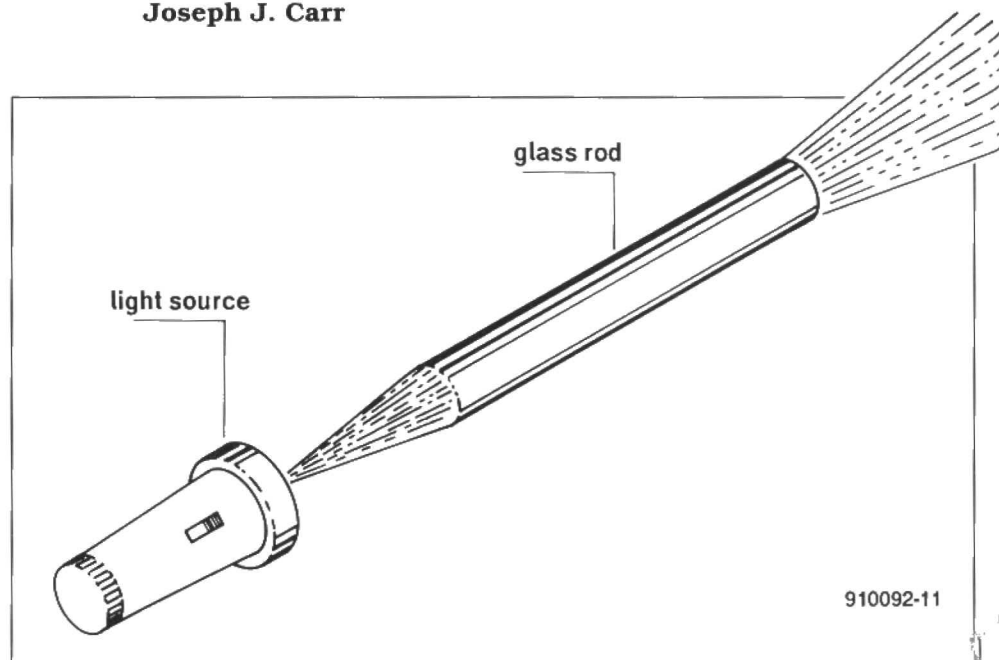


Fig. 1. Light travelling in glass rods was demonstrated more than one hundred years ago.

trials for the Newport Yacht Races just prior to the turn of the 20th century. Today, EMI can be more than merely annoying, and can cause tragic accidents. For example, airliners are operated more and more from digital computers. Indeed, one airline co-pilot recently quipped (about modern aircraft) that one does not need to know how to fly anymore, but one does need to be able to type on a computer keyboard at 80 words per minute. While the pilot's comment was meant to be a joke, it points out just how dependent aircraft have become on modern digital computers and intercommunication between digital devices. If a radio transmitter, radar, or electrical motor is near one of the intercommunications lines, then it is possible to either introduce false data or corrupt existing data with potentially disastrous results. Because the EMI is caused by electrical or magnetic fields coupling between electrical cables, fiber optics (being free of such fields) produces dramatic freedom from EMI.

Electrical isolation is required in many instrumentation systems either for the safety of the user, or the health of the electronic circuits connected to the system. For example, in some indus-

trial processes, high electrical voltages are used, but the electronic instruments used to monitor the process are both low-voltage and ground referenced. As a result, the high voltage can damage the instruments. In fiber optical systems, it is possible to use an electrically floating sensor, and then transmit the data over a fiber link to an electrically grounded, low-voltage computer, instrument or control system.

The fact that fiber optics uses light beams, and these are generated in non-contacting electronic circuits, make the fiber optic system ideal for use in switching and control systems around flammable gases or fumes. For example, in monitoring gasoline systems, or in cases where natural gas or medical anesthetic agents such as ether or cyclopropane¹ are used. Regular mechanical switches or relays are either on contact, or when decontacting, and those sparks can create an explosion if flammable gases or fumes are present. A number of operating room explosions in hospitals occurred prior to about 1960, and some gasoline stations have exploded because of arcing in electrical switches.

System security is enhanced because fiber op-

¹ These agents are only rarely used today, being considered too dangerous since the late 1970s when non-flammable substitutes became widely used.

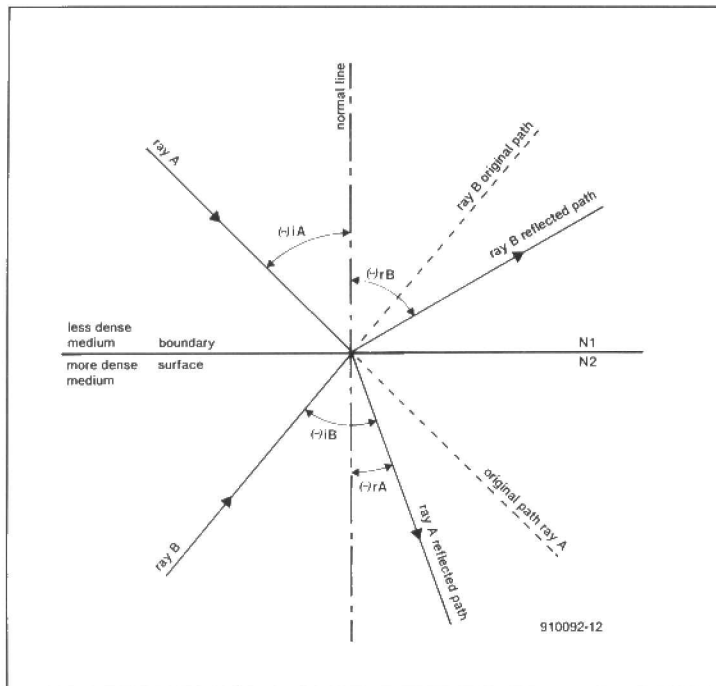


Fig. 2. Basic refraction phenomenon.

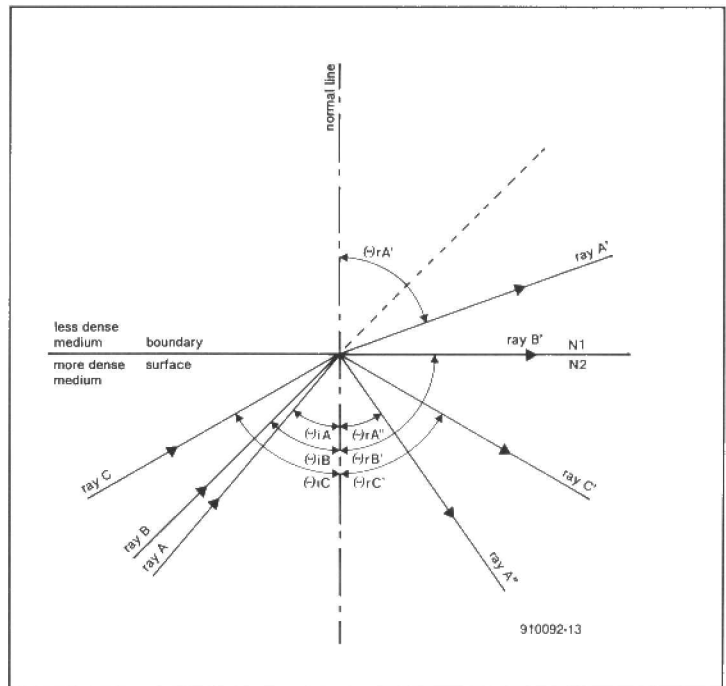


Fig. 3. Refraction involved in 'total internal reflection'.

ties is difficult to tap. An actual physical connection must be made to the system. In wire systems, capacitive or inductive pick-ups can acquire signals with less than total physical connection, i.e., no splice is needed. Similarly, a system is more secure in another sense of the word because the fiber optical transmitters and receivers can be designed to fail safe so that one fault does not take down the system. I recall a hospital coronary care unit data system that used parallel wire connections between the data output ports on bedside monitors and the central monitoring computer at the nurses station. A single short circuit in parallel data lines would reduce the system to chaos! That is less likely to happen in a fiber optical system.

Fiber optics: history and practical applications

The basic fact of fiber optics, i.e., the propagation of light beams in a transparent glass conductor (Fig. 1), was noted in the early 1870s when John Tyndall introduced members of The Royal Society to his experimental apparatus. An early, but not very practical, colour television system patented by J.L. Baird used glass rods to carry the colour information. By 1966, G. Hockham and C. Kao (Great Britain) demonstrated a system in which light beams carried data communications via glass fibers. The significant fact that made the Hockham/Kao system work was the reduction of loss in the glass dielectric material to a reasonable level. By 1970, practical fiber optic communications was possible.

Medicine has made use of fiber optics for more than two decades. Fiber optic endoscopes can be passed into various orifices of the body, either natural or surgically made, to inspect the interior of a patient's body. Typically there are two bundles, one for viewing and one for passing a light from a (misnamed) 'cold' light source into the body. For example, gynaecologists can inspect and operate on certain internal organs in females using a laproscope introduced through a

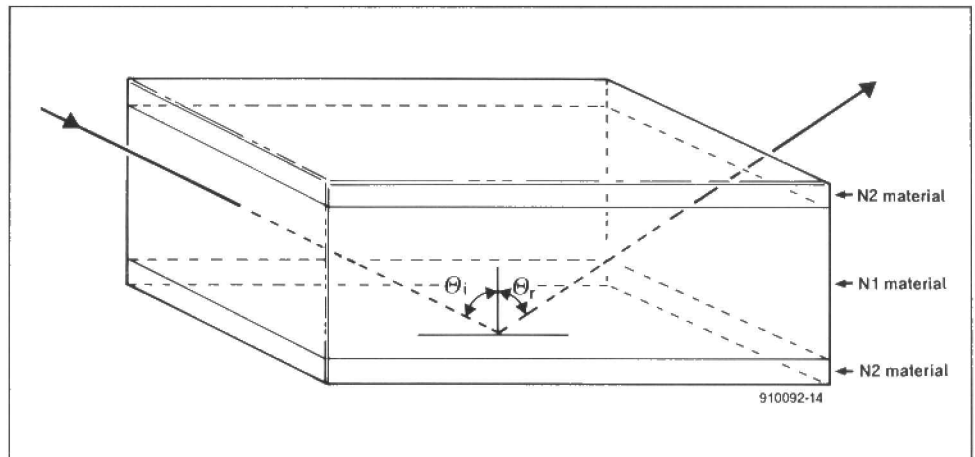


Fig. 4. Waveguide analogy to fiber optics.

'band-aid' incision in the abdomen. Knee surgeons can use a fiber optic arthroscope to perform nearly miraculous operations on the human knee with far less trauma than previous procedures. Other physicians use fiber optic endoscopes to inspect the stomach and gastric track. A probe is passed through the mouth or nose, down the esophagus into the stomach so that tumors and ulcers can be inspected without resort to surgery. In more recent times, miniature TV cameras using CCD arrays have been made available, with the fiber optics carrying the light into the stomach.

Fiber optic inspection is used elsewhere than in medicine. For example, I recall an advertisement for a septic tank service company that used fiber optics and television to inspect the tank; similarly for plumbers. Other industrial and residential services also use fiber optics to inspect areas that are either inaccessible or too dangerous for direct viewing.

Before examining fiber optic technology, it is useful to discuss some of the basics of optical systems as applied to the fiber optic system.

Review of some basics

The index of refraction (n), or refractive index of a material, is the ratio of the speed of the light

wave in a vacuum to the speed of the light wave in the material (e.g., glass, plastic, water). For practical purposes, the speed of light in air is close enough to the speed in a vacuum to be considered the same. Mathematically, the index of refraction, n , is:

$$n = \frac{c}{v_m} \quad [1]$$

where

c is the speed of light in a vacuum (approx. 3×10^8 m/s);

v_m is the speed of light in the medium.

Refraction is the phenomenon in which a light ray changes direction as it passes across the boundary surface (or 'interface') between two mediums of differing indices of refraction ($n_1 \neq n_2$). Consider Fig. 2 in which two materials, with indices of refraction n_1 and n_2 respectively. Consider incident lightray A, approaching the interface from the less dense side ($n_1 \rightarrow n_2$). As it crosses the interface it changes direction towards a line normal (i.e., at right angles) to the surface. Conversely, lightray (B) approaches the interface from the

more dense side ($n_2 \rightarrow n_1$). In this case, the light ray is similarly refracted from its original path, but the direction of refraction is away from the normal line.

In refractive systems the angle of refraction is a function of the ratio of the two indices of refraction, i.e., it obeys Snell's law:

$$n_1 \sin \Theta_{1a} = n_2 \sin \Theta_{2a} \quad [2]$$

or,

$$\frac{n_1}{n_2} = \frac{\sin \Theta_{2a}}{\sin \Theta_{1a}} \quad [3]$$

The particular case which concerns fiber optics is where the light ray passes from a more dense medium to a less dense medium. We can use either a water to air system, or a system in which two different glasses, with dissimilar indices of refraction, are interfaced. This type of system was addressed in Fig. 2 by ray B. Figure 3 shows a similar system with three different light rays (ray A, ray B and ray C) approach the same point on the interface from three different angles (i_a , i_b and i_c , respectively). Ray A approaches at a subcritical angle, so it will split into two portions (A' and A''). The reflected portion (A'') contains a relatively small amount of the original light energy, and may indeed be nearly indiscernible. The major portion of the light energy is transmitted across the boundary, and refracts at an angle r_a in the usual manner.

Light ray B, on the other hand, approaches the interface at the critical angle, r_b , and is refracted along a line that is orthogonal to the normal line, i.e., it travels along the interface boundary surface. This angle is normally labelled C in optical textbooks.

Finally, ray C approaches the interface at an angle greater than the critical angle, i.e., a supercritical angle. None of this ray is transmitted across the boundary, but rather it is turned back into the original media; i.e., it is subject to total internal reflection (TIR). It is the phenomenon of total internal reflection that allows fiber optics to work.

Fiber optics

The fiber optic is somewhat similar to a microwave waveguide, and an understanding of waveguide action is useful in understanding fiber optics. A schematic model of a fiber optic is shown in Fig. 4. A slab of denser material (n_1) is sandwiched between two slabs of a less dense material (n_2). Light rays that approach from a supercritical angle are totally internally reflected from the two interfaces ($n_2 \rightarrow n_1$ and $n_1 \rightarrow n_2$). Although only one 'bounce' is shown in our illustration, the ray will be subjected to successive TIR reflections as it propagates through the n_1 material. The amount of light energy that is reflected through the TIR mechanism is of the order of 99.9 per cent, which compares quite favourably with the 85-96 per cent typically found in planar mirrors.

Fiber optic lines are not rectangular, but rather are cylindrical, as shown in Fig. 5. These components are called clad fiber optics because the den-

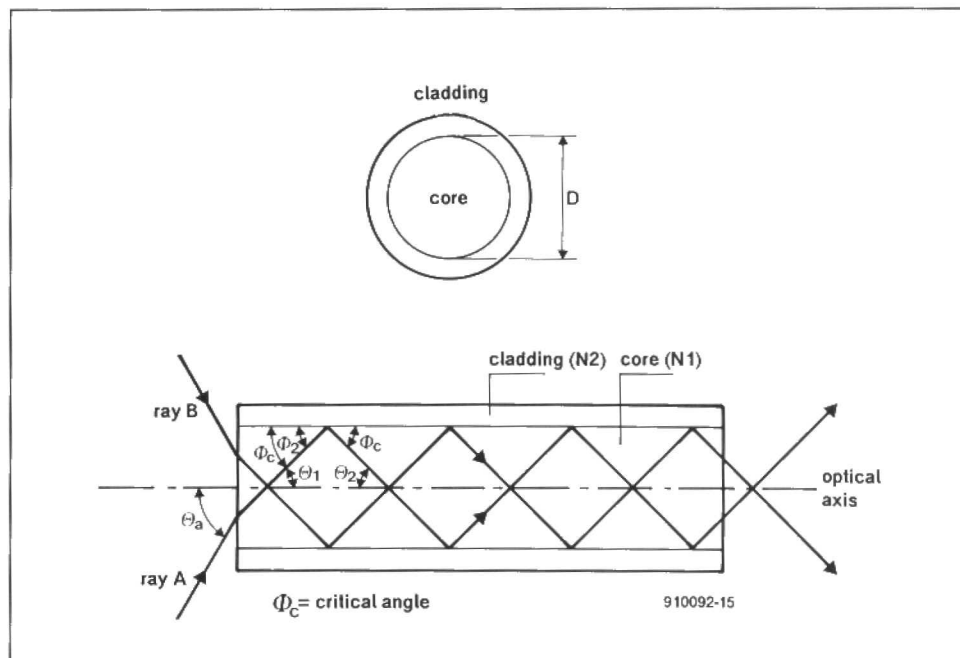


Fig. 5. Light propagates in fiber optics by repetitive total internal reflection.

ser inner core is surrounded by a less dense layer called cladding. Shown in Fig. 5 are two rays, each of which is propagated into the system such that the critical angles are exceeded. These rays will propagate down the cylindrical optical fiber with very little loss of energy. There are actually two forms of propagation. The minority form (Fig. 6a), called meridional rays, are easier to understand and mathematically model in textbooks because all rays lie in a plane with the optical axis. The more numerous skew rays (Fig. 6b) follow a helical path, so are somewhat more difficult to discuss (Ref. 1).

The light acceptance of the fiber optic (Fig. 7) is a cone shaped region centred on the optical axis. The acceptance angle a is the critical angle for the transition from air ($n = n_a$) to the core material ($n = n_1$). The ability to collect light is directly related to the size of the acceptance cone, and is expressed in terms of the numerical aperture, NA, which is:

$$NA = \sin \Theta_a \quad [4]$$

The refraction angle of the rays internally, across the air- n_1 interface, is given by Snell's law:

$$\Theta_{b1} = \arcsin \left(\frac{n_a \sin \Theta_a}{n_1} \right) \quad [5]$$

In terms of the relative indices of refraction between the ambient environment outside the fiber, the core of the fiber and the cladding material, the numerical aperture is given by:

$$NA = \sin \Theta_a = \frac{1}{n_a} \sqrt{n_1^2 - n_2^2} \quad [6]$$

If the ambient material is air, then the numerical aperture equation reduces to:

$$NA = \sqrt{n_1^2 - n_2^2} \quad [7]$$

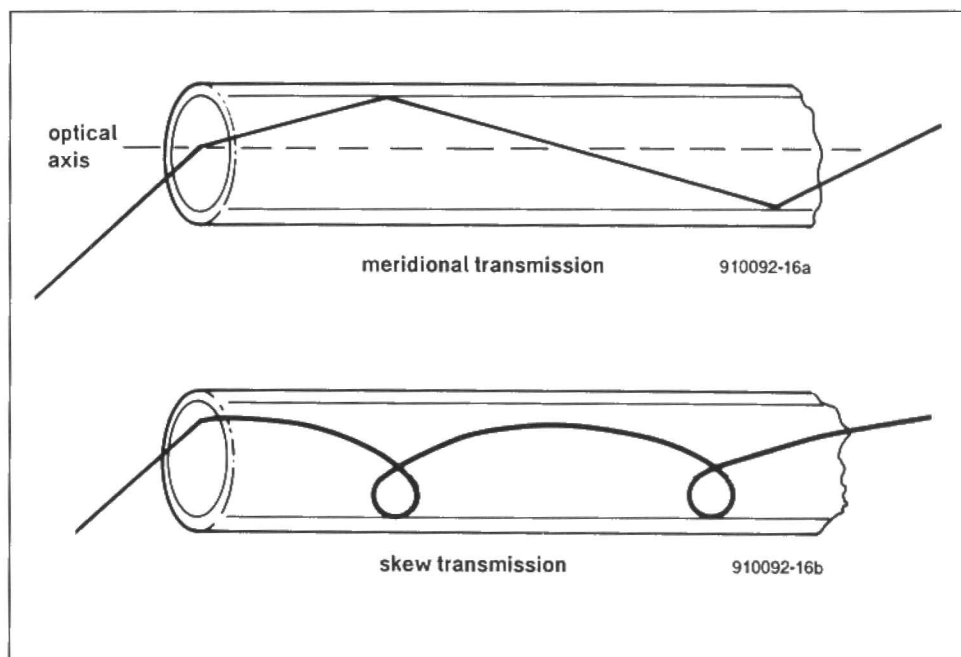


Fig. 6. a) meridional propagation; b) skew propagation.

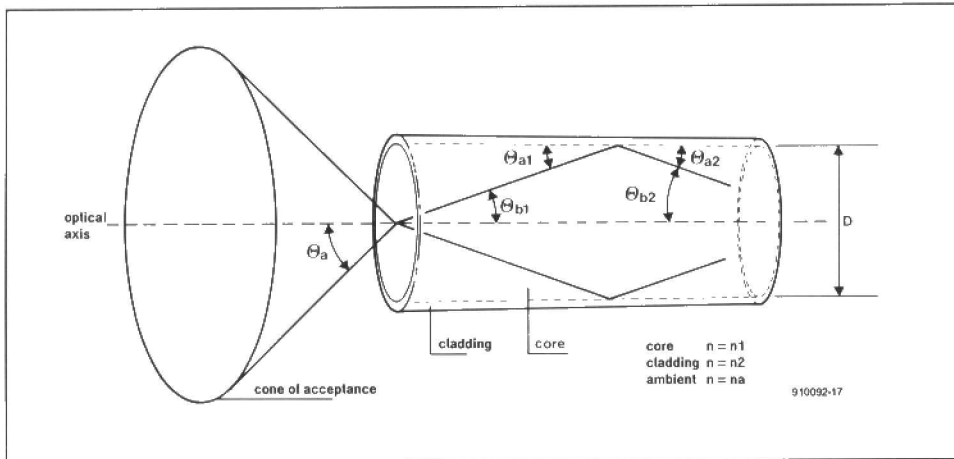


Fig. 7. Cone of acceptance of a fiber cable.

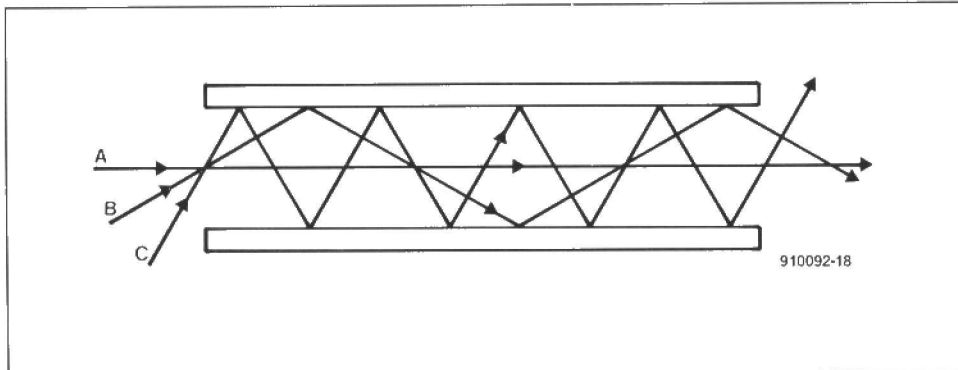


Fig. 8. Transmission modes in fiber optics.

Internally, the angles of reflection (a_1 and a_2), at the critical angle, are determined by the relationship between the indices of refraction of the two materials, n_1 and n_2 :

$$\Theta_{a1} = \frac{\arcsin \sqrt{n_1^2 - n_2^2}}{n_1} \quad [8]$$

Typical fiber optic components have numerical apertures of 0.1 to 0.5; typical fibers have a diameter D of 25 μm to 650 μm . The ability of the device to collect light is proportional to the square of the numerical aperture:

$$\zeta \equiv (\text{NA} \times D)^2 \quad [9]$$

Intermodal dispersion

When a light ray is launched in a fiber optic it can take any of a number of different paths, depending in part on its angle of arrival (Fig. 8). These paths are known as transmission modes, and vary from very low order modes parallel to the optical axis of the fiber (ray A in Fig. 8), to the highest order mode close to the critical angle (ray C); in addition, there are a very large number of rays in between these two limits. An important feature of the different modes is that the respective path lengths vary tremendously, being shortest with the low order modes and longest with high order modes. If a fiber optic has only a single core and single layer of cladding, it is called a step index fiber because the index of refraction changes abruptly from the core to the cladding. The number of modes, N , that can be supported are given by:

$$N = \frac{(\pi D [\text{NA}] / \lambda)^2}{2} \quad [10]$$

Any fiber with a core diameter, D , greater than about ten wavelengths (10λ) will support a very large number of modes, so is typically called a multimode fiber. A typical light beam launched into such a step index fiber optic will simultaneously find a large number of modes available to it. This may or may not affect analogue signals,

but has a deleterious effect on digital signals called intermodal dispersion.

Figure 9 illustrates the effect of intermodal dispersion on a digital signal. When a short duration light pulse (Fig. 9a) is applied to a fiber optic that exhibits a high degree of intermodal dispersion, the received signal (9b) is smeared, or 'dispersed', over a wider area. At slow data rates this effect may prove negligible because the dispersed signal can die out before the next pulse arrives. But at high speeds, the pulses may overrun each other (Fig. 10), producing an ambiguous situation that potentially exhibits a high data error rate.

Intermodal dispersion is usually measured relative to the widths of the pulses at the -3 dB (i.e., half-power) points. In Fig. 9, the -3-dB point on the incident pulse transmitted into the fiber optic is T , while in the received pulse the time between -3 dB points is T_d . The dispersion is expressed as the difference, or:

$$\text{Dispersion} = T - T_d \quad [11]$$

A means for measuring the dispersion for any given fiber optic element is to measure the dispersion of a Gaussian (normal distribution) pulse at those -3-dB points. The cable is then rated in terms of nanoseconds dispersion per kilometre of fiber (ns/km).

The bandwidth of the fiber, in megahertz per kilometre (MHz/km), can be specified from knowledge of the dispersion, using the expression:

$$B \text{ (MHz/km)} = \frac{310}{\text{Disp. (ns/km)}} \quad [12]$$

Graded index fibers

A solution to the dispersion problem is to build a fiber optic with a continuously varying index of refraction such that n decreases at distances away from the optical axis. While such smoothly varying fibers are not easy to build, it is possible to produce a fiber optic with layers of differing index of refraction (Fig. 11). The relationship of the respective values of n for each layer are:

$$n_1 > n_2 > n_3 > n_4 > n_5 > \dots n_i \quad [13]$$

The overall index of refraction determines the numerical aperture, and is taken as an average of the different layers.

With graded fibers, the velocity of propagation of the light ray in the material is faster in the layers away from the optical axis than in the lower layers. As a result, a higher order mode wave will travel faster than a wave in a lower order.

The number of modes available to the graded index fiber are:

$$N = \frac{(\pi D [\text{NA}] / \lambda)^2}{4} \quad [14]$$

Some cables operate in a critical mode, designated HE_{11} (to borrow from microwave terminology) in which the cable is very thin compared with multimodal cables. As the diameter of the core decreases, so does the number of available

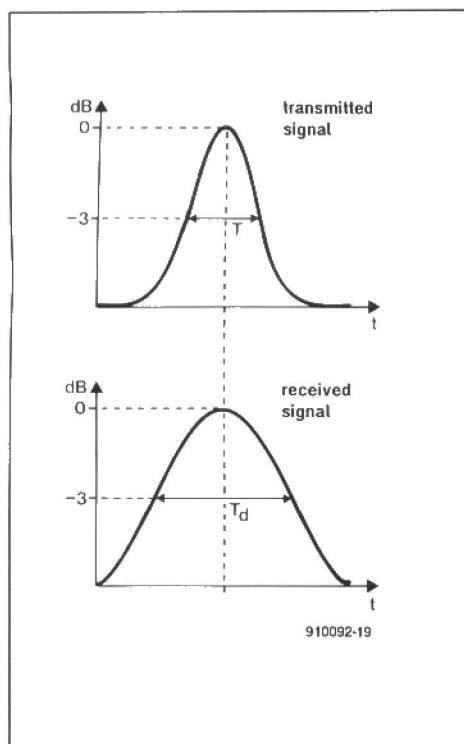


Fig. 9. a) input light pulse; b) output pulse is dispersed in time.

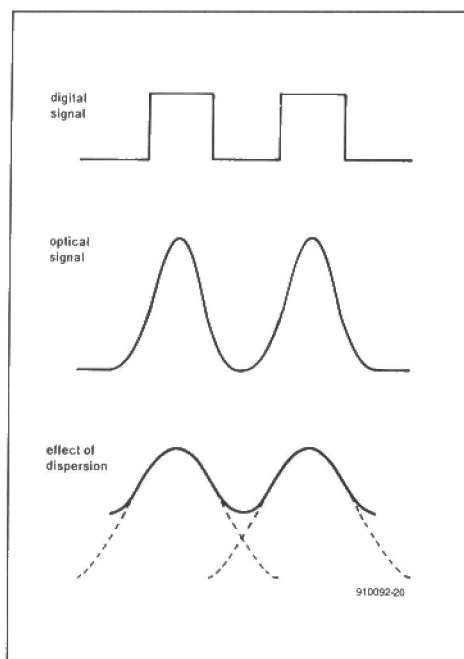


Fig. 10. Effects of dispersion on digital signal bandwidth: a) original data signal; b) light pulse input to fiber system; c) dispersed light pulses overlapped.

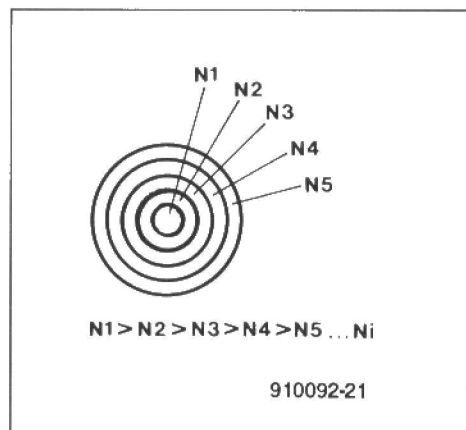


Fig. 11. Graded index fiber.

modes and eventually the cable becomes monomodal; If the core gets down to 3 to 5 microns, then only the HE_{11} mode becomes available. The critical diameter required for monomodal operation is:

$$D_{crit} = \frac{2.4 \lambda}{\pi [NA]} \quad [15]$$

Because the monomodal cable potentially reduces the number of available modes, it also reduces intermodal dispersion. Thus, the monomode fiber is capable of extremely high data rates or analogue bandwidths.

Next month...

In the second and final instalment of this article we will take a look at losses in fiber optic systems, fiber optic communications and some of the basic driver and receiver circuits needed to make fiber optics work. □

Reference:

1. "Optical-fibre communication" *Elektor Electronics* February 1991.

CORRECTIONS

Wattmeter

April 1991, p. 32-35

With reference the circuit diagram, Fig. 1, the right-hand terminal of the lower section of switch S2 should be connected to the circuit ground. This point is indicated by a dot.

In the adjustment procedure given on page 35, the references to presets P4 and P5 have been transposed. Contrary to what is stated, P4 sets the VY offset, and P5 the VX offset. The functions of the presets are shown correctly in the circuit diagram, Fig. 1.

To improve the accuracy of the instrument, connect R5 direct to the circuit ground instead of junction R6-R7. Finally, all circuit board tracks carrying mains current must be strengthened with 2.5-mm² cross-sectional area solid copper wire if currents higher than about 5 A are measured.

80C32/8052 Single-board computer

May 1991, p. 17-23

When a CPU type 8031 or 8052AH-BASIC is used, IC1, IC2, IC3, and IC8-IC12 must be 74HCT types. Jumper B is erroneously referred to as Br2 in the text under "On-board EPROM programmer". Contrary to what is stated, this jumper must be fitted only when an EPROM is to be programmed — for all other use of the SBC, it must be removed. Also note that jumper B may only be fitted when the programming LED is out.

Sequential control

July/August 1991, p. 61

Motor M should be a d.c. type, not an a.c. type as shown in the circuit diagram.

Digital phase meter

June 1991, p. 32-39

In Fig. 5, the switch between input 'A' and IC1 should be identified 'S1', and that between input 'B' and IC2 'S2'. Switch S4 is an on/off type, not a push-button as shown in the diagram. Capacitors C3 and C6 are shown with the wrong polarity. The component overlay of the relevant printed-circuit board (Fig. 8) is all right.

Universal NiCd battery charger

June 1991, p. 14-19

The parts list on page 19 should be corrected to read

C7 = 2200µF 25V

When difficult to obtain, the BYW29/100 (D5) may be replaced by the BY229, which is rated at 6 A.

The text under the heading 'Calibration'

should be replaced by:

4. Connect a multimeter between points G and H on the board, and adjust P4 until the measured voltage is 1 V lower than the voltage on the battery terminals.

MIDI program changer

April 1991, p. 14-17

The contents of the EPROM should be modified as follows:

address	data
00BC	E5
00C7	80
00C8	CB
00C9	F5
00CA	7B
00CB	12
00CC	00
00CD	D2
00CE	C2
00CF	02
00D0	80
00D1	C2

No TC added to
APRIL 1991
P. 17
OFC

Readers who have obtained the EPROM ready-programmed through the Readers Services may return it to obtain an update.

Electronic exposure timer

March 1991, p. 31-35

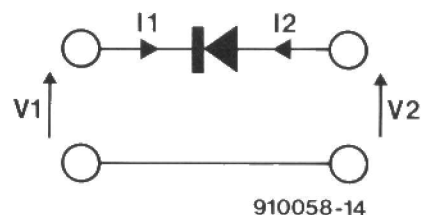
Please add to the parts list on page 32:

C16 = 33 pF

Augmented A-matrices

May 1991, p. 42-43

The drawing below was erroneously omitted in the left-hand bottom corner of page 43.



MEASUREMENT TECHNIQUES – PART 7

High-frequency measurements

by F.P. Zantis

THE test methods described so far in this series apply only to low-frequency (LF) equipment. In circuits carrying high-frequency (HF) signals, the effects of the measuring equipment become an important factor. First of all, of course, the test instruments used must be designed for HF measurements. Also, unless suitable measures are taken, tests may result in reflections and radiation of HF energy, which will invalidate the test results.

Measuring HF voltages

The bandwidth of virtually all inexpensive voltmeters makes them unsuitable for measuring HF voltages. Moreover, the capacitance of the test leads and that of the input circuit of the instrument will adversely affect the measurement. Also, in case of instruments with a not very high input impedance, the circuit Q will be derated.

For accurate measurements of HF voltages, special HF peak rectifiers are used. After rectification of the voltage, a standard DC instrument indicates the peak value of the measurand. It is then not possible to measure the r.m.s. value of non-sinusoidal voltages. The rectified voltage should be fed to the test point in a direct way to ensure that the leads from the test point to the display sec-

tion have no detrimental effect on the measurement. In many cases, therefore, a probe as shown in Fig. 61 is used. The rectifier diode should have the smallest possible junction capacitance and this is met by germanium types. The wide-band properties of this diode determine the overall bandwidth in the first instance. The coupling between the tip of the probe and the diode is capacitive, so that any direct voltage at the tip is blocked. Errors in measurement are normally caused by incorrect earthing. The earth point of the probe should be as close as possible to the test point and be connected to the earth of the equipment on test. If the frequency is higher than about 1 GHz, even these measures are not sufficient, since part of the HF energy is then radiated by various components and the wiring, which, of course, makes the measurement invalid or even impossible.

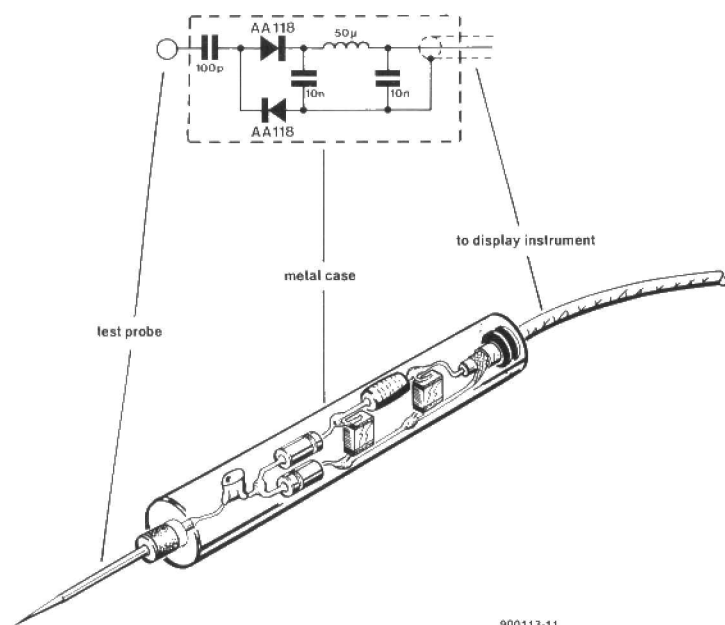
For voltage measurements at frequencies up to about 2 GHz, coaxial insertion probes are used whose construction obviates the unwanted radiation.

Alignment of tuned circuits

Relative measurements suffice in the alignment of tuned circuits—see Fig. 62. Therefore, if a probe is not available, the measurement may be carried out by connecting a low-

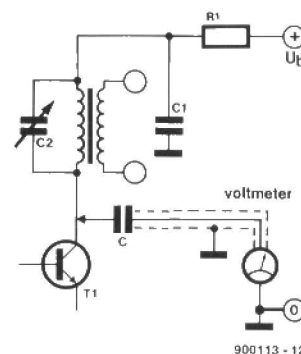
value capacitor, C , in series with the instrument. This reduces the effect of the input capacitance of the test instrument on the tuned circuit. The circuit is aligned by adjusting C_2 for maximum or minimum deflection of the voltmeter. In direct voltage

61



900113-11

62



900113-12

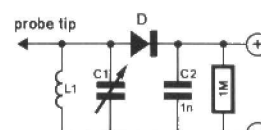
measurements, the effect of the meter is reduced by connecting a high-value carbon resistor (which has a high parasitic inductance) in series with the meter. As in a probe, it is advisable to connect the series capacitor or resistor close to the test point.

It will be realized that these simple methods can only be used for alignment and not for absolute measurements.

The effect of the instrument on the circuit on test can be reduced further by the absorption method, for which a circuit as shown in Fig. 63 is used.

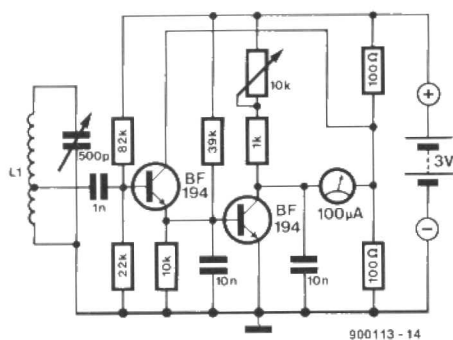
Coil L_1 is brought close to the inductor of the circuit on test. Mutual inductance causes a potential across L_1 that may be fed to an oscilloscope or, after rectification, to a voltmeter. If, owing to screening of the inductor in the tuned circuit, inductive coupling is impossible, wiring that carries the HF voltage may be touched with the tip of the probe. Capacitor C_1 is adjusted for maximum voltage across the tuned circuit, after which the frequency can be read on the oscilloscope or, if this is provided, the scale of C_1 .

63



900113-13

64



To really minimize the effect on the tuned circuit, it is advisable to amplify the voltage obtained by inductive coupling. A suitable circuit is shown in Fig. 64. Coil L_1 may be a plug-in type to make alignment over a wide range of frequencies possible. The tap on the coil ensures matching to the low-impedance transistor input.

Dip meter

The dip meter is still the most popular instrument for the radio and television amateur. Although it is basically a small HF transmitter, the meter functions in a manner similar to the absorption method described earlier. This active instrument makes the effect on the circuit on test even smaller, and, of course, greater sensitivity is obtained.

As in the absorption meter, the frequency is read on the scale of the variable capacitor, while the meter serves merely as a maximum or minimum indicator.

Apart from its use as a resonant-frequency measuring instrument, the dip meter may also be used as a signal source in signal tracing in HF circuits.

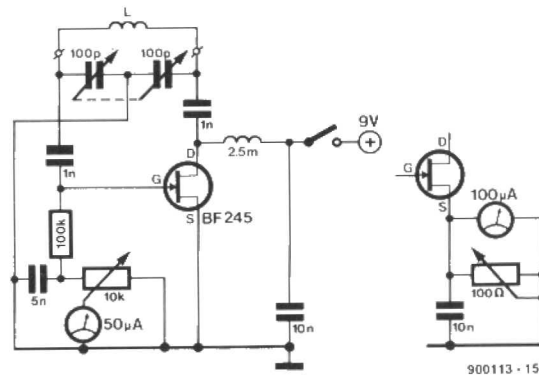
The values of the coil and variable capacitor are readily calculated with the following formulas if the value of one and the frequency (in MHz) are known.

$$L = 25,400/Cf^2 \quad [\mu\text{H}]$$

$$C = 25,400/Ff^2 \quad [\text{pF}]$$

A suitable circuit based on a field-effect

65 (A)



(B)

transistor—FET—is shown in Fig. 65. The HF signal is generated across the gain-drain junction. The display instrument is connected either in series with the gate bias resistor as in A or across the source as in B. The sensitivity of the circuit is set with the potentiometer.

When the circuit is used as an absorption meter and the display instrument is connected as in B, the 100 Ω potentiometer must be disconnected to ensure that the full sensitivity of the meter is available.

Winding data for coils are given in Table I.

Measurements on transmission lines

The characteristic impedance of a transmission line is the value of load resistance that enables maximum power transfer from source to load. The characteristic impedance of a transmission line, Z_c , is given by

$$Z_c = \sqrt{L_d/C_d},$$

where L_d is the distributed inductance per unit length and C_d is the capacitance per unit length. Practical values of Z_c vary from 100 Ω to 1000 Ω for parallel wires and 10 Ω to 150 Ω for coaxial cable.

When a transmission line, such as that connecting a transmitter to its antenna, is terminated by an impedance different from its characteristic impedance, some of the forward signal wave is reflected back. The reflected wave mixes with the forward wave, and the resultant amplitude at any point of the trans-

mission line is the algebraic sum of the amplitudes of the two waves.

The nodes and antinodes do not move relative to the transmission line, that is, they are stationary and the waves are called standing waves. An important consideration in transmission line and antenna design is the standing wave ratio—SWR.

The SWR may be ascertained with the aid of an SWR meter as shown in Fig. 66. The pick-up consists of three conductors of which the centre one is the core of the transmission line, while the outer two, called reflected pick-up wire (top) and forward pick-up wire (bottom), are spaced equally from this.

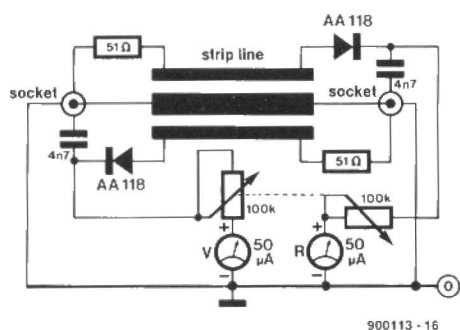
Usually, the pick-up unit is made as a pattern on a printed-circuit board: a strip line. The 51 Ω resistors are, in this case, equal to the characteristic impedance of the transmission line (if this were 75 Ω , the resistors would also have to be 75 Ω). In operation, any RF signal on one of the pick-up wires will be rectified by the relevant diode and then applied as DC to the associated indicator.

To ensure that the indicators can be used independently of the actual power, their scales are calibrated in relative values. That in the forward pick-up circuit, F, shows the relative power as a percentage, whereas the other shows the SWR. The ratio is given by the formula

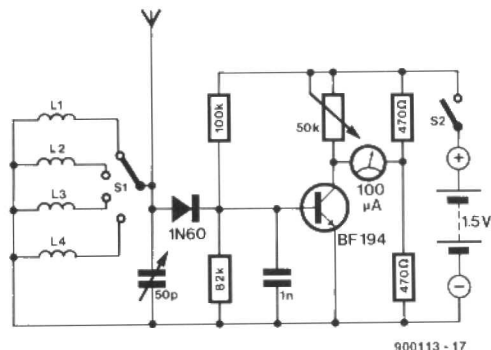
$$\text{SWR} = (1 + U_r)/(1 - U_r),$$

where U_r is the reflected voltage. It is assumed

66



67



that the forward voltage has been set to 100% of the relative power. Optimum performance is, of course, established when $U_r = 0$. A good antenna system has an SWR that varies between 1:1 and 1:1.2. Poor systems have ratios greater than 1:1.5. Most SWR meters do not give a reading beyond 1:3.

Measurement of field strength

For tuning a transmitter or testing an antenna system, a field strength meter is almost essential. In its simplest form, such an instrument consists of a basic receiver in which the headphones have been replaced by a sensitive moving-coil meter. A possible circuit is shown in Fig. 67.

The meter is zeroed with the 50 k Ω potentiometer. For relative field strength measurements, the antenna circuit need not be tuned: setting the tuned circuit to the centre of its bandwidth is sufficient. Otherwise, a number of different inductors may be selected with the aid of switch S_1 , which makes it possible to tune and test transmitters over a wide range of frequencies.

Range	Frequency (MHz)	Inductance (μ H)	No. of turns	Wire dia. (mm)
1	1.2–2.4	300	76	0.5
2	2.3–4.7	82	36	0.5
3	4.6–9.2	21	18	0.5
4	8.2–16.6	6.5	8	1.0
5	16.2–32.6	1.7	5	1.0
6	22.2–44.8	0.9	3	2.0
7	38.4–77.6	0.3	3	2.0
8	74.5–150.0	0.08	1	2.0

The coil diameter for ranges 1–6 must be about 38 mm (1.5 in.) and that for range 7, 25 mm (1 in.). The coil for range 8 is shaped like a hairpin, 50 mm (2 in.) long; wire separation is 10 mm (0.4 in.).

Finally

Instruments are usually multi-purpose: for instance, it is quite common for an SWR meter to be combined with a field strength meter

and a power output meter.

Next month's instalment will deal with "Measurements in digital circuits".

ASYMMETRICAL-TO-SYMMETRICAL CONVERTER

by M. Eller

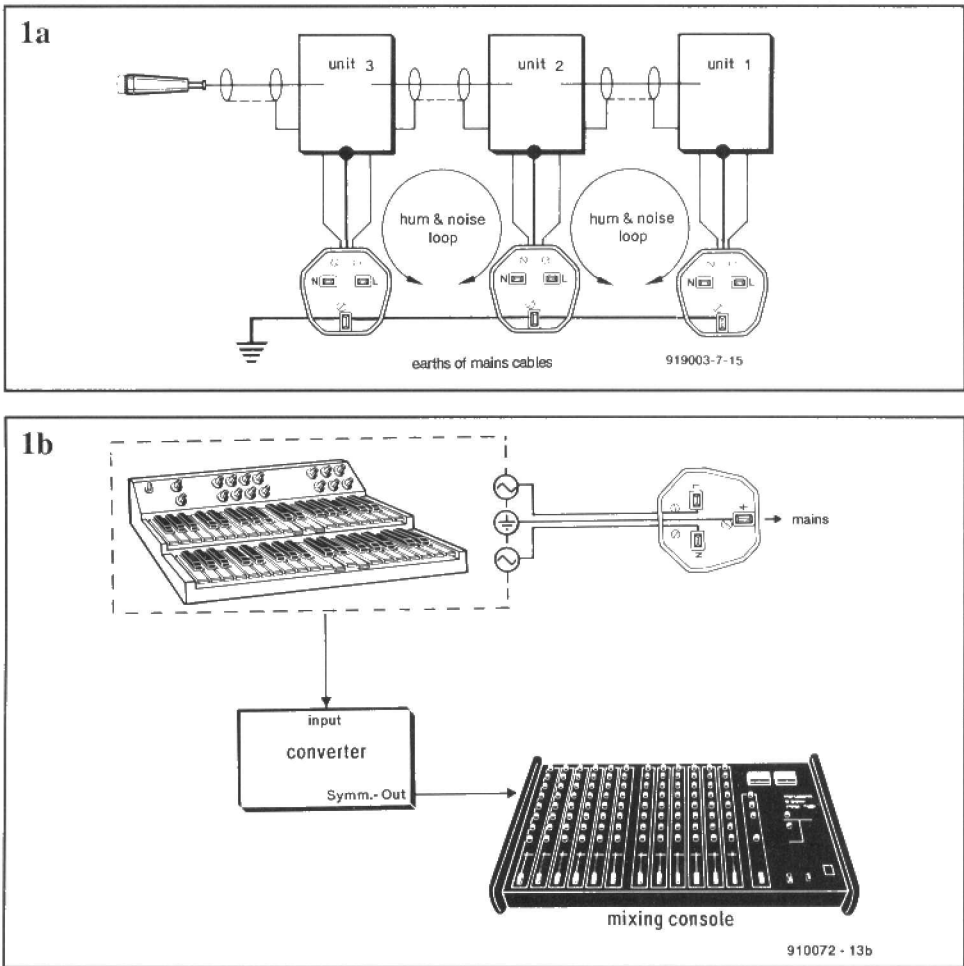
IT OFTEN happens in electrophonics (electronic music) that hum-and-noise loops occur when two or more different instruments are intercoupled as in Fig. 1a. Some musicians play with their lives by covering the earth pins with insulating tape to get rid of the hum. This is, of course, not only very stupid, but also highly dangerous.

A safe and certain method of getting rid of these loops is offered by the converter whose circuit is shown in Fig. 2. The converter is connected between two instruments as shown in Fig. 1b to provide electrical separation of the instruments. Make sure that the 'isolated' instruments are not drawn into new hum-and-noise loops through a common enclosure: each and every instrument must be isolated from the enclosure.

The converter resolves another problem also. On cost grounds, many commercial instruments have only a relatively high impedance output. Even pick-ups often suffer from this. When long connecting leads are used, or the signal is divided, or a following instrument has a low impedance input, noise and hum are the result and the quality of the music suffers. The converter has a high impedance input, and two low impedance outputs (one not isolated).

Circuit description

The input signal arrives at K_1 and from there it is applied via C_5 to IC_2 , which is arranged



below 6 V.

Construction of the converter is straightforward if the printed-circuit board shown in Fig. 4 is used. As mentioned earlier, make sure that the converter is fully isolated when it is used in a common enclosure. ■

PARTS LIST

Resistors:

R1 = 47 k Ω
 R2 = 33 k Ω
 R3 = 10 Ω
 R4, R6, R10 = 1 k Ω
 R5 = 1 M Ω
 R7, R8 = 470 k Ω
 R9 = 680 Ω
 R11 = 1.5 k Ω
 R12 = 10 k Ω

Capacitors:

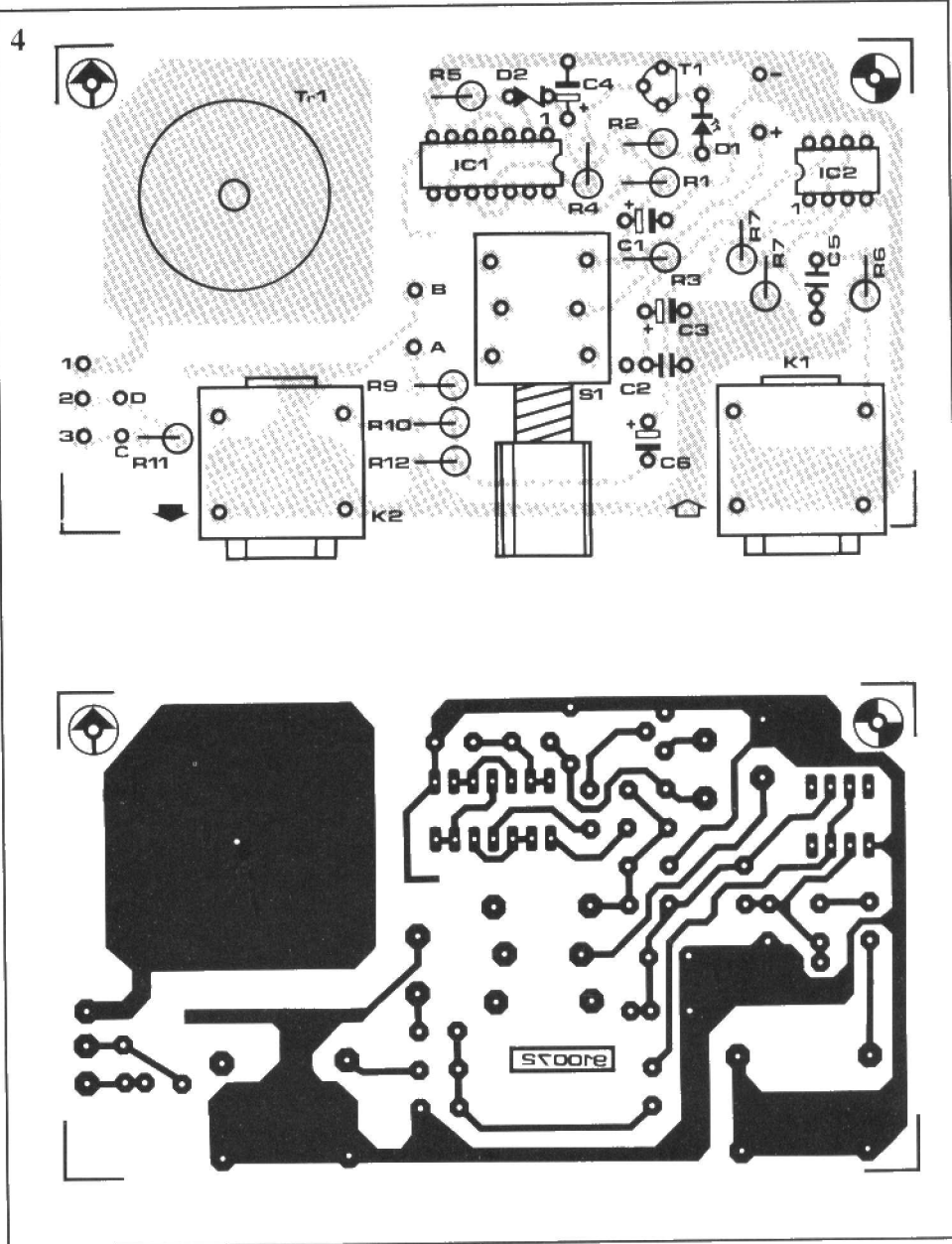
C1 = 1 μ F, 16 V, radial
 C2 = 100 nF
 C3, C6 = 22 μ F, 16 V, radial
 C4 = 47 μ F, 16 V, radial
 C5 = 470 nF

Semiconductors:

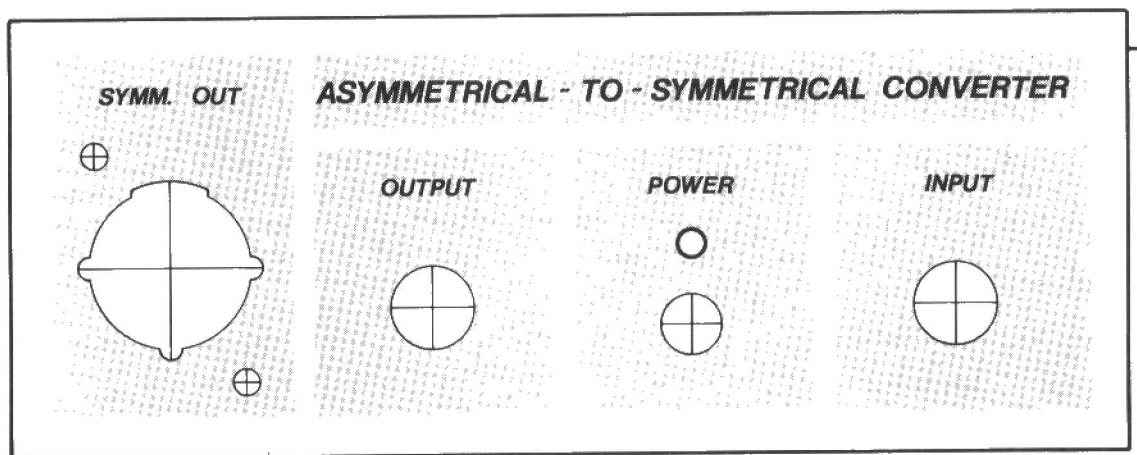
D1 = LED for chassis mounting
 D2 = zener, 2.7 V, 400 mW
 T1 = BC547B
 IC1 = 4011
 IC2 = TL061

Miscellaneous:

S1 = SPST switch
 K1, K2 = 6.3 mm audio socket for panel mounting, mono, insulated
 K3 = XLR socket for panel mounting
 Batt.1 = 9-V battery (UK: PP3)
 Tr1 = 600 Ω transformer — see text
 Enclosure to personal requirements
 PCB 910072
 Front panel foil 910072-F



5



APPLICATION NOTES

The contents of this article are based on information obtained from manufacturers in the electrical and electronics industry and do not imply practical experience by *Elektor Electronics* or its consultants.

REMOTE CONTROL ICs MV500 AND MV601 (Plessey Semiconductors)

TWO integrated circuits from Plessey, the MV500 transmitter and the MV601 receiver, allow remote control systems to be built from a minimum of components. The two ICs have been used already in a number of projects carried in this magazine (Refs. 1, 2). The infra-red remote controls described there are reliable, marked by low cost, a low component count, and the absence of quartz crystals and adjustable inductors. Note,

however, that the MV601 receiver requires one IC, an SL486, to be added when used to build an infra-red remote control system.

Data coding and transmission

The inputs of the transmitter are supplied with the information to be conveyed to the

receiver. This information is provided in parallel form by, for instance, a keyboard. As shown in Fig. 1, the parallel data is transmitted serially. The transmit operation is initiated by a start pulse with a synchronization pause, after the key debounce time, t_d . Then follow the five data-bits. The data packet is transmitted as long as the key is pressed. When the key is released, the data packet is always completed,

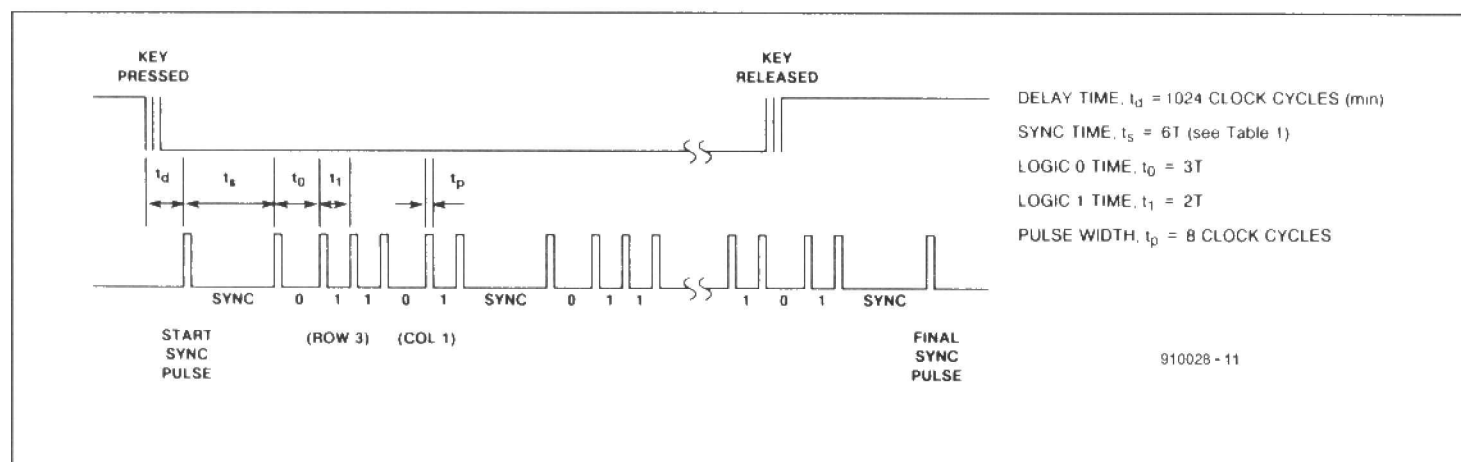


Fig. 1. Pulse/pause modulation applied in the MV500 transmitter.

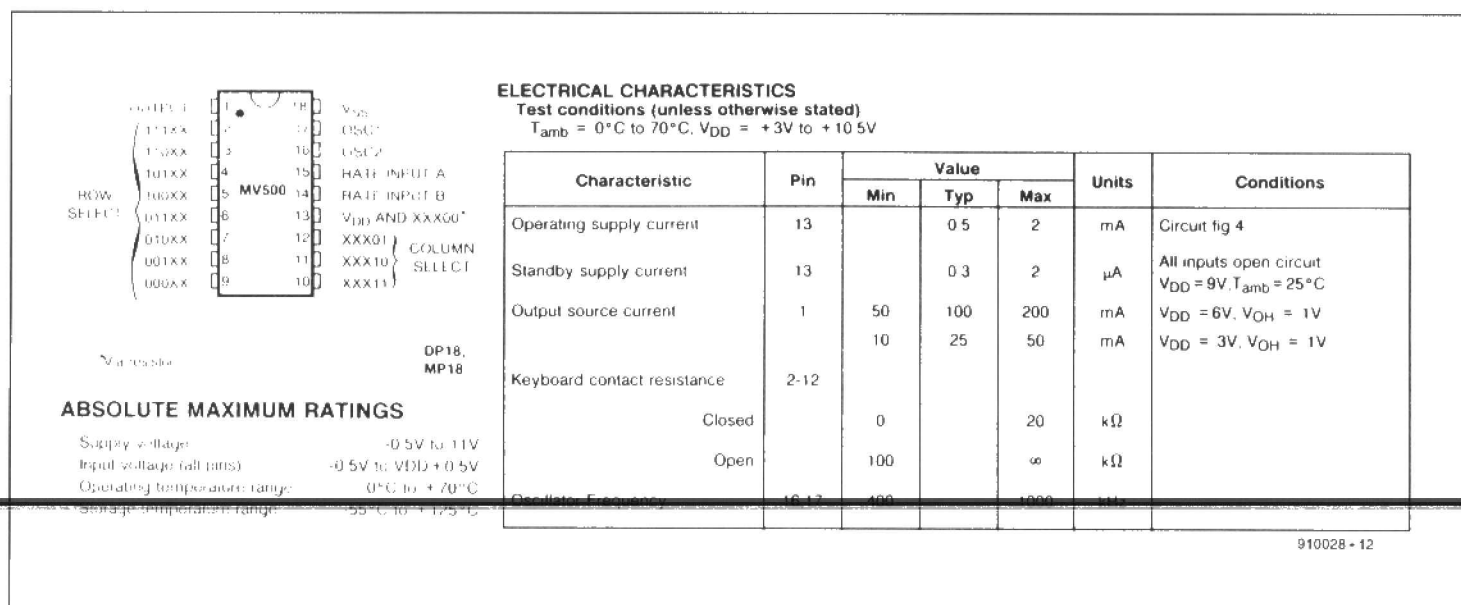


Fig. 2. Main data and pinning of the MV500 transmitter.

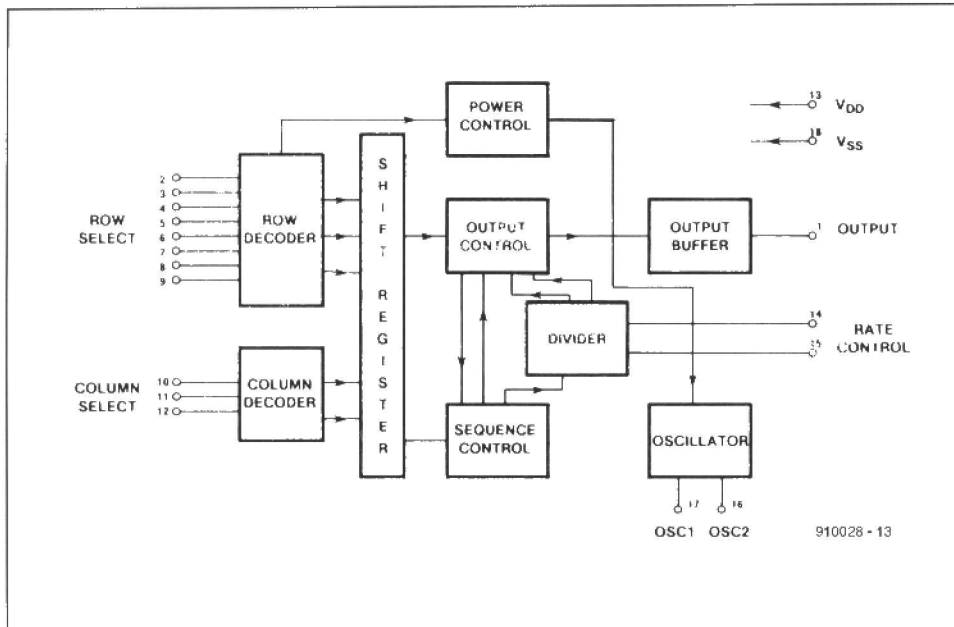


Fig. 3. Internal diagram of the MV500.

Table 1. Transmission rate settings

A	B	clocks	t_1	t_0	t_3
0	0	outputs disabled			
0	1	2048	4096	6144	12288
1	0	1024	2048	3072	6144
1	1	512	1024	1536	3072

Transmitter MV500

The most essential information on the MV500 remote control transmitter is given in Figs. 2 and 3. IC pins 2 to 12 form the channel selection inputs, which allow up to 32 channels to be used with the aid of a (switch-) matrix of 8 rows and 3 columns. A shift register converts the parallel information into a serial datastream. A sequence control block in the MV500 operates together with the output control to ensure the correct pause position and timing. The required transmission rate is set at pins 14 and 15. When both inputs are made logic low, the IC is disabled. The clock frequency is furnished by a oscillator that operates with an external ceramic resonator (fundamental resonance frequency between 400 kHz and 1 MHz; max. tolerance 5%).

As shown in the diagrams, the power control block is connected to the row decoder. In quiescent mode, the associated inputs are held at ground potential. The oscillator is then disabled, and the IC is switched to its power-down state in which the current consumption is reduced to 2 μ A or so. On detection of a high level at one of the column decoders, the power controller actuates the entire IC, and the transmitter starts to operate (provided, of course, one of

and a stop pulse is affixed.

The modulation of the information carrier (i.e., infra-red light) is based on pulse/pause (mark/space) modulation. This means that the five databits and synchronization bits are encoded by means of their length ('mark') and the position of the pauses ('space'). A short pause of two times the bit transmission rate, T , indicates a logic 1; a slightly longer pause of $3T$ indicates a logic 0; and a pause of $6T$ indicates synchronization (see Fig. 1). In this system, the logic levels are thus determined by the length and the position of the pauses in the serial datastream. The pulses serve no other purpose than to set the pauses apart, and can, therefore, be relatively short ($t_p=17 \mu$ s)

and of a fixed length.

As compared with pulsewidth modulation, the pulse/pause encoding system is less susceptible to interference, and more efficient in regard of battery power — the average current drawn by the actuated transmitter is smaller than 10 mA.

The length of the pauses is not constant, not even when they have the same logic content. This is caused by the three transmission rates, A, B, or A+B, that can be set on the transmitter and the receiver. The use of different transmission rates on transmitter/receiver sets allows up to three remote control systems with 32 channels each to be used in one room. This gives a total of no fewer than 96 remotely controlled channels.

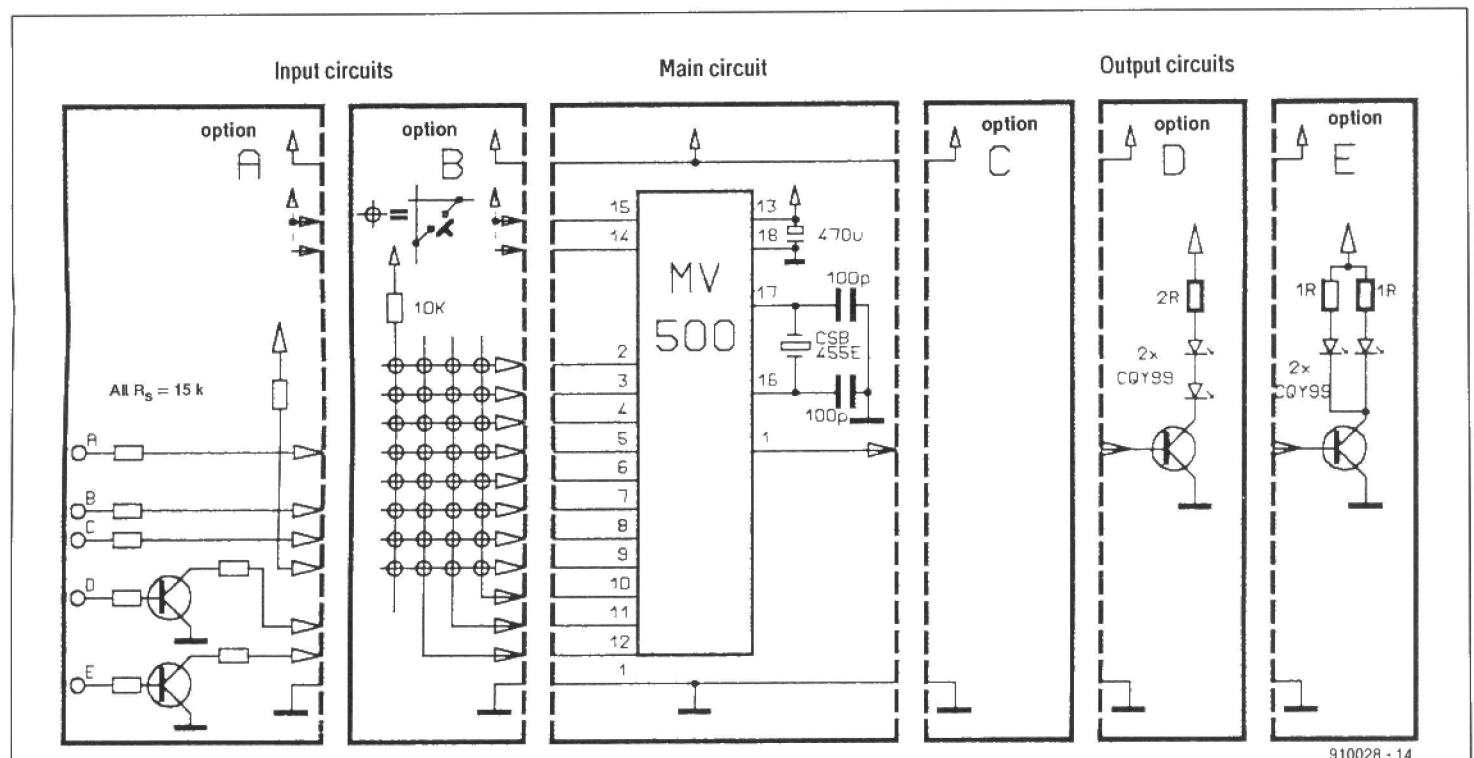
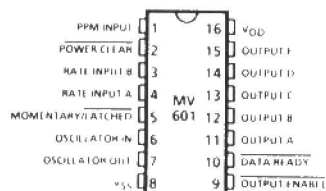


Fig. 4. Options for the input and output circuitry of the MV500.

ELECTRICAL CHARACTERISTICS

Test conditions (unless otherwise stated)

 $T_{amb} = 0^{\circ}\text{C to } 70^{\circ}\text{C}$, $V_{DD} = +4.5\text{V to } +5.5\text{V}$ 

DP16

ABSOLUTE MAXIMUM RATINGS

Supply Voltage V_{DD}	+7V
Input Voltage	$V_{DD} + 0.3\text{V to } V_{SS} - 0.3\text{V}$
Operating Temperature	$0^{\circ}\text{C to } +70^{\circ}\text{C}$
Storage Temperature	$-55^{\circ}\text{C to } +125^{\circ}\text{C}$
Output Sink and Source Current	50mA
Humidity	85%

Characteristic	Pin	Value			Units	Conditions
		Min	Typ	Max		
INPUTS						
OSCIN, RATE A, RATE B, MOM / LAT, OEN	6, 4, 3, 5, 9					
Input low voltage (V_{IL})				$V_{DD} / 3$		
Input high voltage (V_{IH})		$V_{DD} \times 2/3$				
PPM, CLEAR	1, 2					
Input low voltage (V_{IL})				1.0	V	$V_{DD} = 5.0V$
Input high voltage (V_{IH})		2.0			V	
Threshold voltage rising			1.85		V	
Threshold voltage falling			1.05		V	
CLEAR, RATE A, RATE B	2, 4, 3					
Input low current			-33	-100	μA	Nom. 150K pullup resistor
All other inputs except OSCIN	1, 5, 9			± 2.5	μA	$V_{IN} = V_{SS} - 0.3V$ to $V_{DD} + 0.3V$
Input current						
OSCIN	6					
Input current				± 10	μA	$V_{IN} = V_{SS} - 0.3V$ to $V_{DD} + 0.3V$
OUTPUTS						
A - E, DATA READY						
Output low current (sink)		13	26		mA	$V_{OL} = 0.4V$
Output high current (source)		-21	-45		mA	$V_{OH} = 2.4V$
Output leakage current (A-E)				± 10	μA	$V_O = V_{SS} - 0.3$ to $V_{DD} + 0.3V$ pin 9 = V_{DD}
OSCOUT						
Output low voltage (sink)		1.0			mA	$V_{IO} = 0.3V$
Output high current (source)		-1.0			mA	$V_{OH} = V_{DD} - 0.3V$

910028 - 15

Fig. 5. Main data and pinning of the MV601 receiver.

the transmission rate inputs is made logic high; otherwise, the IC remains off).

The main application circuits of the transmitter are given in Fig. 4. As already mentioned, very few external parts are required — the basic circuit works with an inexpensive ceramic resonator and two capacitors.

In principle, there is a choice between two types of input circuit. Of these, the most frequently applied is probably a keyboard matrix (option B). Alternatively, the code to be transmitted may be supplied by a computer or another digital circuit (option A).

When the inputs are connected to an 8×4 matrix (option B), the 5-bit parallel code is composed from bits A, B and C supplied by the row decoder, and bits D and E supplied by the column decoder. Note that bits D and E must be inverted because the relevant IC inputs, pins 11 and 12, are active low. The other data inputs, pins 2 to 9, are active high.

At the output of the MV500, the encoded serial data is modulated on to a carrier. In its simplest form, this carrier may be a direct voltage on a wire connected to pin 1. Add the ground wire to the receiver, and you have a simple 2-wire remote control system (option C). Note, however, that this arrangement requires the transmitter to operate at 5 V, i.e., at the same supply voltage as the receiver. For wireless control, the choice of infra-red light as the carrier is obvious. Since the output of the MV500 is not capable of driving an infra-red emitter diode direct, we need to insert a power driver. To increase the range of the transmitter, the IR beam emitted

by the diode can be made narrower by fitting the device with a small reflector or, to achieve even greater directivity, a small lens. The current limiting resistor may be omitted when the full transmit power is called for. Note, however, that this increases the current drain, and shifts the operating point of the IR diode beyond that of maximum efficiency. Remember, the peak current through the IR diode can be as high as 2 A, although this current flows for a couple of microseconds only. The IR diode shown in the circuit

diagram is a type with a peak pulse current of 2.5 A. Options D and E show suggested circuits for use with a 9-V battery block and a 5-V power supply respectively.

Receiver MV601

Figures 5 and 6 fill you in on the receiver IC, the MV601. The serial data applied to the input of the IC are converted into parallel to give an exact copy of the encoded data at the transmitter side. The block marked 'Noise

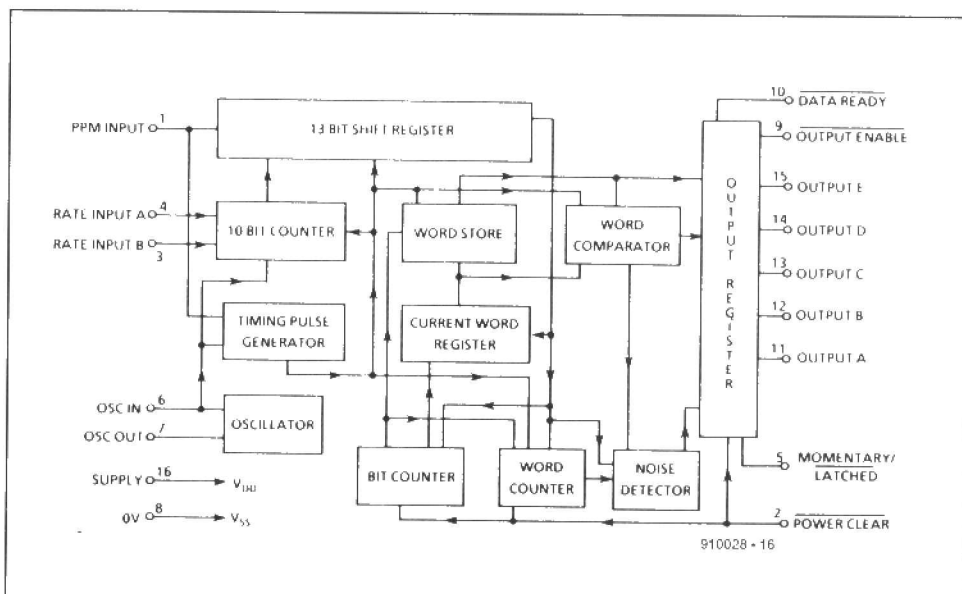


Fig. 6. Block diagram of the MV601

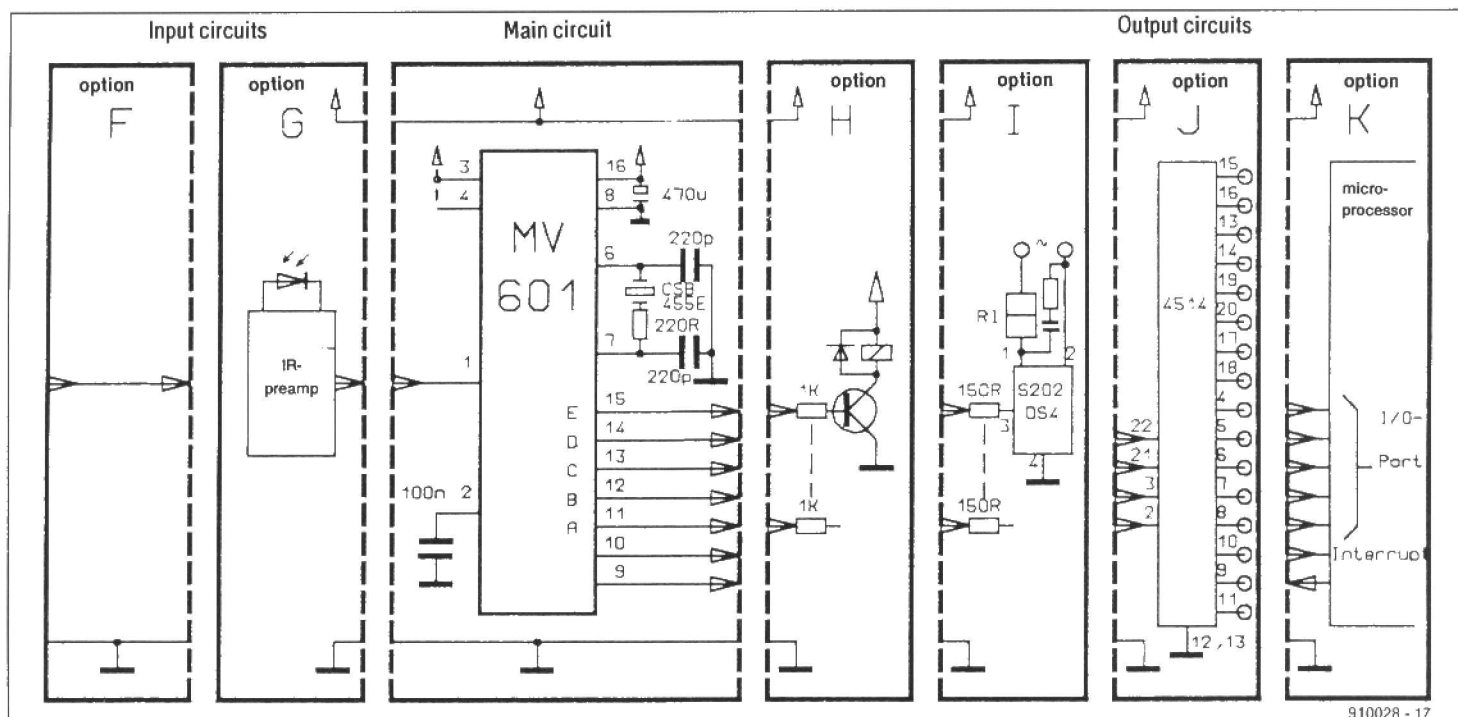


Fig. 7. Application options of the receiver.

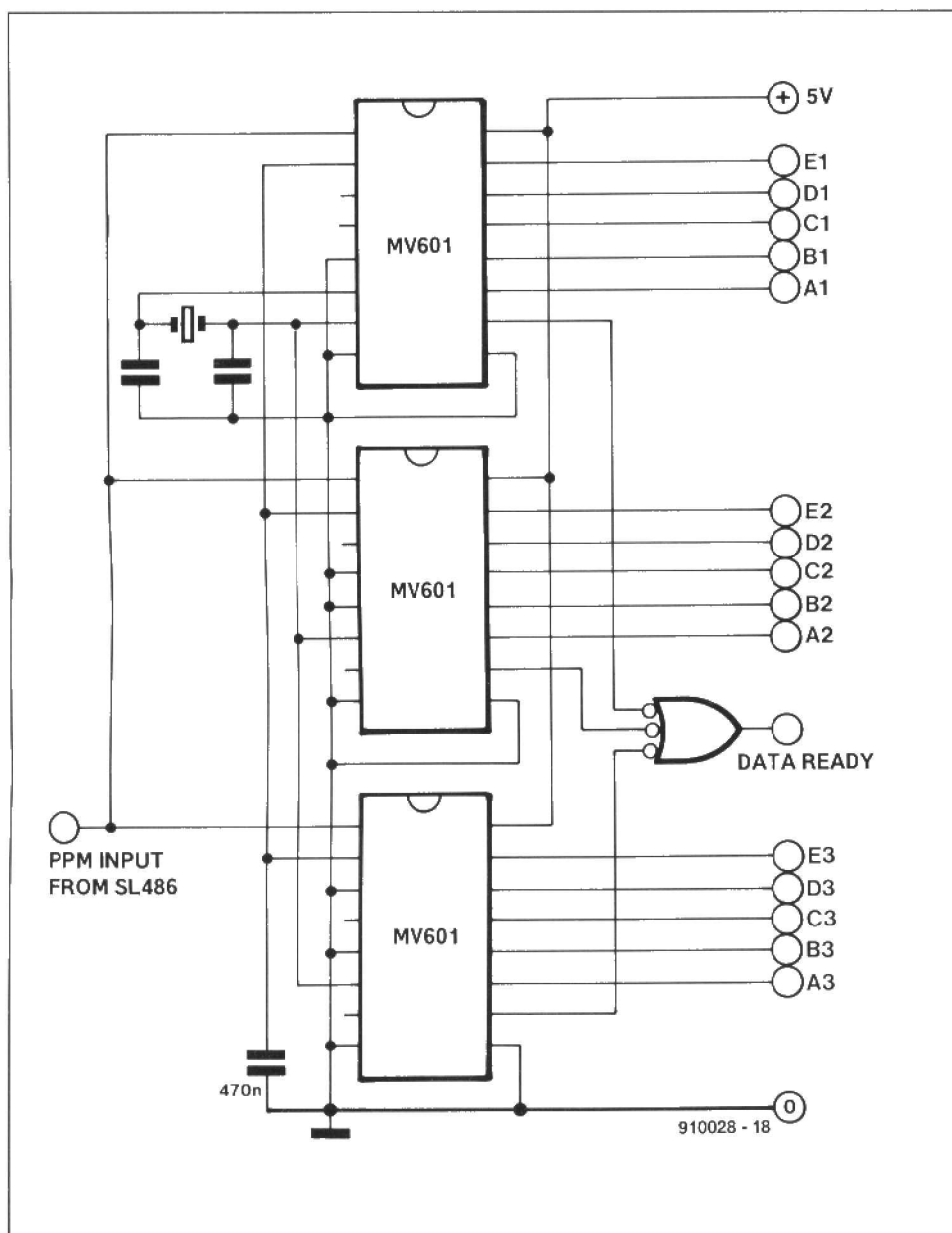


Fig. 8. 96-channel remote control extension.

Detector' is capable of recognizing and suppressing interference. Similar to that in the transmitter, the clock is provided by an oscillator. After being processed in a number of latches, counters and timers, the data are fed to the output latch, and from there to the IC output pins, A-D, pins 11-15. Each latch output can source 45 mA and sink 26 mA. The internal timers and the output latch may be reset with the aid of a low pulse at the POWER CLEAR input (pin 2). This input is connected to an on-chip 150-k Ω resistor, so that a single capacitor is sufficient to achieve automatic resetting of the IC on power-up.

The logic level applied to the MOMENTARY/LATCH input, pin 5, determines whether the data are kept in the latch (level = 0), or erased (level = 1) when there is no valid code at pin 1. When the OUTPUT ENABLE pin is made low, the dataword is fed to the IC outputs. A high level switches pins 11 to 15 to the high-impedance state. This allows the outputs of two or more MV601s to be connected to a databus. The DATA READY output goes low when a valid word is present.

The main application options of the MV601 are shown in Fig. 7. Like the transmitter, the receiver contains a small number of components only — the simplest application circuit works with a single ceramic resonator and two capacitors. A resistor may be connected in series with the resonator to ensure resonance at the fundamental frequency.

Depending on the transmitter configuration, there are several options for the receiver input circuit. No additional components are required for the two-wire remote control system, option F, where pin 1 of the receiver is simply connected to pin 1 of the transmitter. The wireless remote control, option G, is more complex because the MV601 requires an external infra-red preamplifier such as the SL486 (see Fig. 1-12).

The outputs of the MV601 may be con-

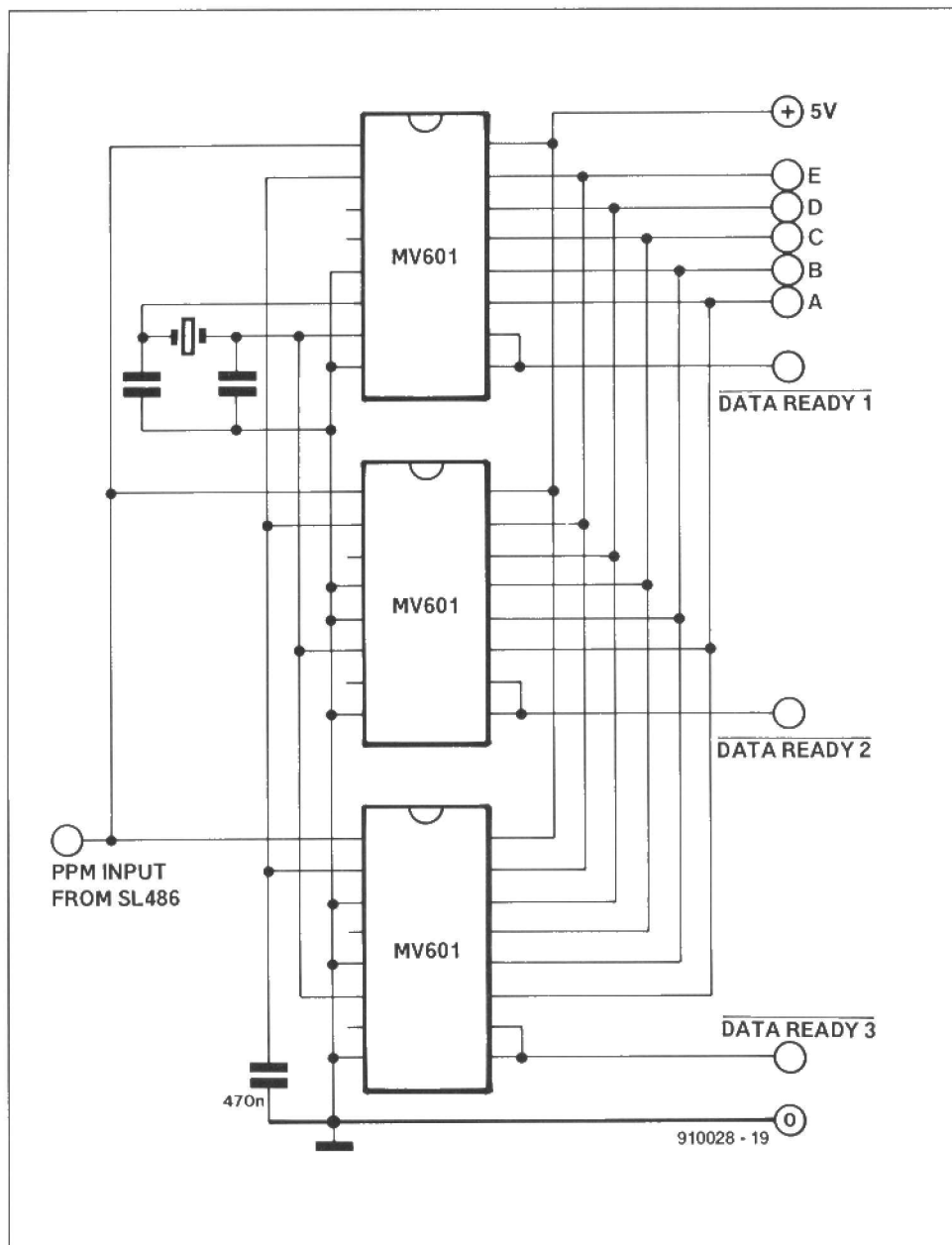


Fig. 9. 96-channel remote control receiver implemented on an 8-bit microprocessor bus.

connected to driver transistors (option H), or solid-state relays (option I). It should be noted, though, that these output configurations allow only 5 of the 32 possible channels

to be switched, since decoding is not applied. When more than 5 channels are required, simply add one or two 1-of-16 decoders, e.g., the CD4514 (option J).

Receiver option K works with the previously mentioned computer-controlled version of the transmitter, option B. The output register is set to latching (pin 5 held logic low), and the outputs of the MV601 are connected direct to a microprocessor input port. A simple handshaking arrangement may be implemented between the IR receiver and the microprocessor with the aid of the DATA READY and the OUTPUT ENABLE lines.

A single receiver has a maximum decoding capacity of 32 channels. This figure can be trebled by using three sets of transmitter/receiver, each wired to operate at its own transmission rate. As shown in Fig. 8, the complexity of a 96-channel remote control system is still within reason, mainly because the clock for all three receivers is supplied by a single oscillator. Also, a single reset line is used for the complete receiver system.

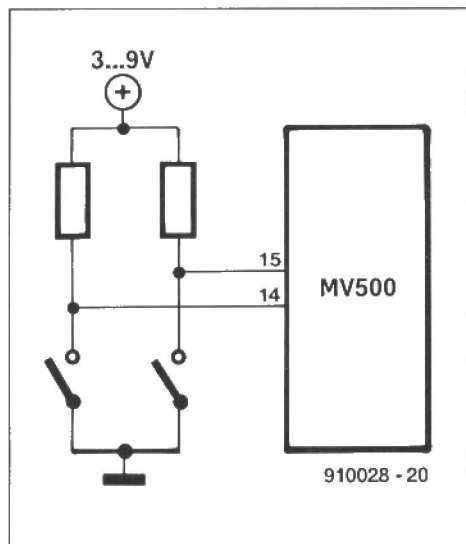


Fig. 10. Keyboard select extension for the transmitter.

channel receiver when an 8-bit microproces-

sor bus is available. Here, the DATA READY output is connected to the OUTPUT ENABLE input.

The receiver is not too complex either when it is extended. The two transmission rate inputs are held logic high with pull-up resistors. When a key is pressed, one of the inputs goes low, and a different MV601 is addressed. It is almost impossible to tamper with this system since the transmitter remains off when two keys are pressed simultaneously. Finally, the circuit in Fig. 10 shows an input configuration that allows you to switch between three keyboards. ■

References:

1. "Infra-red remote control", *Elektor Electronics* September 1990.
2. "Dimmer for halogen lights", *Elektor Electronics* April 1991.

Source:

Satellite & Cable TV IC Handbook, Publication P.S.2020, October 1988 (Plessey Semiconductors).

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ZAP51: AN 87C51 PROGRAMMER

Dr. David Kyte (Micro Amps)

IN my first article (Ref. 1) I described the problems associated with developing 87C51 single-chip microcontroller applications, especially the software. In the second article (Ref. 2), I described a low-cost in-circuit emulator (ICE) that provides the hobbyist with a route into simulation — conventionally the province of corporate/professional developers only. One final problem remains for the hobbyist. Having developed the software in situ in the target environment, the single-chip microcontroller needs to be programmed. Most low-cost EPROM programmers have 28-pin sockets and can not, therefore, program the 40-pin 87C51.

The ZAP51 described here is a minimum cost programmer that uses the ICE51 hardware as the program controller. The diagram in Fig. 1 describes the hardware.

The ZAP51 consists of a socket, P3, to plug the ICE51 into; a voltage converter circuit to generate 12.5 V from the 15-V power supply; and two zero-insertion force (ZIF) sockets: one 28-pin type, U1, to program EPROM devices, and a 40-pin type, U6, to program the microcontrollers. The ZAP51 can program CMOS devices only; hence, it will program the 87C51, but not the NMOS part, the 8751. The 8751 requires a 21-V programming voltage that, on cost considerations, was rejected on the programmer.

Software

The software supplied with the ZAP51 is split into two parts. The first part executes on the PC; the second part runs on the ICE51. The ICE51 program extends the functionality of the standard ICE51 monitor program to include programming code. The PC software includes menu-driven code to control the ICE51. A brief description of the procedure to program a microcontroller is presented below. This is followed by a description of each menu option.

To program a device

1. The RAM on the ICE51 should be set high using the monitor. Move the cursor over the 'mon' option, then press return. Fill memory with \$FF by typing

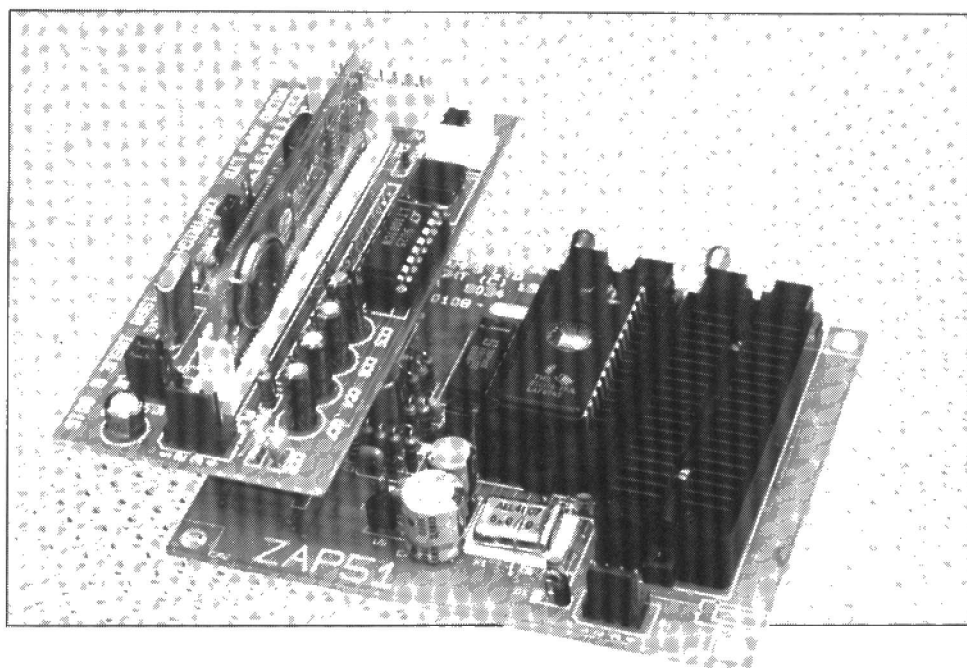
```
x 1000-2000 ff
```

then exit back to the menu using

```
q
```

2. The device type (microcontroller/EPROM) must be selected by position-

then pressing return.



3. To load a file, select the 'mon' option, then enter the command line

```
load |filename|
```

Enter 'q' to exit back to the menu.

4. The target address in the 87C51 must be set by defining the device offset address in hexadecimal.

```
offset  
0
```

5. The number of bytes to program must be entered using the option

```
#bytes  
0100
```

6. To program the device, select the 'program' option. The programmed data will be verified automatically after the programming function is complete.

7. Optionally, select the security lock, 1 and 2, or encryption functions during production device programming.

8. Repeat the entire procedure, or part of the procedure, on all devices, or exit the program to return to DOS.

Monitor

The software on the ZAP51 contains a super-set of standard ICE51 commands. As such, the development facilities on the ICE51 exist and can be accessed by selecting the monitor

#Bytes

The #Bytes option enables the user to define the number of bytes to use in any operation. It affects the number of bytes that are programmed, read, verified and check-summed. The numeric value is entered in hexadecimal.

Offset

This option selects the address in the target device to start programming or reading the data from. The value is entered in hex. It can be used to move, copy or relocate data within a device. Under most conditions, this value will normally be set to 0.

Read

Data is read from the device into the ICE51 memory. It can be examined and modified using the monitor option. For example, to read \$100 bytes from the start of an EPROM, enter

```
offset 0  
#bytes 0100  
read
```

To modify the data, enter the monitor using the 'mon' option. Data is read into the ICE starting at address \$1000. Hence, to dump the data, execute the monitor command

```
x 1000 - 1010
```

To modify the code, enter

```
x 1000 1,2,3,4 ...
```

To return to the menu, enter

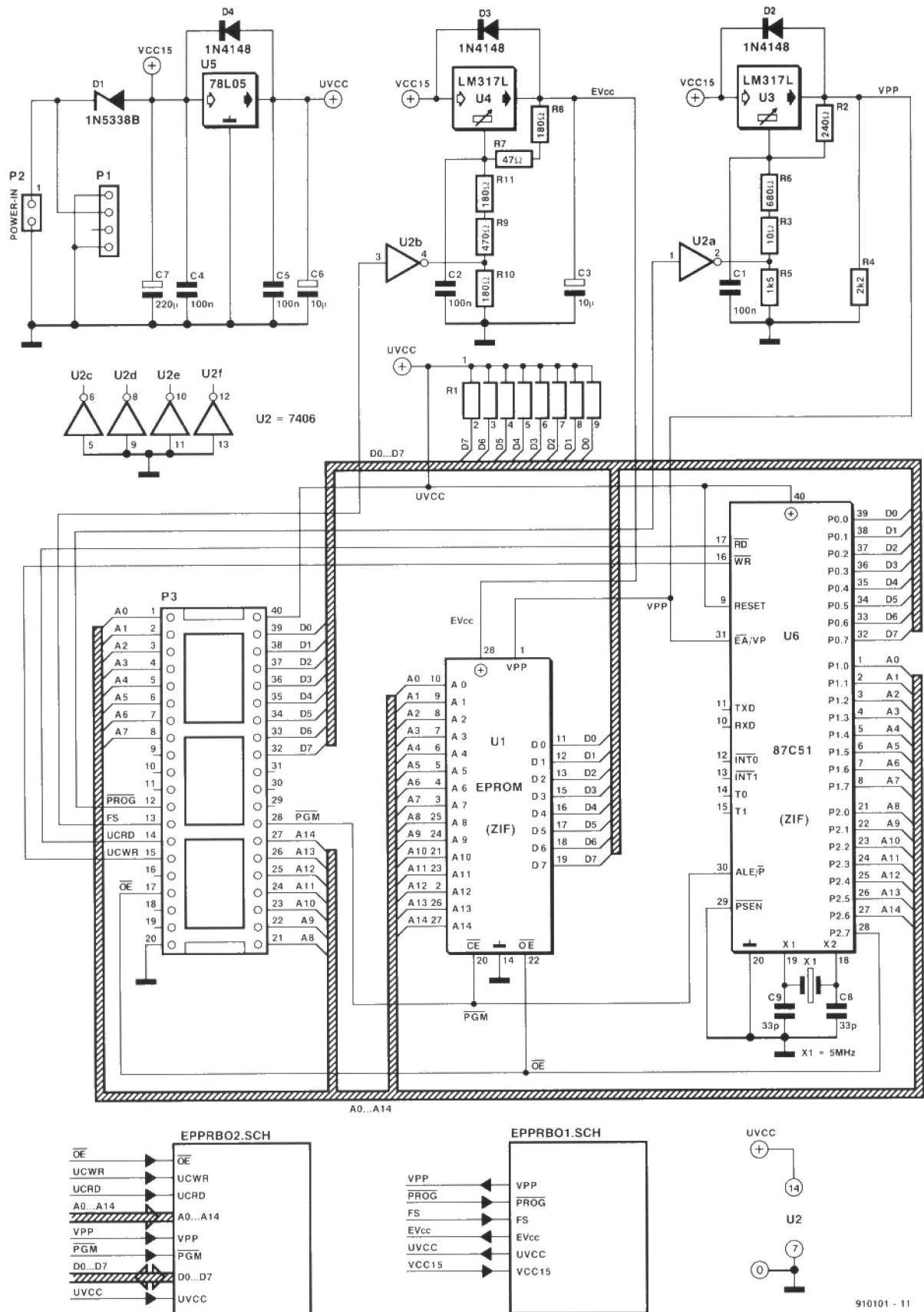
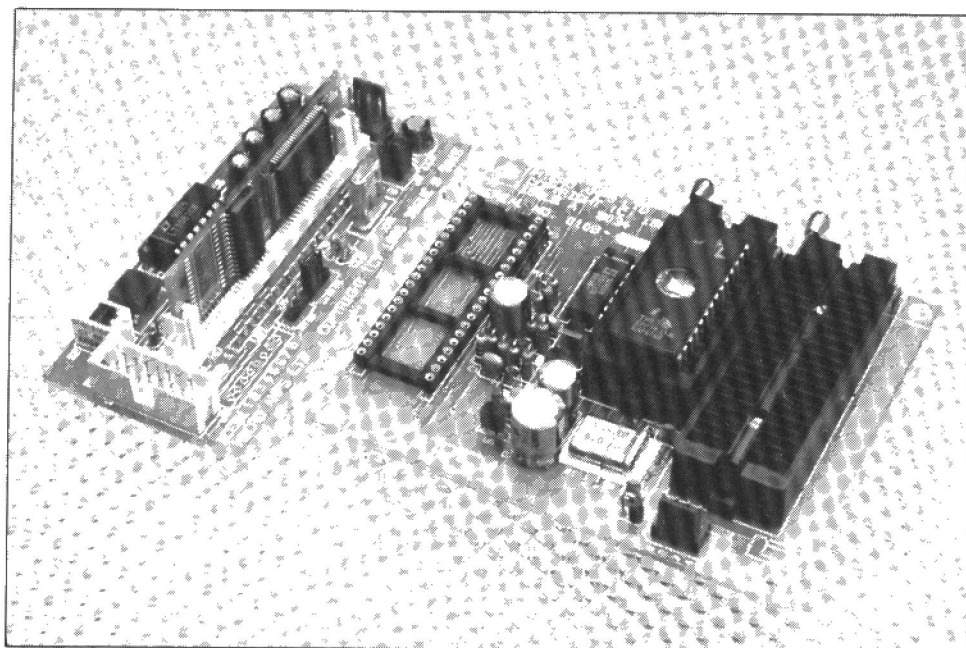


Fig. 1. Circuit diagram of the ZAP51.



q

The modified data can now be programmed into the new device. By default, when the ICE51 powers up, the ICE51 offset value is set to \$1000 in the startup file. Consequently, data loaded from an Intel hex file is offset by \$1000 bytes — the data byte for address 0 is loaded at address \$1000, \$1→\$1001, etc.

To display the ICE51 offset value, enter

o

whilst in the monitor. The display should respond with the value of 1000. If any other value is displayed, set the offset back to 1000 by entering

o 1000

If code is read from an EPROM, it will be stored at address \$1000 in the data memory. To disassemble that data, the data pointer in the ICE51 must be changed. The data pointer defines the boundary between data memory and code memory in the DS2250 device. Normally, the ICE51 code memory is set between addresses 0 and \$0FFF when using the ZAP51. Data memory is then available above address \$1000. The list command, 'l' is used to list disassembled code memory:

l 0-10

but it operates on code memory only. To disassemble the contents of data memory above \$1000, the data memory must be temporarily changed to code memory. You can do this by entering

```
data 4000
l 1000-2000
data 1000
```

It is vital that the data pointer be returned to 1000 after executing this command sequence. Otherwise, incorrect data will be programmed or read from the device.

Program

#Bytes of data is programmed into the selected device starting at the target address of offset. 'Program' automatically calls 'verify' to check the result of the programming operation.

Verify

The contents of the device can be verified against the contents of either an Intel-hex file or another device. In the former case, data is read into RAM using the monitor to load the file as described above. Next, the file can be verified against the device in the socket. To compare two devices, read the first device, then verify its contents against that of the second device.

Checksum

This option enables the user to generate a checksum from the data in memory, which can be used to monitor the integrity whilst programming multiple devices. After each device is programmed, a checksum is generated reflecting the contents of memory used to program the device. The checksum provides a visual reassurance that consistent data is being used in successive devices.

27C128/27C256/87C51

These options select the type of device that is to be programmed. In the latter case, the 87C51 is programmed in the 40-pin ZIF socket, while with the former two devices the 28-pin socket is used.

BlankCheck

BlankCheck provides the user with the tools to check that a region of memory can be programmed, i.e., it is in an erased state.

Security locks

The 87C51 provides two security lock bits. The first, SL1, prevents further programming of the device — a useful feature if master devices are going to be generated. The second security bit, SL2, prevents the device from being read. This bit is programmed

normally on production parts for commercial security reasons only. Both the lock bits are cleared when the device is erased using ultra violet light.

Encrypt

The 87C51 provides a facility to encrypt the data in the on-chip EPROM. A 32-byte encryption table is used to XNOR with the on-chip code. The encryption table provides a degree of security from unscrupulous software pirates.

Quit

This option takes the user back to the DOS command line interpreter.

Prospective

The 87C51 in its one-time programmable form costs about £18.00. Since it is often the only device required to implement many applications, custom designs are cheap to manufacture. An added advantage — if the designer creates a 'winning product' — is that the cost to manufacture in quantities by making a masked device tumbles to less than £2.00 per device. ■

References:

1. "The 8031/8751 Microcontroller", *Elektor Electronics* July 1990, p. 36.
2. "8031 In-circuit emulator", *Elektor Electronics* January 1991, p.50.

For further reading:

"Programmer for the 8751", *Elektor Electronics* November 1990.

For further information on the ICE51 and the ZAP51, contact the author at Micro Amps Ltd. • 66 Smithbrook Kilns • Cranleigh • Surrey GU6 8JJ • England. Telephone: (0483) 505395. Fax: (0483) 268397.

INTERMEDIATE PROJECT

A series of projects for the not-so-experienced constructor. Although each article will describe in detail the operation, use, construction and, where relevant, the underlying theory of the project, constructors will, none the less, require an elementary knowledge of electronic engineering. Each project in the series will be based on inexpensive and commonly available parts

BUILD THE OPTICALOCK – PART 1

by Michael Swartzendruber

Combination locks are useful because they can not be picked like a 'key' lock can. If a combination lock could sound an alarm before it was cracked', the odds of stumbling on the correct combination would be very slim. The trouble with combination locks is that they have preset/unchangeable combinations. Such combinations are a security risk, since they may fall into the hands of the wrong people. So, how about creating a programmable combination lock system unlike any other in the world that is so innovative that practically nobody can crack the code?

THE lock system described in this article is well adapted for controlled entrances for the following reasons: 1) it will allow only three incorrect attempts at the correct combinations before it will trigger an alarm system; 2) the combination is programmable at any time – moreover, the process of reprogramming is as easy as setting the frequency of a garage door opener; 3) the lock has 127 possible combinations – with only three entry attempts allowed, the risks of an unauthorized entry are very small; 4) because of its innovative nature, it is highly

unlikely that any unauthorized person will possess a 'skeleton key'.

The key

The design goal of the key to this system is convenience. It is reprogrammable at any time. And, since it is 'palm sized', it could be mounted into any small enclosure and could be added easily to a key ring.

The key's operation and construction are very basic. It may be easily assembled on the printed circuit board shown in Fig. 6.

The key operates as follows—see Fig. 1: all the enabled infra-red (IR) emitters are actuated by closing the normally open push-button switch. This connects battery power to the buses on the keyboard. Each of the IR emitters is wired in parallel across this power bus.

The only emitters that are enabled are those that have power passing through their branch; power is applied to the emitter by the DIP switch, S₂, in that branch. If the DIP switch in a branch is closed, current will flow through that branch and that emitter will be active. If the DIP switch in that channel is open, the emitter will have no current and will not be active. The resistors hold the current to a level that is safe for the reliable operation of the emitters.

The infra-red emitters correspond with detectors inside the lock unit. The lock will be programmed to expect certain IR emitters to

be active by the setting of its corresponding DIP switch element. In this manner, any combination can be chosen or changed at will, but the lock will 'open' only if the combination in the lock and that in the key are exact matches.

The lock

The lock part of the combination system is divided into four distinct functional areas: the infra-red detector array and amplifier section; the combination programming section; the combination decoder logic array and lock driver; and the entry attempt counter and alarm trigger driver. Each of these sections will be described individually, after which the operation of the system should be easy to grasp.

Sensor/amplifier array (keyhole)

The infra-red detectors and detector amplifier array in Fig. 2 form the 'keyhole' of the system. The IR detector array, T₁–T₈, senses which of the emitters of the key are active. When the detectors are exposed to IR radiation, they begin to conduct. This raises the voltage at the base of the current amplifying transistor connected to the relevant detector. The transistor is then switched on and a logic high voltage becomes present at the emitter side of the biasing resistor. This voltage

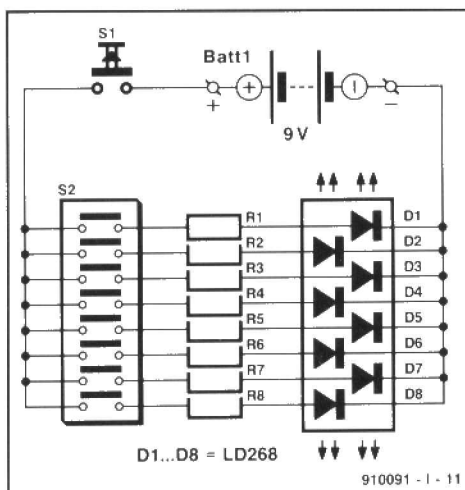


Fig. 1. Circuit diagram of the 'key' to the electronic combination lock.

is used as the input to gates of logic sections. Amplifier channels that are not stimulated with IR energy stay clamped at a logic low level.

The combination decoder

The combination detector/lock driver section operates as follows—see Fig. 3. The eight output lines of the IR detector amplifier array, A–H, are applied in parallel to the eight Q inputs of magnitude comparator IC₃, and to the eight inputs of NOR gate IC₅. The eight P inputs of IC₃ are linked to DIP switch S₄ on which the unlock code is set. If the key described earlier is programmed with a specific emitter enabled, its relevant detector will clamp on and the amplifier circuit will apply a high-level signal to the P input and the input of IC₅ associated with that detector channel.

Provided the code set in the key matches that set in the receiver, that is, when the two DIP switches are set to the same bit combination, output P=Q (pin 19) of the comparator goes logic high when the push-button on the key is pressed. If the two bit combinations do not match, the P=Q output will remain logic low. When a match occurs, the high level at the P=Q output is applied to IC₈, a Type PWRDRV1 high-current drive IC. This driver actuates a solenoid locking mechanism or relay coil or any other electromechanical device you may wish to drive.

The 8-input NOR gate, IC₇, functions as a digital signal detector. Its output, pin 13, goes low whenever one or more inputs are taken logic high, that is, whenever the key is used to transmit a code, whether this is valid or not. This enables the NOR gate to clock the code entry counter, bistables (US: flip-flops) IC_{4a}–IC_{4b}, via the CLK input of IC_{4a}.

The lock mechanism may be overridden by switching the OUTPUT ENABLE pin of the 8-bit magnitude comparator to V_{cc}. This clamps the P=Q output low. Note also that an LED will light whenever the Power Driver is applying current to the load. This LED is used to indicate when the device is 'unlocked'.

The output signal of AND gate IC_{6b} is used to clear the counter in the unauthorized attempt detection block. The signal is applied to the CLR input of a pair of JK bistables (US: flip-flops), IC_{4a} and IC_{4b}.

The unauthorized-attempt counter and alarm driver

The unauthorized-attempt counter and alarm actuation block operates as follows. All the signals from the detector array are OR-ed together in IC₅. Whenever any of the sensors detects an IR signal, the output of IC₅ will pulse high while the excitation lasts and is used to clock a pair of JK bistables (US: flip-flops), IC_{4a} and IC_{4b}.

The bistables are hard-wired in toggle mode, that is, they will switch states with every clock input. The Q output of the first flip-flop is connected to the CLK input of the second bistable: this configuration forms a two-stage ripple counter. The Q outputs of both flip-flops

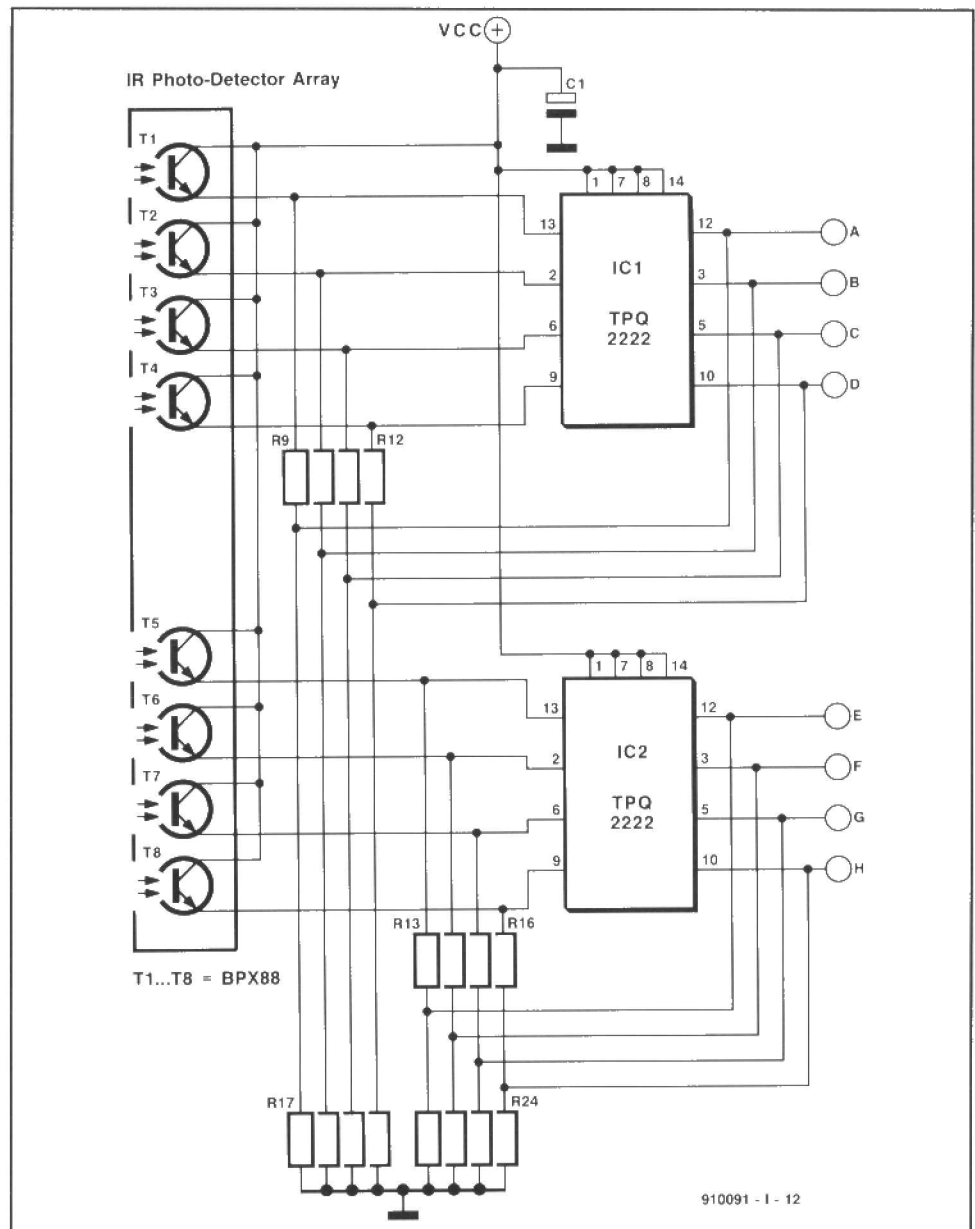


Fig. 2. Circuit diagram of the infra-red detector/amplifier array.

are wired to an AND gate, IC_{6b}; when both are in a high state, representing binary 11 or decimal 3, the two inputs to the AND gate will be high. This enables the AND gate. Its output drives a Type PWRDRV1 chip that controls a relay.

The contacts of the relay can be wired easily as a normally open or normally closed switching detector in any existing alarm loop or they can enable an alarm.

The alarm may be disabled by closing the ALARMCLEAR switch, S₃. This action causes a pulse to be applied to the CLR lines of the bistables to disable the alarm relay.

Constructing the lock

It is best to begin the project with constructing the key. Start by inserting a 16-pin DIP socket into the circuit board (marked S₁). Make sure that all the leads go cleanly through the board and that the socket is held firmly against the top side of the board. Solder all the leads of the socket to the board, taking care not to make any solder bridges between the closely spaced adjacent pads. Insert an 8-po-

sition single-pole, single-throw DIP switch into the socket.

Insert resistors R₁–R₈ into the appropriate positions on the board. Note that, in an effort to keep the board small, they should be placed at an angle: the part that is lifted off the board should point to the DIP switch socket.

Next, install the leads of a 9-V-battery clip in the holes marked + and –. Cut two 2-in. (5 cm) long pieces of solid hook-up wire and strip 1/8 in. (3 mm) of insulation from each end of the wires. Solder the two wire ends to the pads marked S₁ on the board. Solder each of the free ends to one of the lugs of a normally-open momentary-contact pushbutton switch.

Finally, install the IR emitter array, D₁–D₈, according to the detail drawing. Note that this device is polarized, that is, it will work only if it is installed correctly. Once you are sure it is placed correctly, solder all terminals into place. Make all solder connections quickly or use a heatsink to avoid possible heat damage to the device.

When the board is completed, hook up

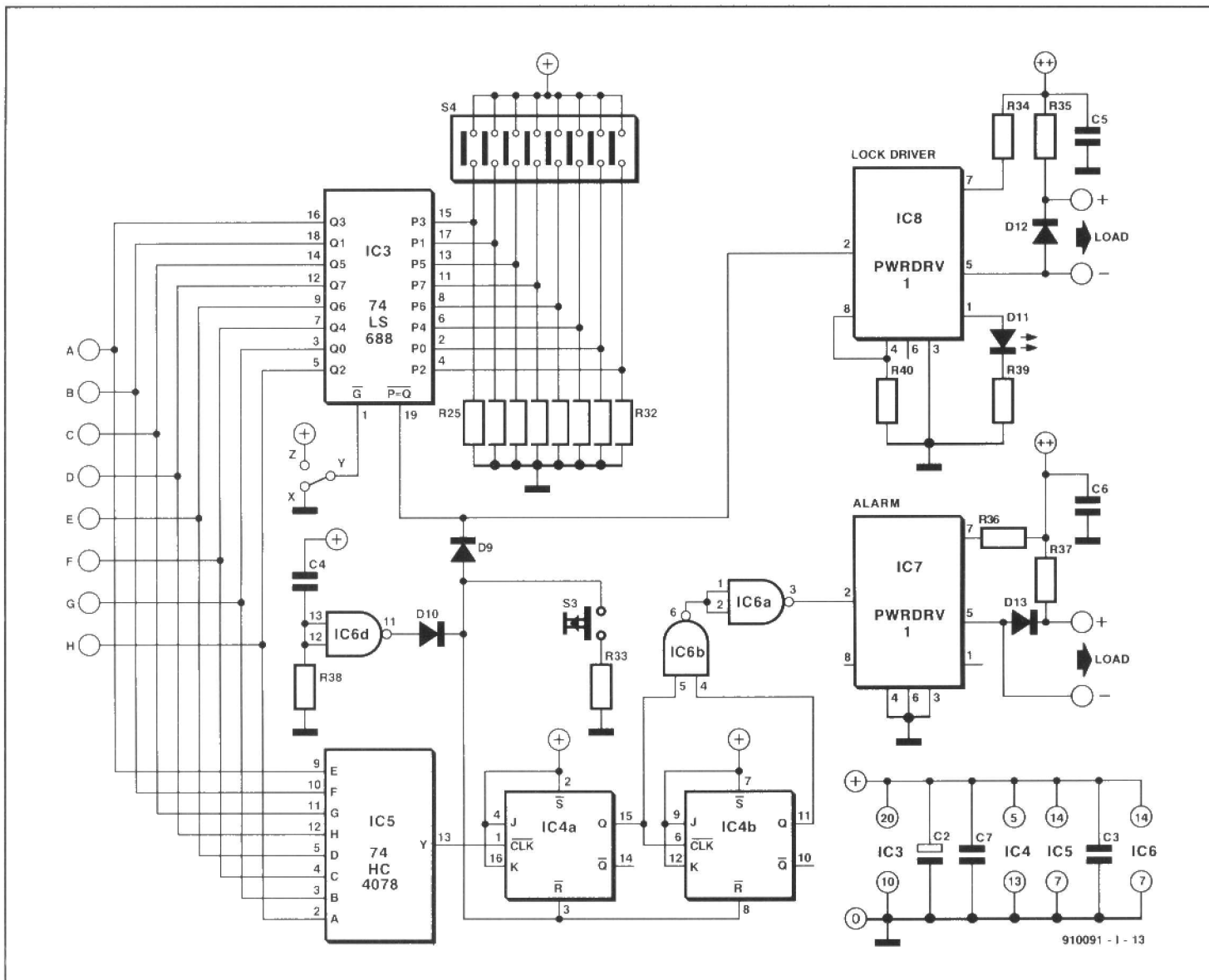


Fig. 3. Circuit diagram of the main logic board.

the simple test jig shown to test the operation. Open, or close, each of the DIP switches one at a time and aim that emitter at the test jig. The voltage level indicated by the meter should be about 5 V. If none of the emitters works, check the battery wiring, the polarity orientation of the array, and the wiring of the test jig. If one, or more but not all, of the emitters fails, replace the array.

Next, complete the sensor array and amplifier board. First, prepare the leads of the IR array, Q₁—Q₈, so that they will 'mate' with the corresponding emitters from the key according to the assembly detail drawing. Make sure that the polarized device is installed correctly or the entire assembly will not work properly. Solder the array into place; make all connections quickly or use a heat sink to avoid any possible damage to the devices contained in the array.

Next, install sockets for the current-amplifying circuits, IC₁ and IC₂. Seat them firmly against the board by bending out the corner leads at an angle of 60°. Solder the sockets to the board; be careful not to create solder bridges between any closely spaced pads.

Install base bias resistors R₉—R₁₆ and emit-

ter resistors R₁₇—R₂₄ on to the board and bend their terminals to hold them in place. Then solder all terminals to the board and cut away all excess lead lengths.

Solder voltage stabilizing capacitor C₁ to the board. Observe correct polarity: improperly installed electrolytic capacitors can (and do) explode. When that happens, it is loud, messy and a little unnerving.

Prepare two pieces of 18 AWG (1 mm²) wire by stripping 1/8 in (3 mm) from one end of both pieces. Insert the bare ends into + and - respectively.

Test the board by applying 5 V d.c. (observe polarity) to the circuit. At each collector in the transistor sockets and on the detector array, 5 V should be measured. All other locations on the board should be 0 V. If the board passes this test, switch off the power and fit the transistor arrays.

The next test is to aim the emitter key at the array detectors and measure the voltages at the emitters of the amplifying transistors. They should be high if that emitter is enabled and low otherwise.

Remove the power from the assembly and attach an 8-conductor ribbon cable to

the output port of the board. Carefully separate the wires from the ribbon over about 3–4 in. (7.5–10 cm). Carefully stripe each of the conductors, twist the fine wires together and lightly tin the ends of each conductor. Insert one end of the ribbon cable into the output port of the sensor array board and put the assembly aside till the next board is completed.

Note: if the IR sensor array will be exposed to electric light, especially fluorescent light, in its normal application, RF bypass capacitors (0.001 µF polyester 'chicklet' types) should be soldered across the collector and emitter leads of each IR detector to prevent false amplifier circuit triggering from the electric light source. See the detail photograph that shows how this can be done.

The next module to be constructed is the main logic board. Start by fitting IC sockets for IC₃—IC₈. Make sure that the sockets are flush with the board before soldering them into place. Install a 16-pin DIP socket for S₄.

Prepare insulated jumper wires for each of the jumpers on the board by measuring the wire next to the jumper location and adding sufficient length to each end for PCB penetration and soldering. Carefully place the

jumpers flat against the board and solder in place. Clip away all excess lead length. In some cases, the jumpers will lie very close to where other components or wire connections will be, so make sure to route them so that they

PARTS LIST

Resistors:

R1–R8 = 156 Ω *
 R9–R16, R38 = 10 k Ω *
 R17–R24 = 220 Ω *
 R25–R32 = 330 Ω *
 R33 = 3.3 k Ω *
 R34, R36 = 2.7 k Ω , 1/2 W, 5%
 R35, R37 = 56 Ω , 1 W, 10%
 R39 = 1 k Ω *
 R40 = 470 Ω *
 * = 1/4 W, 5%

Capacitors:

C1 = 100 μ F, 16 V, electrolytic
 C2 = 220 μ F, 16 V, electrolytic
 C3, C4, C7 = 1 μ F**
 C5, C6 = 10 μ F**
 ** = ceramic or polyester

Semiconductors:

D1–D8 = 8-position IR emitter,
 Siemens Type LD268
 D9, D10 = 1N914 or general purpose
 switching diode
 D11 = LED, 3/4 Texas
 D12, D13 = 1N4002
 Q1–Q8 = 8-position IR phototransistor,
 Siemens Type BPX88
 IC1, IC2 = transistor array, Sprague
 Type TPQ2222
 IC3 = 8-bit magnitude comparator,
 Texas Type 74LS688
 IC4 = dual JK flip-flop,
 Texas Type 74LS76
 IC5 = 8-input OR gate,
 Texas Type 74HC4078
 IC6 = quad AND gate,
 Texas Type 74LS00
 IC7, IC8 = PWRDRV1 (Power
 Technologies)

Miscellaneous:

S1, S3 = normally open,
 momentary-contact switch
 S2, S4 = 8-position SPST DIP switch
 S5 = SPDT slide or toggle switch
 circuit boards; solder; circuit (hook-up)
 wire; jumper wires; enclosures;
 mounting hardware; battery clip for 9 V
 battery; IC sockets; 0.1x0.1 in. right-
 angle circuit board headers; ribbon
 cable.

In the USA, the chip set may be obtained from Artronix, PO Box 221393, Sacramento, Ca. 95822, at a cost of \$35.00 (excl. sales tax). Add \$3.50 for postage and handling. Allow 4–6 weeks for delivery.

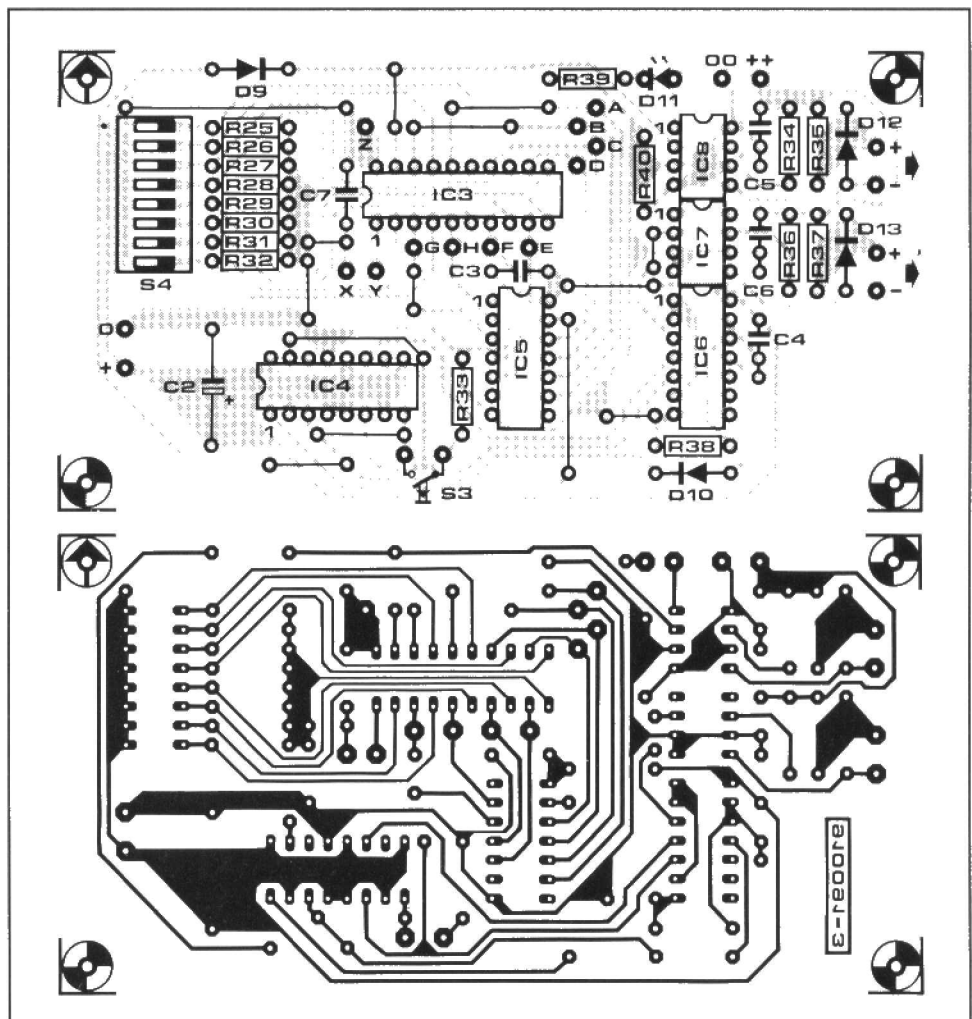


Fig. 4. Main logic board.

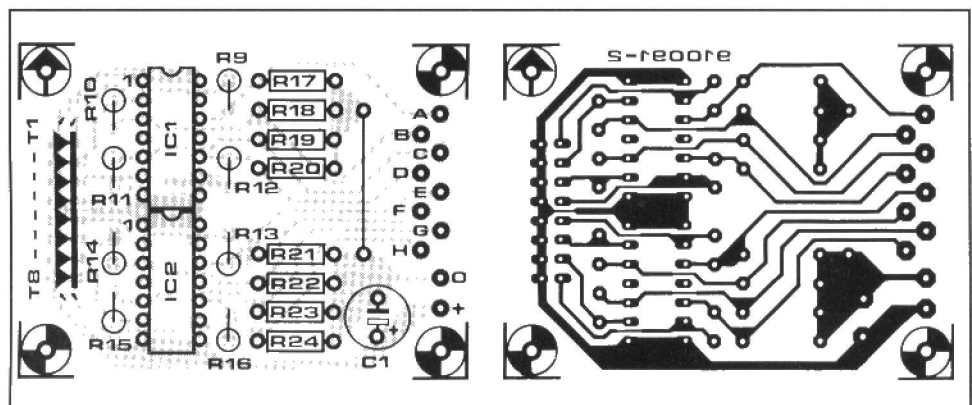


Fig. 5. PCB for the IR detector/amplifier array.

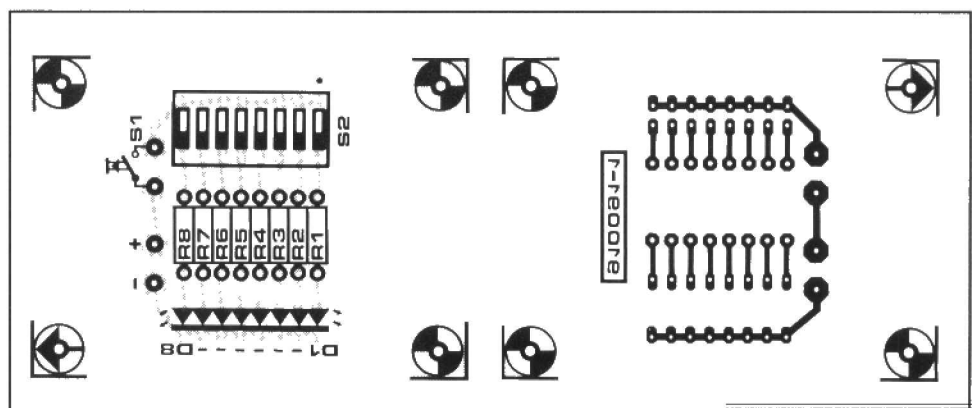


Fig. 6. Printed circuit board for the 'key'.

will not interfere with these components.

Next, fit resistors R_{25} – R_{40} . Clip away the excess lead length from these components after they are soldered in. Inspect your work as you progress, look for bad solder joints or solder bridges between any of the closely spaced pads or circuit tracks.

Install D_9 – D_{13} . Use heat sparingly on these devices when soldering them to the board. Also, observe correct polarity. When you are certain that the devices are properly oriented, solder them to the board and clip away the excess lead lengths.

Fit capacitors C_2 – C_7 . Note that some of these components are polarized electrolytic types; make sure that correct polarity is observed. When the capacitors are fitted correctly on the board, solder them into place.

Prepare the following from solid 22 AWG (0.6 mm dia.) circuit wire: two 6-in. (15 cm) lengths, stripped $1/4$ in. (6 mm) at each end for the alarm reset switch, S_3 , and three 8-in. (20 cm) lengths for lock enable switch S_5 . Solder these wires to the appropriate locations on the board and then attach them to the relevant lugs on the switches.

Test the board by applying 24 V d.c. and 5 V d.c. to the appropriate points on the board (observe polarity) and make the following measurements: pins 7 and 8 of IC_7 and IC_8

should be at 24 V d.c.; all others pins on the two sockets should be 0 V.

Insert S_4 into its socket with the ON side located towards R_{25} – R_{32} . Close all the switches, whereupon pins 2, 4, 6, 8, 11, 13, 15, and 17, of IC_3 should be at 5 V d.c. Open all the switches, whereupon these pins should be at 0 V. The level at pin 1 may be high or low, depending on the position of change-over switch S_5 , connected to points X, Y and Z. Pin 20 should be at 5 V d.c. all the time. All other pins should be at 0 V all the time.

Pins 2, 4, 5, 7, 9, 12, and 16, of IC_4 should be at 5 V d.c. All other pins should be at 0 V all the time.

Pin 14 of IC_5 and IC_6 should be at 5 V d.c.; all other pins on these sockets should be at 0 V.

If you measure any levels other than the ones stated, stop and find the reason for the incorrect reading. Once this has been found, retest the board as outlined.

Next, remove the power from the circuit. Attach the ribbon cable between the sensor array board (completed earlier) and the main logic board. The letters on the main logic board correspond to the channel letter output of the sensor detector/amplifier array.

Prepare the cable for assembly by carefully stripping the insulation from the ends of the

wires. Be careful not to nick the fine-strand conductors. Twist the conductors together and lightly tin the wires: take care not to damage the cable insulation with heat from the soldering iron. Separate the cable along the centre conductors in the cable to a length of 3 in. (7.5 cm) from the end. Next, separate each conductor in the ribbon over about 1 in. (2.5 cm) from the end. Insert the wires from each channel into the corresponding pad of the main logic board. Note that channels 7 and 8 are not in order and must be given a 'half twist'.

Attach a relay or solenoid coil, or any other suitable type of load, to the load points on the logic board. Mount the sensor detector/amplifier array, the main logic board and the output loads in an appropriate enclosure. Set switch S_5 so that pin 1 of IC_3 is low to enable the lock driver.

Install IC_3 – IC_8 into their respective sockets: make sure that they are correctly oriented and that all pins insert correctly before pushing them home. Note that IC_3 , IC_5 , IC_7 , and IC_8 , are sensitive to electrostatic energy so take the appropriate precautions when handling these devices. ■

Next month's final part of this article will deal with programming and testing the optical lock.

DESIGN IDEAS

The contents of this column are based solely on information supplied by the author and do not imply practical experience by **Elektor Electronics**

Keyboard circuit

by D. Nelson

THERE are many chips on the market that may be used in a keyboard circuit, but many of these are fixed and do not provide all the keys required. For example, RCA's CDP 1871 is an excellent device, CMOS logic and low power requirement, but it does not provide for the backspace key to be coded as hex 08. Instead, it uses the delete key, coded as hex 7F. Although it is possible to change the software to recognize the different code, this is not always easy. The aim of the design offered here is a keyboard that can produce every code but is also able to be hooked up as a standard keyboard.

To provide a matrix that will encode the 128 combinations of the ASCII code, 16×8 lines are needed. If all 128 keys are to be used, a strobe output to signal that a key

has been operated is also required.

In the diagram, IC_5 , IC_6 , and IC_8 are all CD4051 single 8-channel multiplexers. The strobe is generated by stopping the clock that drives seven-stage ripple counter IC_2 via an AND gate, because the battery on pin 9 is earthed via the matrix and two of the multiplexers.

The key code is contained in the output of the ripple counter and the strobe is provided by the Schmitt trigger NAND gate that will oscillate with an unequal mark-space ratio; since the diode used is a germanium type. A silicon diode would, of course, do as well, provided it is shunted by a high value resistor. The oscillation provides a repeat function of the key that is pressed. Since the strobe is in the wrong sense to that re-

quired by the following circuit, it is inverted by an additional transistor.

To give the conventional keyboard the functions of shift and control keys, extra gating is required, and that is the purpose of the rest of the circuit. Control has precedence and, by means of two AND gates, forces bits 6 and 7 low. The control key is non-locking.

The shift key is arranged to convert lower case letters to upper case so that it is necessary to wire the alpha keys in the lower case matrix positions. This key is conventional non-locking and inverts bits 6 and 5 of the output code. The shift-lock is coupled capacitively to the same AND gate as the shift key, so that the gate is toggled by the shift-lock key and will stay with the

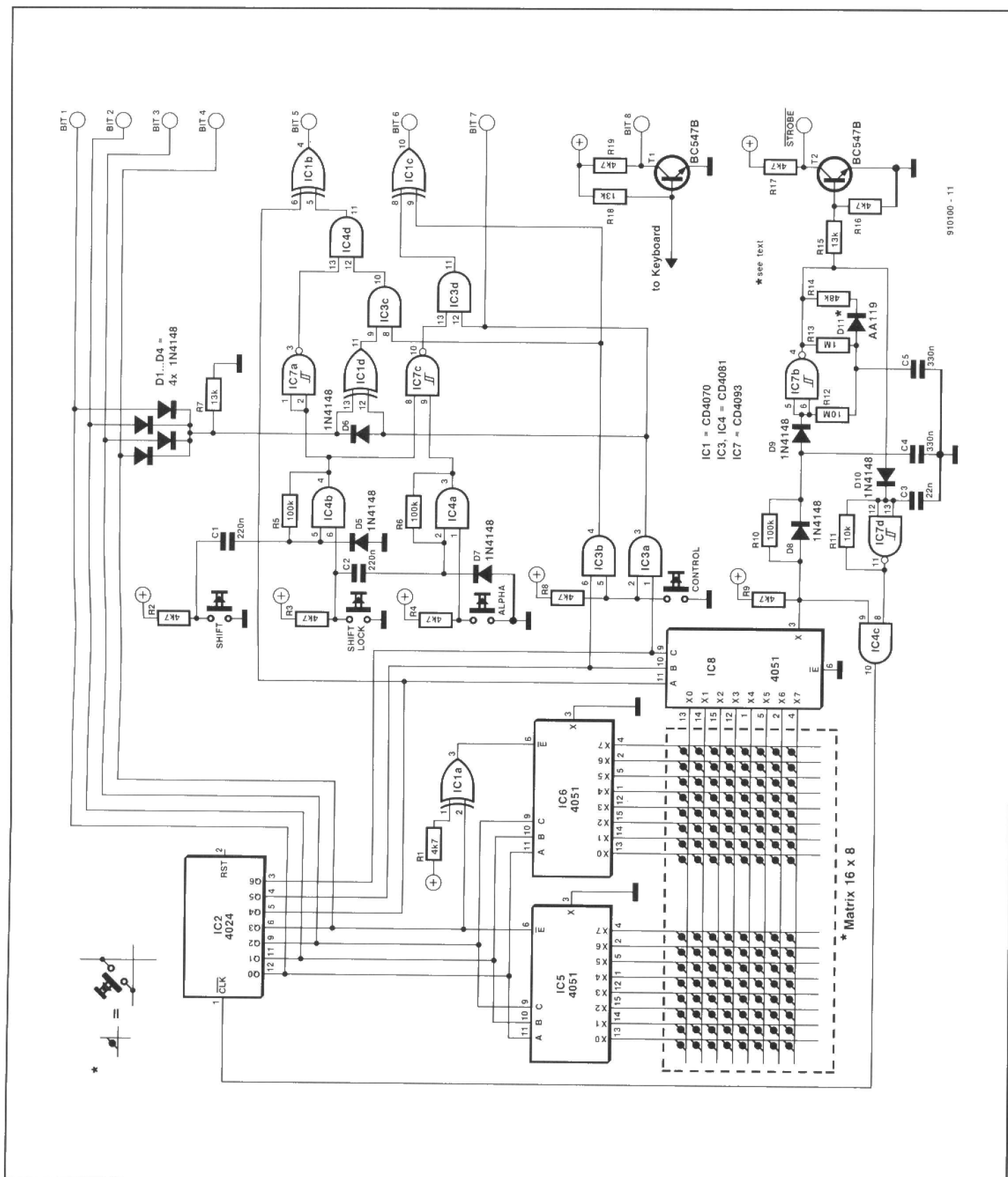
output low when the shift-lock is released. The shift-lock is released by pressing the shift key and releasing it again.

One other feature has been included to make the keyboard friendly to computers: the alpha key. This changes lower case to upper case without shifting the keys with an ASCII code between 20 and 3F hex, that is, the numbers row on a standard keyboard. This key is locking and implemented in the same way as the shift-lock key. The

alpha key is released by operating the shift-lock.

Only one key now remains an enigma: the space bar. Without any extra gating, this gives a 0 if the shift or shift-lock is operated, and this is clearly not acceptable. To correct this, five diodes have been added, one each from the four least significant lines and one between the two inputs of the XOR gate in bit 5, so that a space remains a space, shifted or not.

Two further features of the circuit require a mention. One is the transistor feeding the most significant bit 8. If this is connected to its own key, it can be used in conjunction with other keys to give hex codes from 80 to FF. The other is tied up with the clock and strobe. A diode is fed back from the output of the repeat strobe oscillator to the main clock. This is necessary to prevent a false output if a second key is pressed before the first one is released.



A CHEAP, EFFICIENT, STRATEGIC FIRE ALARM

by C.C. Whitehead

A fire may be started by an unstubbed cigarette-end, a faulty electrical appliance carelessly left on, or lighted paper shoved through the letter-box by vandals. You may, like a great many people have furniture stuffed with deadly polyurethane foam, which catches alight easily, burns rapidly and produces vast quantities of dense and highly toxic smoke. In most cases, smoke is the killer. People asleep are poisoned and rendered helpless long before the heat gets to them to finish the job. And all this happens in a surprisingly short time: a few minutes at most.

A NEIGHBOUR of mine showed me the fire alarm she had had installed in her living room. It was not particularly cheap, but nevertheless reasonable in price. It was efficient, but certainly not strategic. In effect, it protected one room only, or at most one floor of a two-storey house if all doors on that floor were left open.

The experts—professional firemen—have shown us clearly how domestic fires nearly always start, what happens in the first few minutes from the start, and what the main danger to life is.

In all cases, *smoke* is the main hazard and that is why most fire alarms are smoke detectors. Fortunately, these can be made very efficient at little cost.

Once the fire has started, hot air carrying smoke quickly makes its way to the highest point it can reach in the building, forming a layer just below the ceiling, and then filling first the room or passage and subsequently the whole building from the ceiling downwards. That is why firemen, and those who are trying to escape from the fire, keep as low down near the floor as they can, even crawl if necessary. It is clear that a smoke detector should be installed on or near the ceiling, certainly high up in a room.



Fig. 1. Correct position of smoke detector.

A smoke detector/alarm can be installed in every room, but that is quite an expensive business. So is the installation of smoke detectors in every room connected to a central alarm, which involves wiring costs.

The cheapest method, without sacrific-

ing too much in the way of efficiency is to install a single smoke detector/alarm at the most strategic point in the building. In a two-storey house that is at the top of the staircase leading to the second floor, close to or on the ceiling—see Fig. 1.

Dealers may, of course—and quite rightly—point out that this system loses a few seconds of time in indicating the start of the fire, and that, if the fire starts in a room of which the door is closed, considerable damage may occur before the alarm goes off. This is true, but the alarm still gives time to awaken sleeping people and allows them time to make their escape; in this respect it is as effective as any other system: it is all a matter of seconds after the start of a fire.

Circuit diagrams of a battery-operated version and of a mains-operated version of the unit are shown in Fig. 2 and Fig. 3 respectively. To avoid duplication of the description, the designation of the essential components is the same in the two diagrams.

The relay is a miniature type available from many suppliers; it has an operating 'on' voltage of 5–7 V at 10 mA. The coil resistance is 600 Ω . In a simplified version of the battery unit, Tandy Type 275-232 may be used: this has only one set of contacts. The

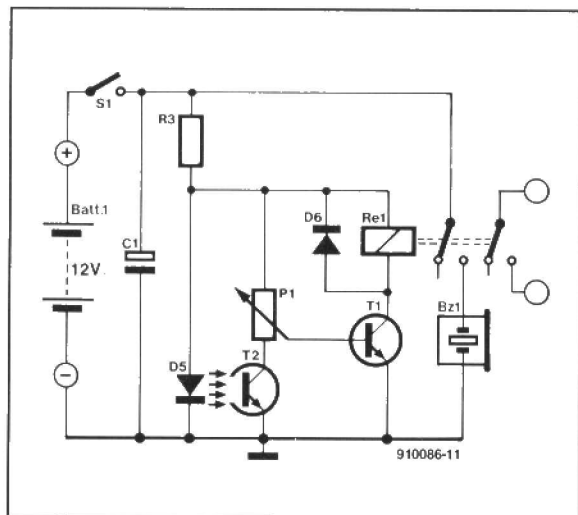


Fig. 2. Battery-operated version of smoke detector.

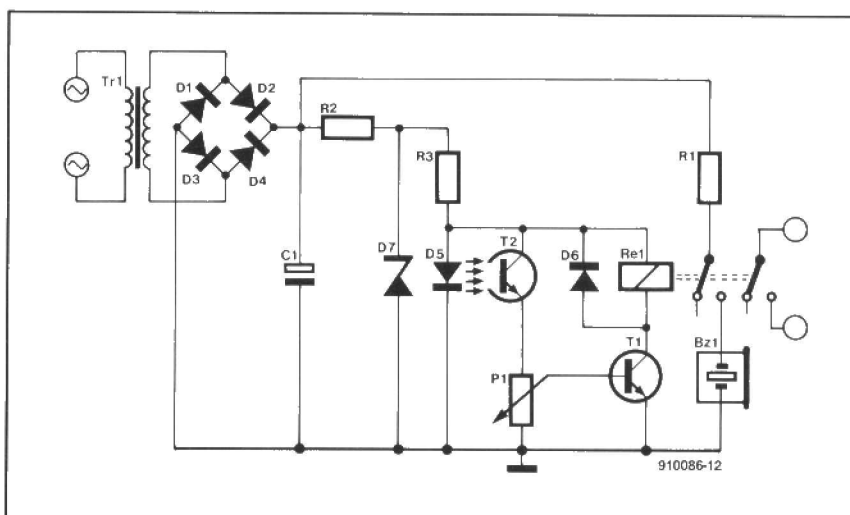


Fig. 3. Mains-operated version of smoke detector.

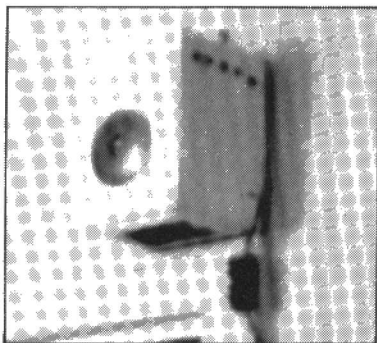


Fig. 4. Detail of mounting of unit (see Fig. 1).

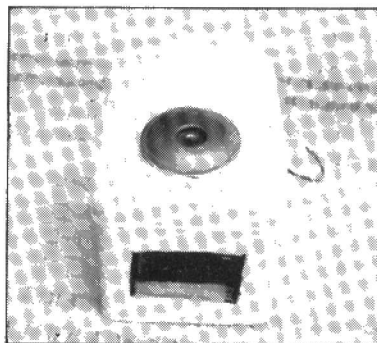


Fig. 5. Smoke hole at underside of unit.

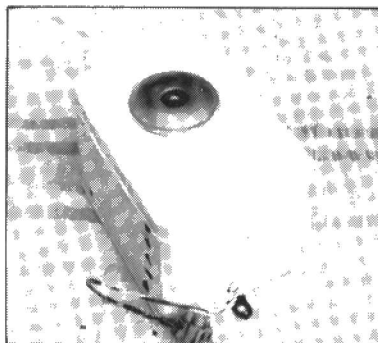


Fig. 6. General view of front of unit.

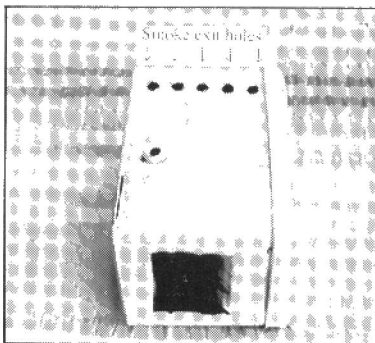
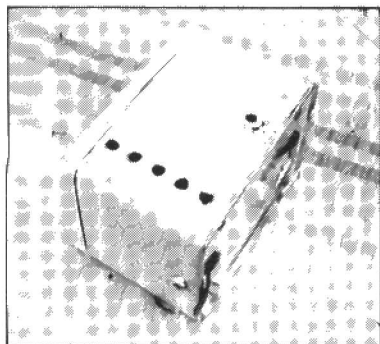


Fig. 7. General view of right-hand side of unit.

Fig. 8. Smoke escape holes and holes for connecting leads to mains, escape lamp and access to P_1 .

objective is to keep the power consumption of the relay (in the non-alarm condition of the unit) as low as possible to extend the battery life.

There are two ways in which the unit can be made to function, depending on the position of infra-red (IR) emitting diode D_5 and IR photodetector T_2 . As shown in the diagrams, when there is no interruption of the light path between D_5 and T_2 , the relay is energized and the supply to the buzzer is held off. A slight obstruction of the light path causes the relay contacts to open, whereupon the buzzer (and the 'escape light', if fitted) is energized.

In the battery-operated version, the posi-

tions of D_5 and T_2 can be reversed and the connections of the relay contacts as shown to give a slightly reduced current drain on the battery. The circuit works well in either case.

Capacitor C_1 in the mains-operated version has two functions: the usual one of reservoir and that of holding a charge so that when the unit is disconnected or switched off, the buzzer gives a loud bleep. This shows that the unit is functioning correctly and is the reason that the capacitor is retained in the battery-operated version.

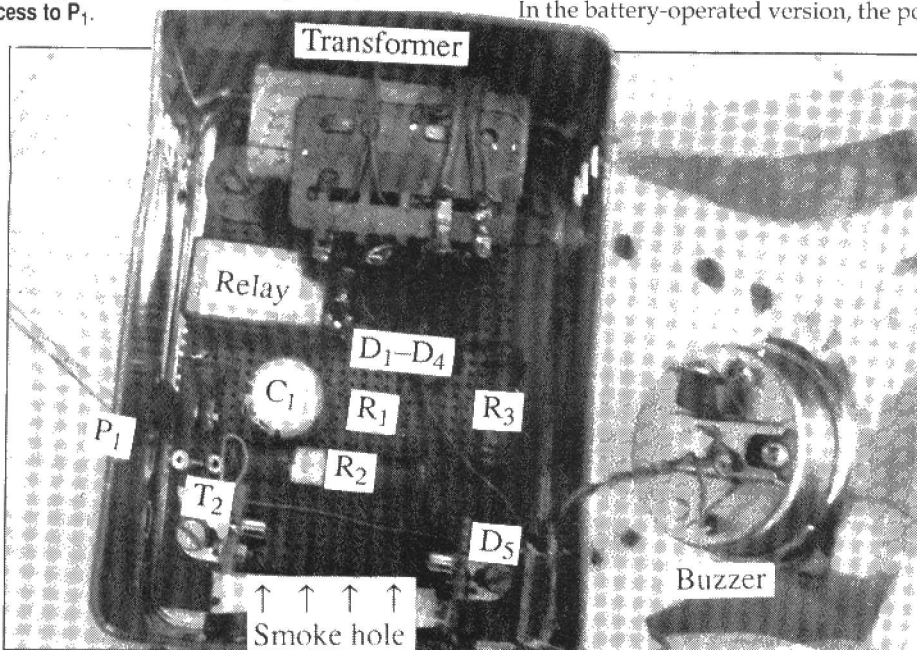
In the mains-operated version, the miniature transformer may have a secondary voltage of 12–20 V and be capable of providing a load current of 150–200 mA.

The value of R_2 is $15U_s$ where U_s is the secondary voltage of the transformer; its tolerance may be $\pm 20\%$.

The unit may be constructed on a 10×7.5 cm (4×3 in.) piece of prototyping board (veroboard or perfboard). The location of the components, other than D_5 , T_2 , P_1 and the transformer, is not important. The positions of T_2 and D_5 are obvious and should be about 25 mm (1 in.) above the board.

The dimensions of the enclosure are 9×11.5×9 cm (3.5×4.5×3.5 in.) (L×W×D). The positions of the smoke holes and the hole for screwdriver access to adjust P_1 can be ascertained from the photographs.

It will be found that there are two points on P_1 at which the buzzer can be switched on and off: only one of these is correct. The adjustment may be made on a workbench, since T_2 is not sensitive to visible light. To find the correct adjustment point, waggle a matchstick between D_5 and T_2 . Once this has been found, carefully adjust P_1 again until the buzzer just goes off. The buzzer should make a loud and unpleasant noise to make sure that it wakes healthy sleepers. ■

Fig. 9. Location of components in mains-operated version. In the battery-operated version, removal of the transformer, zener diode and R_2 makes space for the battery.

PARTS LIST

Resistors:

$R_1 = 50 \Omega$
 $R_2 = \text{see text}$
 $R_3 = 300 \Omega, 1 \text{ W}$
 $P_1 = 22 \text{ k}\Omega \text{ preset}$

Capacitors:

$C_1 = 1000 \mu\text{F}, 35 \text{ V DC working}$

Semiconductors:

D_1 – $D_4 = 1\text{N}4001$
 $D_5 = \text{infra-red emitting diode}$
 $D_6 = 1\text{N}914$
 $D_7 = \text{zener diode, } 12 \text{ V, } 1 \text{ W}$
 $T_1 = \text{BC149 or similar}$
 $T_2 = \text{infra-red photodetector}$

Miscellaneous:

$S_1 = \text{SPST switch}$
 $\text{Re1} = \text{miniature relay, } 5\text{--}7 \text{ V, } 10 \text{ mA, coil resistance } 600 \Omega$
 $\text{Batt1} = 12 \text{ V battery}$
 $\text{Tr1} = \text{miniature mains transformer, secondary } 12\text{--}20 \text{ V, } 300 \text{ mA}$
 $\text{Bz1} = \text{miniature buzzer, } 12 \text{ V}$

SCIENCE & TECHNOLOGY

Understanding the EDIF standard

by Tony K.P. Wong

EDIF is a standard data format for electronic design information transfer between CAD systems, and supports gate array and semicustom IC design. It plays an important role in the VLSI world. Some of the basic structure of the EDIF and an application of its netlist are presented in this article.

IT MAY be recognized that the VLSI integrated circuit design process relies heavily on communication between all parties involved in the design, manufacture and testing of VLSI products, that is, 'Joint Ventures' scheme. This has to be so irrespective of the different CAD systems that might be used at each end of the data exchange. However, problems arise since each CAD system employs its own system-specific data structure for storing product data. This data may not be transferred from one system to another or be read by other systems, as they have no common data structure. Hence, to obtain the maximum benefit from CAD systems, data exchange becomes essential to the manufacturers.

Many national and international organizations have developed a public domain standard for data transfer, which is called Electronic Design Interchange Format, or EDIF. This standard enables the designs of semicustom and custom ICs to be communicated unambiguously to device makers.

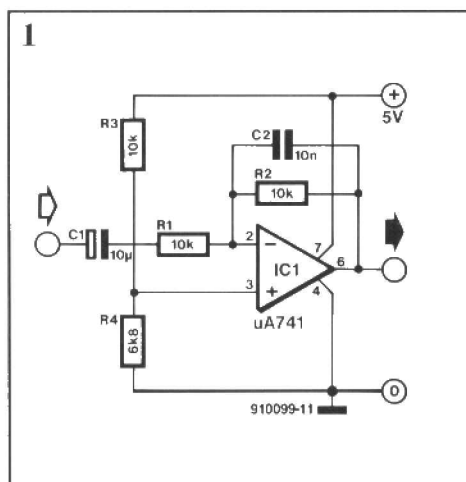
EDIF structure

EDIF is a neutral data format that may be used for transferring netlists, schematics, IC layouts and other electronic data between computer workstations. A translator program will be required to translate the information from the sender's data base and to create a sequential file in the format defined by the EDIF specification. Another translator program may be used to load the design information into the receiver's data base.

The basic format of the EDIF syntax is an ASCII file. An EDIF file consists of an hierarchical set of structures based on the LISP programming language. Each construct of the EDIF language is a parenthesized list of items of information. Each distinct EDIF construct is identified by a keyword. This syntax is very simple, easily parsed, and extensible, but its power for representing design information comes from its structure. The hierarchical structure of EDIF means

that it is abstract at the highest levels and becomes progressively more detailed as one descends within the hierarchy. Figure 1 shows a portion of the EDIF structure model and the path of the netlist view is specified. Further details of the structure of EDIF may be obtained from Ref. 1.

In general, an EDIF file may contain one or more libraries of cell data. A library consists of cells grouped according to the common characteristics.



Cells in the library may contain instances of other cells from an external library. Each cell currently supports seven view types: behaviour; schematic; symbolic; netlist; mask layout; document; and stranger. Each view of the cell contains information particular to a specific use of the cell.

The 'library' and 'view' structures can make a possible change in the transfer of partial or incomplete design information, so that the data transfer time may be reduced.

View cells can be divided into two sections: the interface section defines the cell's communication with other cells, and the contents section defines the detailed implementation of the cell.

In the top level, the Design block contains the name of a design and provides a

path for finding data. The Status block specifies the file information such as the program version, creation time, and so on. The User Data block contains the user specific data, for instance, local user extensions. All of the data describing a design is collected in the Library block. The Library may make reference to the External Library, that is, a library is known to the sender and receiver by name, but no details are transferred. Within the Technology construct, information of physical design rules, global constants, and so on, may be included.

For the View level, the Netlist view, the netlist description contains a list of cell instances and a collection of nets that specify signal connections among the ports on the instances and the external ports of the cell itself. It is possible to display the property name and its value in any context. Properties may include optional 'owner' and 'unit' values. For example,

```
(port AAA
  (property BBB (number (e X-Y))
    (unit CCC)
    (owner DDD)))
```

describes that the port named AAA of a cell has a property BBB (e.g., Cin). The value of the property is $\exp X - Y$ (e.g., 1×10^{-12}) and it has the unit of CCC (e.g., capacitance). The owner of this property is DDD, which is user-defined to avoid the same name of properties from different data bases.

It should be noted that, when the file is translated into the receiver's data base, any scaling of values for the unit CCC, which is specified in the technology section of the EDIF library, would be applied to the property value.

The Mask Layout view also contains an interface and a contents section. In the contents of the view there is a set of shapes on different mask layers, called figureGroups in EDIF, and an instance of another cell. The figureGroup will refer to a figure group defined in the technology library.

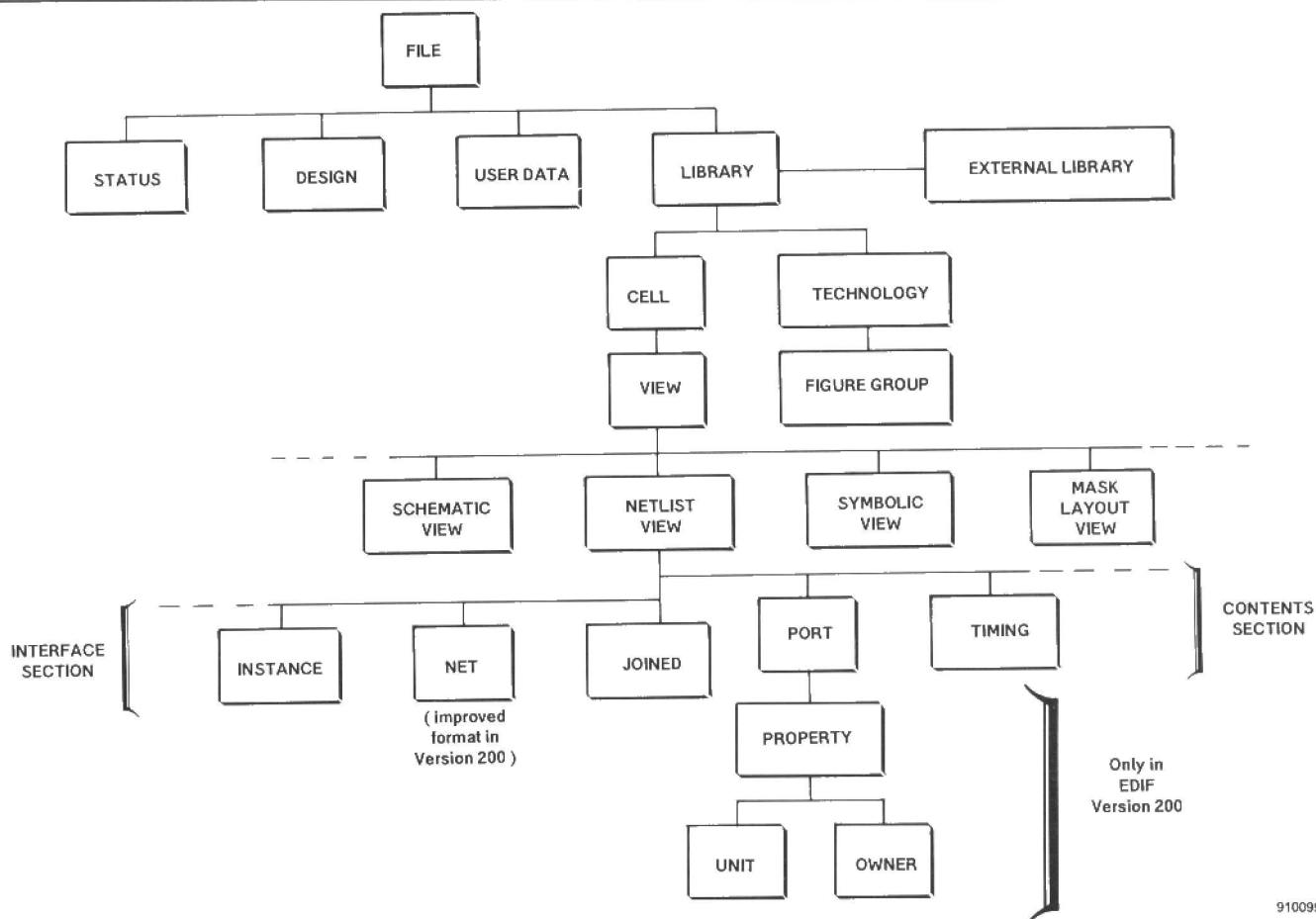
```

(EDIF OPAMP_SCH
  (status
    (EDIFVersion 1 1 0)
    (EDIFLevel 0)
    (Written
      (TimeStamp 1991 2 9 14 5 40)
      (comment "The ABOVE TimeStamp is local time")
      (accounting Program "NETLIST.EXE")
      (accounting ProgramVersion " V3.20a 26-Jan-89")
      (comment "(C) Copyright 1985,1986,1987 OrCAD Systems.")
    )
  )
  (external ANALOG_LIB)
  (external ASSEMBLY_LIB)
  (external CMOS_LIB)
  (external DEVICE_LIB)
  (external INTEL_LIB)
  (external MOTO_LIB)
  (external PSPICE_LIB)
  (external SHAPES_LIB)
  (external SPICE_LIB)
  (external TTL_LIB)
  (external POWER_LIB)
  (design OPAMP_SCH (qualify lib root))
  (library lib
    (cell root
      (status
        (Written
          (TimeStamp 1991 2 9 14 4 4)
          (comment "The ABOVE TimeStamp is local time")
          (comment " February 9, 1991")
        )
      )
    )
  )
  (view NETLIST root_NET
    (interface
      (define input port VSS)
      (define input port IBARP
        (rename IBARP "I/P"))
      (define output port OBARP
        (rename OBARP "O/P"))
      (define input port X_PLUS5V
        (rename X_PLUS5V "+5V"))
      (define input port GND)
    )
    (contents
      (instance (qualify PSPICE_LIB X_10K) X_10K_NET R1)
      (instance (qualify PSPICE_LIB X_10K) X_10K_NET R2)
      (instance (qualify DEVICE_LIB X_0_01UF) X_0_01UF_NET C2)
      (instance (qualify PSPICE_LIB X_6_8K) X_6_8K_NET R4)
      (instance (qualify PSPICE_LIB X_10K) X_10K_NET R3)
      (instance (qualify ANALOG_LIB X_741) X_741_NET U1)
      (instance (qualify DEVICE_LIB X_10UF) X_10UF_NET C1)
      (joined
        (qualify C2 X_1)
        (qualify R2 X_1)
        (qualify R1 X_2)
        (qualify U1 MINUS_INPUT)
      )
      (joined
        (qualify C2 X_2)
        (qualify R2 X_2)
        (qualify U1 OUTPUT)
        OBARP
      )
      (joined
        IBARP
        (qualify C1 X_1)
      )
      (joined
        (qualify C1 X_2)
        (qualify R1 X_1)
      )
      (joined
        (qualify U1 PLUS_INPUT)
        (qualify R3 X_2)
        (qualify R4 X_1)
      )
      (joined
        (qualify U1 PLUS_V)
        X_PLUS5V
        (qualify R3 X_1)
      )
      (joined
        (qualify R4 X_2)
        GND
        VSS
        (qualify U1 MINUS_V)
      )
    )
  )
)

```

910099-12

3



910099 - 13

The Symbolic view contains the description on elements of connectivity and geometric layout. It can be used to describe placement and routing problems, and to transmit symbolic layouts for technology re-mapping. Under the Symbolic view, the construct elements specified in the Interface and Contents sections may be implemented.

The Schematic view is used for the transmission of logic data and schematic diagram plus connectivity. The cells include logic elements and symbols.

An EDIF netlist application

Netlist is a list of components and connections that describes the connectivity of a circuit (Ref. 2). Figure 2 shows an EDIF file that describes the circuit of the band-pass network shown in Fig. 3. The schematic capture was produced by OrCAD/SDT III software. The EDIF netlist file is one of the formats that the software can support. The details of the file related to the circuit are described below.

OPAMP_SCH is the name of the file. Under the Status construct, the EDIF version and level are specified; the local time and the program (NETLIST.EXE) from which the EDIF file was generated are described in the Written block.

Following these, the external library files are referred to; they are named with the extension, LIB, as shown and, in this case, they may be found in the library directory of Schematic capture software.

A root Cell must reside in the Design entity and be a cell in one of the libraries.

The Status block following the Cell root contains information about this particular cell. It then shows the Netlist view of the cell. At the beginning of the view, all input and output ports are defined under the Interface block.

The Rename construct shows the original port name. The designation of components and their electrical values are specified in the Instance construct. Each component value and its related library file are also mentioned with a Qualify construct. For instance, in this case, R_1 has a value of 10 k Ω and belongs to the external PSPICE library file.

Finally, the connectivity of the circuit is described in the Joined blocks. Each Joined block specifies the connections at one node of the circuit. In practice, a number is assigned to the terminals of each discrete component: the left-hand terminal is 1 and the right-hand one is 2. For instance, as shown in the first Joined block, terminal 1 of C_2 and R_2 is joined to terminal 2 of R_1 and the -ve input of U_2 .

Conclusion

EDIF Version 1.00, published in 1985, has provided a solution to the data base compatibility problem in the gate array and semi-custom IC designs. Although it is not complete, users have processed a number of successful data base conversion programs. Many CAD software manufacturers have included the format in their products, for instance, OrCAD, HiWIRE, Schema III, and so on.

EDIF Version 2.00 has just been pub-

lished. This can address many of the problems and difficulties of the earlier version, and meets the needs of real data transfer in the design and manufacture of printed circuit boards. Moreover, it contains provision for behavioural modelling and includes some new constructs, for instance, Net and Property. Unfortunately, even the latest version can not yet do everything: features that are still under development include:

- transfer of design changes;
- PCB layout transfer between CAD systems;
- transfer of data for board testing;
- transfer of data from CAD systems to board manufacture;
- electrical design rules.

These features may form part of the next version. However, there will be a significant performance penalty to using EDIF for data exchange, because the format tends to require more storage space than the CAD data, and may slow down the data base conversions. Simplification and more advanced constructs may, therefore, be required. ■

References:

1. *EDIF Specification*, Version 1.00, March 1985.
2. "Shaping up the Netlist", by Tony K.P. Wong, *Electronics World*, Vol. 96, No. 1656, Oct. 1990.
3. "Focus Report: Engineering Software", *IEEE Spectrum*, Vol. 27, No. 11, Nov. 1990, pp. 60-85.

PLOTTER DRIVER

WRITTEN IN
TURBO PASCAL 6.0

Although the low-budget plotter published some three years ago in this magazine is a popular project, it has no 'intelligence' of its own. It therefore requires some additional computer activity before those beautiful drawings and PCB track layouts produced by CAD programs can be put on to paper. In this article a plotter driver program is presented that translates HPGL commands contained in a plot file into the appropriate bit patterns needed to control the home-made plotter.

by Danielo Sijtsma

FOR those of you who have not followed the story so far: the plotter referred to above is a mechanical as well as electronic construction project described in Ref. 1, with some useful mechanical alterations brought together in a follow-up article, Ref. 2. The second article also describes a partly HPGL-compatible plotter driver, which is less sophisticated than the one discussed here. It may be useful to know that the modified version of the plotter is available as a kit from some regular advertisers in *Elektor Electronics*. It must be noted, though, that the contents of their kits may deviate from the modified mechanical parts list included in Ref. 2.

The driver program

CAD programs — or more generally, drawing programs — such as AutoCAD, OrCAD, DrawPerfect, Ultiboard and Smartwork, to mention but a few, provide drivers for plotters that work with a certain industry-standard 'language', for instance, HPGL (Hewlett Packard Graphics Language). Since the *Elektor Electronics* plotter is not compatible with any graphics language, it requires a conversion operation in which the commands contained in the computer output file are converted into appropriate bit combinations that can be applied to the interface board that belongs with the plotter. In practice, this conversion operation is carried out by the pro-

gram described here. This program accepts HPGL input data, translates this into a series of plotter commands, and drives the plotter via the Centronics port on the PC and the interface board attached to the plotter.

The plotter driver program is written in Turbo Pascal 6.0, and comes on one 5¼-inch

360 KByte MS DOS formatted floppy disk. The program is suitable for MS-DOS computers only. It can be modified to drive plotters other than the *Elektor Electronics* one by adapting a number of procedures in one of the source files. Evidently, to be able to make such modifications you must be conversant

MONDRIAAN PLOTTER DRIVER		Version 2.2
Plot	Paper	Settings
		Quit
		PAPER SIZE
Size	:	SIZE
Smallest X co-ordinate	:	A4
Smallest Y co-ordinate	:	A3
Largest X co-ordinate	:	USER1
Largest Y co-ordinate	:	USER2
X co-ordinate of P1	:	USER3
Y co-ordinate of P1	:	
X co-ordinate of P2	:	10603
Y co-ordinate of P2	:	7721
Enlarge/reduce factor	:	1.0000
Plot Horiz./vert.	:	H

Plotfile: AUTOCAD.PLT A4 Copyright (c) Danielo Sijtsma

with the Turbo Pascal 6.0 compiler. The basic information on the modifications is contained in the source file itself.

The plotter driver program, PL.EXE, translates HPGL files into control commands for the *Elektor Electronics* plotter, and in addition allows a number of plotter-specific parameters to be defined.

Before the plotter driver can be used, the drawing made on the PC must be converted into an HPGL file. Most CAD programs can do this without problems when an HPGL-compatible plotter (e.g., the HP7475A) is selected in the output menu, and the plot file is printed to disk. When the HPGL file is available on the system, the plotter driver, PL.EXE, may be called up to complete the conversion into plotter commands. Completely menu-driven, the converter program is uncomplicated in practical use.

Hardware recap and tuning

The interface board with the *Elektor Electronics* plotter is connected to the Centronics port of the PC as shown in Fig. 1. Note that a number of pins on the Centronics connector are tied to +5 V to make them permanently logic high. The +5 V can be taken from the plotter interface via an unused wire in the cable to the Centronics port on the PC. For connector pin functions, look in the file PLPROC.PAS on the diskette.

Before you can start plotting a drawing, a number of parameters must be set. This is done in the 'settings' menu, and in particular, in the sub-menu 'mechanical characteristics'.

Wait time between steps

This parameter determines the plotting speed. The larger the wait time, the slower the plotting, but the more accurate the result. Since the wait time is set by means of a software counter, it may have to be adapted in accordance with the clock speed of the computer.

Half step

The half step parameter determines the final resolution of the plotter. When you switch the motors from half step mode to full step mode, the size of the plotted drawing will remain the same, i.e., the co-ordinates are re-scaled internally.

Wait time between pen up/down

This is a constant that must be determined empirically for best results. It provides a certain delay before a pen is lifted or put down on the paper.

Y-compensation factor

This factor is a constant that allows differences in the resolution between the X and Y driving systems to be compensated. It is programmed by writing the following line of ASCII text, and sending it to the plotter:

```
PR1000,0; PR0,1000 ^Z
```

Make sure that the clipping area (see 'paper size') is not effective, and if necessary adapt the enlarge factor. The Y factor is obtained by dividing the distance travelled in the X direction by the distance travelled in the Y direc-

THE HPGL COMMAND SET — AN INTRODUCTION —

HPGL (Hewlett-Packard Graphics Language) commands are abbreviations of plotter control instructions. An HPGL file may be written with any ASCII-compatible word processor, and consists of HPGL commands and co-ordinates. The best known commands from the HPGL set are probably PA (plot absolute), SP (select pen), CI (circle) and LB (label).

The number of HPGL commands supported determines whether or not a certain plotter can be used with a drawing program. Most drawing programs use only a few of the 50 commands available in the HPGL. The well-known AutoCAD package is a good example, because it uses the HPGL basic commands only, such as PA (plot absolute) and SP (select pen). Texts generated with AutoCAD are plotted as series of PA commands rather than with the aid of the LB (label) command. The same goes for circles and arcs, which are also plotted with PA command strings. There are, however, other programs that use a much larger subset of HPGL commands. If you want to know if the *Elektor Electronics* plotter can be used with your drawing program, it is best to check the commands contained in a generated plot file against the commands supported by the driver program presented in this article.

Supported HPGL commands

The plotter driver program discussed here supports all the HPGL commands necessary to work with most commonly used drawing programs. In practice, the driver has been tested successfully in conjunction with AutoCAD, OrCAD, Ultiboard, Smartwork and DrawPerfect.

The HPGL commands supported by the author's Turbo Pascal 6.0 program are:

PU (X1,Y1)(,...):	Pen Up
PD (X1,Y1)(,...):	Pen Down
PA (X1,Y1)(,...):	Plot Absolute
PR (X1,Y1)(,...):	Plot Relative
CI radius(,chord angle):	Circle
AA X,Y,arc angle(,chord angle):	Arc Absolute
AR X,Y,arc angle(,chord angle):	Arc Relative
LB ASCII string (c):	LaBel ASCII string
DTc:	Define label Terminator (c)
SI width, height:	absolute character Size
SR width, height:	Relative character Size
DI cos,sin:	absolute-Direction
SP n:	Select Pen
SC Xmin, Xmax, Ymin, Ymax	SCale into user units
IP P1x,P1y(,P2x,P2y):	InPut P1 (,P2)
IN:	INitialize
DF:	set DeFault values

Optional parameters in brackets (); parameters are delimited with a comma. HPGL commands in a plot file may be separated by a comma. The plot file may contain carriage returns (CRs) and line feeds (LFs) which are ignored by the driver. These control codes may however help to improve the readability of the plot file.

Co-ordinate system

A number of plotter commands are followed by co-ordinates, which can be absolute (i.e., with respect to the origin), or relative (i.e., with respect to the current pen position) depending on the preceding command.

The unit of distance used in the co-ordinate system is a plotter unit rather than a SI unit such as the millimetre. The values assigned to the co-ordinates depend more on the resolution used by the drawing program than on the size of the drawing. The plotter units used by the *Elektor Electronics* plotter are determined by the resolution of the stepper motors and the mechanical drive systems. In half-step mode, a resolution of about 0.1 mm is achieved.

The HPGL provides the SC command for plotter-unit to user-unit conversion. The SC command also allows the origin to be moved, for instance, from the centre of the paper to the lower left-hand corner.

Another, related, scaling command, IP, enables two reference points to be defined, P1 and P2, which are also used during rescaling to user units. The SR command, which sets the relative character size, is also related to the reference points P1 and P2.

All the juggling with co-ordinates is of little interest to the user, who is only after the final size of the drawing. This size will depend on the drawing program used. A scaling manipulation feature must be built into the plotter driver or the drawing program to enable the output of different programs to be drawn on one (maximum) paper size.

In the drawing program, the scale is entered as a parameter together with the plot command, or as a global setting in the program itself. This allows the co-ordinates to be converted directly to the co-ordinates that belong with the new scale. Alternatively, the SC (scale into user units) command may be placed at the beginning of the plot file to enable the plotter driver to do the co-ordinate conversion itself.

When the driver is used to scale co-ordinates, this is best done with the aid of the reduce/enlarge option of which the parameters can be set via the 'paper' menu. □

Plot	Paper	Settings	Quit
		SETTINGS	
Plotfile		:	AUTOCAD.PLT
Path		:	A:\
Wait time between steps		:	250
Half step		:	Yes
Mecha		MECHANICAL CHARACTERISTICS	
Screen	Wait time between pen UP/DOWN	:	200
Save	Y compensation factor	:	1.0000
	HPGL compensation factor	:	0.130
	Number of pens	:	3
	X compensation pen 2	:	58
	Y compensation pen 2	:	0
	X compensation pen 3	:	116
	Y compensation pen 3	:	0
	Position slowly	:	10
	Position Fast	:	100
	Printer port	:	LPT1

Plotfile: AUTOCAD.PLT A4 Copyright (c) Daniël Sijtsma

SOFTWARE ON DISKETTE

The plotter driver program and configuration utilities described in this article are available on a 5¼-inch 360 KByte MSDOS formatted floppy disk under order number ESS1541. Details on cost and ordering are given on the Readers Services page elsewhere in this issue.

equipment will confirm this without shame.

In the worst case, nothing is plotted. First, check whether manual pen positioning works (go to the sub-menu 'plotting'). If this works, you have probably loaded a non-HPGL compatible plot file (the name of the file processed is displayed in the lower left-hand corner of the screen).

A problem reported by many constructors of the *Elektor Electronics* plotter has to do with the lifting and lowering of the pens. First, check that the pens can move up and down without friction. Marker pens in particular are prone to remaining stuck. This happens because the lever that lifts the pen remains stuck to the core in the solenoid (lift magnet). The problem is simple to eliminate by sticking a small piece of self-adhesive tape between the core and the lever. This creates a small air gap between these two metal parts, and reduces the risk of sticking (caused by permanent magnetism) to a minimum.

'Real' plotter pens are much heavier than marker pens, and are much more likely to remain down on the paper because the solenoid in the carriage is incapable of lifting the weight. There are two possible solutions to this problem:

- reduce the tension of the solenoid springs, or remove them altogether;
- increase the value of capacitors C2, C3 and C4 on the interface board from 470 µF to 1,000 µF.

The distance between the lever and the pen is critical. When the lever is too close to the pen, it can not move freely. Conversely, when the distance is too great, the pen can bounce up when it is lifted. The critical distance can be 'tuned' by bending the 'rear leg' of the solenoid a little forward or to the rear.

If the plotted drawing is mirrored with respect to that produced with the CAD program, simply reverse the connections to one of the stator windings on one of the stepper motors.

Paper slip may be caused by insufficient pressure on the platen. The correct amount of pressure must be determined empirically by fitting springs with different tensions.

Another type of slip (in the X as well as in the Y direction) may occur when the platen or the string wheel for the carriage movement is not fitted securely on the spindle of the relevant stepper motor.

References:

1. "Plotter", *Elektor Electronics* May and June 1988.

tion: Y factor = dX/dY. The larger the distances travelled, the more accurate the Y factor.

X- and Y-compensation pen 1/2/3

These parameters serve to compensate the distance between the pens in the carriage. Enter the following text in an ASCII word processor, and send it to the plotter:

```
PU; SP1; PD; PU; SP2; PD; PU;
SP3; PD; PU ^Z
```

This should produce a single spot on the paper without off-set between the individual dots made by the pens.

Number of pens

Optionally, you may work with fewer than three pens. The pen numbers in the SP commands are counted in a cyclic manner. When, for instance, the driver encounters the command 'SP3' (select pen 3), while the maximum number of pens is set to 2, pen 1 is selected.

Paper size

This parameter speaks for itself. The X and Y

co-ordinates are not the HPGL co-ordinates in the plot file, but the maximum number of steps to be made by the stepper motors on the plotter. The limits that belong with a certain paper size setting can be calculated on the basis of the diameter of the platen and the string wheel for the carriage drive, and the number of steps per spindle revolution of the stepper motors used. Next, the enlarge/reduce factor is used to fit the drawing on the selected paper size. When the co-ordinates of the drawing fall outside these borders, the relevant part of the drawing is not plotted, and a warning is given when the plotting is finished.

Trouble shooting and user hints

It is very well possible that the first results obtained with the plotter and the driver program will look like drawing attempts of a two-year old. Any one with some experience in setting up electromechanical drawing

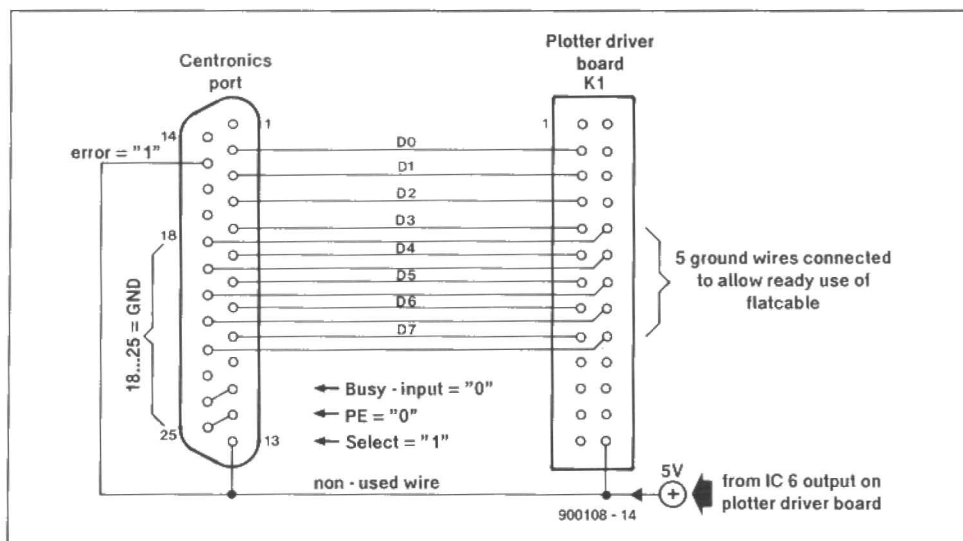


Fig. 1. Hardware recap: suggested connections between the PC Centronics port and the plotter driver board.

'Would you be an inventor?'

Sir—In your issue of July/August 1991 you include an article with the above title by a Mr Whitehead. Unfortunately, the article is wrong in several important respects, and I am concerned in case inventors try to take guidance from it.

For example, Mr Whitehead bases much of his article on the contention that 'it is an established principle that employees' inventions belong to the employer'. This is not the case. The United Kingdom law, for example, lays down very strict conditions for an employee's invention to belong to the employer, and in all other respects the invention belongs to the employee. Furthermore, the law makes it impossible for the employer to extend his rights to the inventions of an employee by contract of employment, or by other means.

Mr Whitehead also suggests that the date when the patent is accepted is important and sets up 'an expensive brawl between lawyers to decide which specification was filed first, and thus oust the other'. Again, this is totally incorrect. Any patent application filed anywhere in the world has a filing date from the outset and this establishes the precedence of all patents.

It is also distressing that Mr Whitehead suggests that individuals and smaller firms cannot take action for infringement. In this case, it is now possible to insure to cover the costs of infringement actions. There is also a new Court, the Patents County Court, which is designed to cut the cost of infringement actions by several orders of magnitude.

Jacqueline Needle
Chairman, Press & Public Relations
Committee
The Chartered Institute of Patent Agents
London

Satellite receiver conversion

Sir—Further to my telephone conversation with your Technical Editor, I enclose the information on how to convert a 16-channel Alba/Bush/etc set to a 20-channel set. In principle, this conversion works in all satellite receivers that are based on the SGS-Thomson Type M494 processor.

The conversion has the advantage that the remote control of the set remains fully functional, because the same codes are now merely interpreted differently. In fact, some keys on the remote control transmitter are no longer used.

READERS' LETTERS

The conversion is effected by soldering two Type 1N4148 diodes between the option select line (pin 6) and data lines D0 and D3 (pins 2 and 5) of the processor. It costs only a few pence and, in any case, many amateurs have the diodes in their workshop. How they are soldered on to the board in the Alba receiver is shown in the sketch.

R. van Zon
Nunspeet, The Netherlands

Wattmeter

Sir—In the article 'Wattmeter' in your April 1991 issue, the author claims that his device will give reasonably accurate readings when dealing with a reactive wad, and that the device accounts for the phase angle difference between voltage and current. I'm not convinced. Power is equal to $EI\cos\Phi$, when $\cos\Phi$ is the cosine of the difference angle between the voltage across the load and the current through it. I see no circuit in his device to sense this difference, and no circuit to multiply a ' $\cos\Phi$ ' by the EI product.

Gene May
Belvoir, USA

You are right! The wattmeter measures the apparent power (EI) and not the reactive power (EIcosΦ). Our apologies for this error.

Ed.

Hall-effect sensor / Gaussmeter

Sir—I have a present need to be able to sense if there be a magnetic field around a conducting element, most particularly, an insulated water pipe. I would like to use a Hall-effect sensor, but do not know who manufactures such devices, where to buy them and, above all, what the component designations may be. Could you help me

with the appropriate data?

Perhaps in some future issue you might care to give us a circuit for a gaussmeter. I, for one, would enjoy building such an instrument and adding it to my electronic equipment.

Harold Willis Milnes
Lubbock, USA

We have asked our colleagues at Peterborough, NH, if they can help with the first part of your letter. Your interest in a gaussmeter has been passed on to our design department for investigation.

Ed.

Plotter Mark II

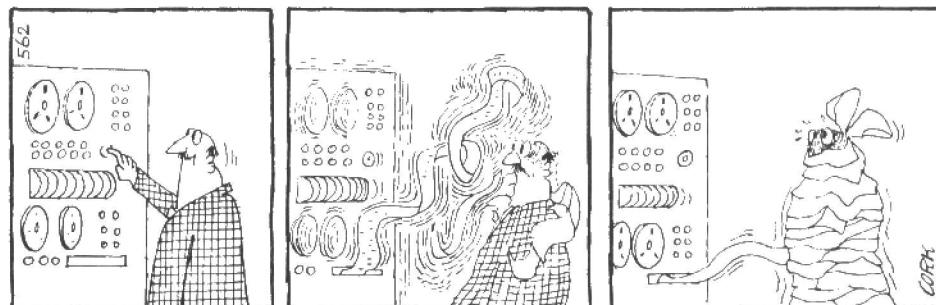
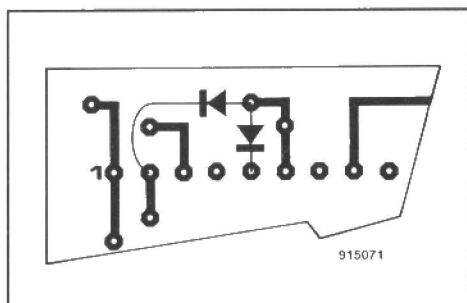
Sir—You may recall my letter to you of 14 December 1990 in which I expressed concern about some aspects of the software you supply on diskette E117—the plotter driver software MONDRIAN*. You referred the letter to your office in Holland who gave me the address of the author in Germany. After putting my difficulties to him, he replied to say these had been pointed to him previously by a German reader, and that he had expanded the basic commands so that PUx,y ; and PDx,y ; are now correctly interpreted.

In my case, I was particularly concerned with the HPGL files produced by the EASYPC software supplied by Number One Systems. The author very kindly supplied me with a corrected version of the software and all is now well. He states that I should feel free to help other users with similar problems. Therefore, should any of your readers encounter similar problems, I would be glad to assist them.

G. H. Olsen, 5 Fieldhouse Close, Hepscott, Morpeth, Northumberland NE61 6LU.

** Piet Mondrian (or Mondriaan) (1872–1944) was a Dutch artist who, with J. van Doesburg (1883–1931), founded the De Stijl movement in architecture and painting. His rectilinear abstracts in black, white and primary colours have had considerable influence and he is considered the leader of neo-Plasticism.*

Ed.



PRODUCT OVERVIEW

SEPTEMBER 1991

A number of projects carried in *Elektor Electronics* are supported by ready-made printed-circuit boards (PCBs), self-adhesive front panel foils, ROMs, EPROMs, PALs, microcontrollers and diskettes, which may be ordered through our Readers Services using the order form printed every month on the Readers Services page. The list printed here is complementary to the shorter one on the Readers Services page elsewhere in this issue. This two-page overview of all currently available products is regularly updated and will appear in the March, June, September and December issues of *Elektor Electronics*.

Items marked with a dot (*) following the product number are in limited supply only, and their availability can not be guaranteed by the time your order is received.

Items not listed here or on this month's Readers Services page are not available. The artwork for making PCBs which are not available ready-made through the Readers Services may be found in the relevant article (from March 1990 onwards).

Prices and item descriptions subject to change. Prices can be confirmed on request at the time of ordering.

PRINTED-CIRCUIT BOARDS

1983

64-way bus extender board	83102	10.60	1.86
µProcessor aid	83515	2.90	0.51

1984

RS232-Centronics adapter	84078	6.60	1.16
Frequency meter	84462	5.50	0.96
Echo sounder	81105-1	5.00	0.88
Mini Crescendo	84041	6.50	1.14

1985

Universal I/O bus	85058	10.10	1.77
Hi-res colour graphics card	85080-1	15.25	2.67
Hand-held anemometer	85093	9.70	1.70
Jumbo displays	85413-2	4.90	0.86
Lead-acid battery charger	85446	2.75	0.48
Model railway monitor	85493	3.70	0.65
Digitizer	85063	4.10	0.72

1986

FEBRUARY 1986			
Battery-operated NiCd charger	86002	5.80	1.02
Car burglar alarm	86005-1	4.65	0.81

MARCH 1986			
MSX busboard	86003	18.15	3.18

APRIL 1986			
Portable mixer	86012-1	5.30	0.93

MAY 1986			
Printer buffer	85114-1	11.75	2.06
	85114-2	5.05	0.88
Portable mixer	86012-3A	5.30	0.93

JUNE 1986			
8-way relay board	86039	5.80	1.02
Rain gauge	86068	3.60	0.63

JULY/AUGUST 1986			
Rodent deterrent	86490	2.00	0.35

SEPTEMBER 1986			
RTTY interface	86019	7.60	1.33
Universal peripheral equipment	86090-1	7.95	1.39

OCTOBER 1986			
IDU for satellite TV reception	86082-1	12.60	2.21
Computerscope	86083	24.60	4.31
	9968-5	2.05	0.36
Video interface for Atari ST	86103	6.20	1.09

NOVEMBER 1986			
VHF/UHF noise generator	86081	1.55	0.27
Top-of-the-range preamplifier	86111-3A	6.90	1.21
	86111-1	10.40	1.82

DECEMBER 1986			
Temperature probe for DMM	86022	1.05	0.18

1987

JANUARY 1987			
Top-of-the-range preamplifier	86111-2	22.50	3.94

FEBRUARY 1987			
Electron ROM card	86089	5.70	1.00

MARCH 1987			
MSX EPROMmer	87002	9.50	1.66
Valve preamplifier (1)	87006-1	8.50	1.49
	86111-3A	6.80	1.21

APRIL 1987			
Valve preamplifier (2)	87006-2	12.52	2.19
Facsimile interface	87038	8.83	1.55

MAY 1987			
MIDI signal distribution	87012	7.40	1.30

JUNE 1987			
Autorangeing DMM	87099	6.55	1.14

JULY/AUGUST 1987			
Headphone amplifier	87512	9.00	1.58

OCTOBER 1987			
Low-noise microphone preamplifier	87058	3.45	0.60

NOVEMBER 1987			
SSB receiver for 80m and 20m	87051	14.75	2.58
BASIC computer	87192	20.25	3.54
Dimmer for inductive loads	87181	6.00	1.05

1988

JANUARY 1988			
DCF77 receiver and frequency standard	86124-A	8.70	1.52
Stereo limiter	87168	7.25	1.27
Light-powered thermometer	87188	6.75	1.18
Switch-mode PSU	880001	5.00	0.88

FEBRUARY 1988			
Infra-red headphones	87640	6.10	1.07
Prescaler for frequency meter	880005	9.25	1.62

MARCH 1988			
Computer-controlled slide fader	87259	16.00	2.80
Low-noise preamplifier for FM receivers	880041	6.50	1.14
Signal divider for satellite TV receivers	880067	5.00	0.88

APRIL 1988			
Stereo sound generator	87142	7.25	1.27
Fuzz unit for guitars	87255	6.50	1.14
Active loudspeaker system	880030	7.50	1.31
Tunable preamplifiers for VHF/UHF TV	880044	6.25	1.09

MAY 1988			
Plotter	87167	11.50	2.01
Balanced line driver and receiver	87197	10.50	1.84
VLF converter	880029	5.75	1.01

JUNE 1988

Microcontroller-driven power supply	880016-1	19.00	3.33
	880016-2	12.50	2.19
	880016-3	15.00	2.63
	880016-4	0.75	0.13
set price incl. FPL	880016-9	57.00	9.98
Wideband active aerial for SW receivers	880043-1	6.00	1.05
	880043-2	4.75	0.83
HF operation of fluorescent tubes	880085	9.75	1.71

JULY/AUGUST 1988

Electronic sand-glass I/O extension card for IBM PCs	87406	6.60	1.16
	880038	28.60	5.01
Frequency read-out for SW receivers	880039	18.40	3.22
Universal prototyping board	884013	10.45	1.83
Five-band graphic equalizer	884049	7.95	1.39
Simple 80m RTTY receiver	886034X	8.15	1.43

SEPTEMBER 1988

Fast NiCd charger	87186	6.10	1.07
64K RAM for MSX	87311	16.95	2.97

OCTOBER 1988

Centronics interface for slide fader	880111	7.75	1.36
Preamplifier for purists	880132-1	5.90	1.03
	880132-2	12.25	2.14
Ultrasonic distance meter	880144	7.75	1.36
Peripheral modules for BASIC computer	880159	5.00	0.88
	880163	5.40	0.95
Transistor curve tracer	886087	4.60	0.81

NOVEMBER 1988

Bus interface for hi-res LCD screens	880074	16.75	2.93
LFA-150 — a fast power amplifier	880092-1	8.45	1.48
	880092-2	7.70	1.35
Harmonic enhancer	880167	6.30	1.10
Portable MIDI keyboard	880168	7.85	1.37

DECEMBER 1988

LFA-150 — a fast power amplifier	880092-3	6.40	1.12
	880092-4	6.45	1.13
CVBS to-TTL adaptor	880098	4.85	0.85
Colour test pattern generator	880130	13.30	2.33
Autonomous I/O controller	880163	4.85	0.85
	880184	15.30	2.68
Pitch control for CD players	880165	11.50	2.01

1989

JANUARY 1989			
Fax interface for Atari ST and Archimedes	880109	7.35	1.29
MIDI control unit	880178-1	9.05	1.58
	880178-2	6.65	1.16
Low-budget capacitance meter	UPBS-1	1.95	0.34

FEBRUARY 1989

Digital Model Train	87291-1	4.20	0.74
Touch key organ	886077	10.05	1.76
VHF receiver	886127	7.45	1.30

MARCH 1989

Power line modem	880189	6.10	1.07
Centronics buffer	890007-1	19.60	3.43
	890007-2	2.15	0.38
	890007-3	8.35	1.46

APRIL 1989

Digital Model Train	87291-2/3	4.30	0.75
Function generator	UPBS-1	1.95	0.34
Triplet	890013-1	6.65	1.16
	890013-2	6.80	1.19
Multi-point IR control	890019-1	3.45	0.60
	890019-2	4.05	0.71
Video recording amplifier	ELV project		

MAY 1989

RDS decoder	880209	4.50	0.79
Digital Model Train (4)	87291-4	5.25	0.92
Analogue multimeter	890035	12.50	2.19
DTMF system decoder	890060	6.50	1.14
Sine-wave converter	UPBS-1	1.95	0.34
S-VHS-to-RGB converter	ELV project		

JUNE 1989

8-digit frequency meter	880128	11.50	2.01
Echo unit	ELV project		

JULY/AUGUST 1989

MIDI keyboard interface decoder board	890105-1	7.00	1.23
controller board	890105-2	5.25	0.92
Tracking tester	ELV project		
Floppy disk monitor	890078	4.25	0.74
Function generator	UPBS-1	1.95	0.34
Sound level meter	894024	3.50	0.61

SEPTEMBER 1989

Digital Model Train	87291-4	6.70	1.17
Stereo viewer	890044	5.57	0.97
Centronics monitor	890123	5.50	0.96
Resonance meter	886071	3.90	0.68

OCTOBER 1989

Inductance meter	890119	7.25	1.27
Logic analyser with Atari ST	890126	5.25	0.92
CD error detector	890131	6.00	1.05
RGB-to-CVBS converter	ELV project		

NOVEMBER 1989

Digital Model Train (8)	87291-5	43.50	7.62
Extension card for Archimedes	890108	18.00	3.15
Extension card for Archimedes, incl. PAL and diskette	890108-9	29.25	5.12
3 1/2-digit LED SMD voltmeter	890117	3.75	0.66

DECEMBER 1989

Digital Model Train	87291-7	8.75	1.53
EPROM simulator	890166	10.00	1.75
Hard disk monitor	890186	11.00	1.93
IC tester	ELV project		
LF/HF signal tracer	890183	8.00	1.40
Solid-state preamp	890170-1*	11.75	2.06
	890170-3*	9.00	1.58
Transistor curve tracer	890177	5.75	1.00

1990

JANUARY 1990			
Video mixer (1)	87304-1	27.25	4.77
Mini EPROM programmer	890164	7.00	1.23
All solid-state preamplifier	890170-2*	15.75	2.76
Simple AC milli-voltmeter	900004	6.50	1.14
1 GHz frequency meter	894110	21.75	3.81
card for PCs			

*The four PCBs required for the preamplifier (2 × 890170-1; 1 × 890170-2 and 1 × 890170-3) are available as a package, ref. 890170-9, at a discounted price of £41.00 + £7.18 VAT + P&P, a saving of £7.25.

FEBRUARY 1990

Initialisation aid for printers	900007	14.25	2.49
Digital Model Train (11)	87291-8	4.50	0.79
Dark-room clock	894027	6.50	1.14
Reflex MW AM receiver	UPBS-1	1.95	0.34
Video mixer (2)	87304-2	16.25	2.84
Capacitance meter	900012	7.25	1.27

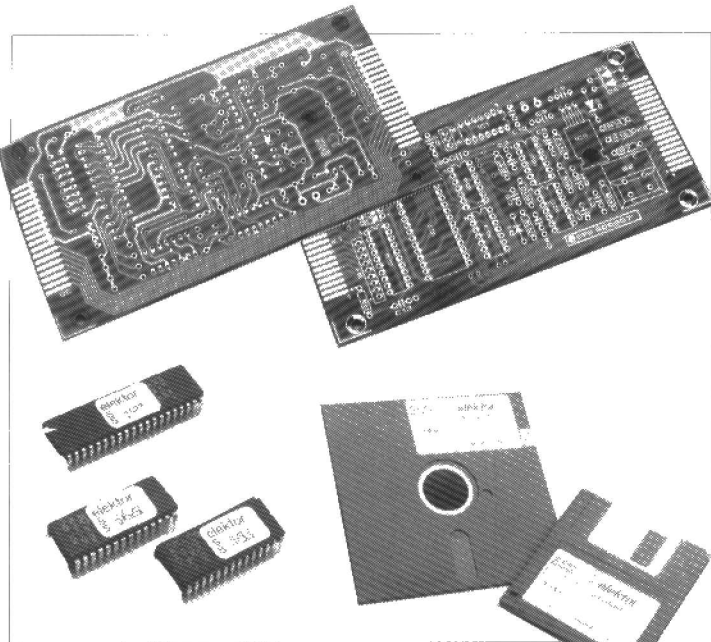
MARCH 1990

Audio/video modulator	ELV project		
Digital model train (12)	87291-9	3.50	0.61
IC monitor	896140	7.50	1.31
Power line monitor	900025	4.75	0.83
Replacement for TCA280A	894078	5.50	0.96
Video mixer (3)***	87304-3	35.50	2.84

*** PLEASE NOTE that the price of PCB 87304-3 was erroneously given as £16.25 plus £2.84 VAT in earlier Product Overviews.

APRIL 1990

BBD sound effects unit	900010	7.75	1.36
Digital model train (13)	87291-10	4.00	0.70
Q meter	900031	6.00	1.05



RS-232 splitter	900017-1	7.25	1.27
	900017-2	4.50	0.79
Video line selector	900032	6.50	1.14
Wiring allocation tester		ELV project	

MAY 1990

Acoustic temperature monitor	UPBS-1	1.95	0.34
Budget sweep/function generator	900040	7.00	1.23
Centronics ADC/DAC	900037D	15.25	2.67
PC servicing card		ELV project	
Transistor characteristic plotting	900058	4.75	0.83

JUNE 1990

Electronic load simulator	900042	12.00	2.10
MIDI master keyboard		Doepler Elektronik	
Mini EPROM viewer	900030	18.00	3.15
Power zener diode	UPBS 1	1.95	0.34
Remotely controlled stroboscope		ELV project	

JULY/AUGUST 1990

Battery tester		ELV project	
Compact 10A power supply	900045	11.50	2.01
Intermediate projects	UPBS-1	1.95	0.34
Mini FM transmitter*	896118	4.25	0.74
Sound demodulator for satellite-TV receivers	900057	3.75	0.66
Audio power indicator	904004	3.75	0.66
Four-monitor driver for PCs	904067	5.25	0.92
SMT prototyping board	904035	3.50	0.61

* can not be supplied to readers in the UK

SEPTEMBER 1990

High-current hfe tester	900078	5.50	0.96
Infra-red remote control	904085/86	6.75	1.18
Sound generator		ELV project	

OCTOBER 1990

µP-controlled telephone exchange	900081	18.00	3.15
S-VHS/CVBS-to-RGB converter	900055	12.25	2.14

NOVEMBER 1990

400-watt laboratory PSU	900082	11.00	1.93
Active mini subwoofer	900122-1	6.00	1.05
Dubbing mixer EV7000		ELV project	
Medium-power audio amplifier	900098	9.00	1.58
Programmer for the 8751	900100	7.00	1.23
PT100 thermometer	900106	5.00	0.88

DECEMBER 1990

Active mini subwoofer	900122-2	5.25	0.92
MilliOhmmeter	910004	5.00	0.88
Phase check for audio systems	900114 1/2	8.00	1.40
PC-controlled Video-text decoder (1)		ELV project	
Signal suppressor for all-solid state preamp	904024	3.75	0.66
Audio input selector	904039	6.25	1.09
Search time monitor	904052	4.00	0.70

1991

JANUARY 1991			
Logic analyser (1): - Busboard	900094-4	9.00	1.58
PC controlled Video-text decoder (2)		ELV project	
SWR meter	900013	3.00	0.53

FEBRUARY 1991

Logic analyser (2): - RAM board	900094-2	15.75	2.76
- Probe board	900094-3	4.25	0.74
Multifunction measurement card for PCs	900124-1	24.00	4.20
MIDI-to-CV interface		Doepler Elektronik	
RDS decoder: - demodulator board	880209	4.50	0.79
- processor board	900060	6.50	1.14

MARCH 1991

The complete preamplifier: - input board	890169-1	22.20	3.89
- main board	890169-2	33.50	5.86
Electronic exposure timer	900041	9.25	1.62
PC-controlled weather station (1)	900124-3	3.75	0.66
2-m band converter	900006-1	4.25	0.74

APRIL 1991

Logic analyser (3): - control board	900094-5	15.75	2.76
MIDI programme changer	900138	5.75	1.00
8-bit I/O for Atari	910005	10.50	1.84
6-m band transverter	910010	9.75	1.71
Wattmeter - meter board	910011-1	6.50	0.96
- display board	910011-2	3.50	0.61
Moving-coil (MC) preamplifier	910016	9.00	1.58
Dimmer for halogen lights - transmitter	910032-1	3.50	0.61
- receiver	910032-2	3.75	0.66
PC-controlled semiconductor tester		ELV project	

MAY 1991

8032/8052 Computer	910042	10.25	1.79
Battery tester	906056	3.50	0.61
Laser (1)		ELV project	
Moving-magnet (MM) preamplifier	900111	5.75	1.01
Universal I/O interface for IBM PCs	910046	9.25	1.62

JUNE 1991

Universal battery charger	900134	8.00	1.40
Logic analyser - 4 - power supply board	900094-7	7.50	1.31
- Atari interface	900094-6	10.75	1.88
- IBM interface	900094-1	12.25	2.14
Digital phase meter (set of 3 PCBs)	910045-1/2/3	22.25	3.89
Light transceiver	UPBS-1	1.95	0.34
Variable AC PSU	900104	5.25	0.92
Light switch w. TV IR r/c	910048	4.75	0.83
RTC for Atari ST	910006	5.25	0.92
Stepper motor board - 1	910054-1	24.75	4.33
- PC insertion card			

JULY/AUGUST 1991

Multifunction I/O for PCs	910029	20.75	3.63
B/W video digitizer	910053	19.25	3.37
Stepper motor board - 2	910054-2	24.25	4.23
- power driver board			
Laser - 3		ELV project	
LED voltmeter	914005	4.75	0.83
Wien bridge	914007	3.50	0.61
Angled bus extension card for PCs	914030	10.25	1.79
Sync separator	914077	3.75	0.66

ROMS — EPROMS — PALS — MICROCONTROLLERS

Article/Project	Issue	ESS no.	Description	Price (£)	VAT (£)
Universal Terminal	11/83	525	1 × 2732	9.00	1.58
Wind direction indicator	1/84	526	1 × 2716	7.30	1.28
Elabyrinth	3/84	527	1 × 2716	7.30	1.28
EPROM copier	5/84	528	1 × 2716	7.30	1.28
Analytical video display	5/84	529	1 × 82523	4.80	0.84
Typewriter interface	6/84	530	2 × 2716	14.60	2.56
µP controlled frequency meter	12/84	531	1 × 2732	9.00	1.58
X Y plotter	4/85	532	1 × 2732	9.00	1.58
Programmable timer	5/85	535	1 × 2732	9.00	1.58
GHz prescaler	7/85	536	1 × 2732	9.00	1.58
Automate your model railway	book	537	1 × 2716	7.30	1.28
Marine computer	10/85	538	1 × 2716	7.30	1.28
Jumbo clock	12/85	539	1 × 2716	14.60	2.56
Graphics card	3/86	543	2 × 825123	9.80	1.72
Printer buffer	5/86	545	1 × 2716	7.30	1.28
EPROM programmer for MSX computers	4/87	552UK	1 × 27128	10.00	1.75
Bus interface for high-res LCD screens	12/88	560	1 × 2764	10.00	1.75
Intelligent time standard (I.T.S.)	2/88	553	1 × 2764	10.00	1.75
I/O extension card for IBM PCs and compatibles	7-8/88	561	1 × 16L8	8.75	1.53
Multifunction measurement card for PCs	2/91	561	1 × 16L8	8.75	1.53
Centronics interface for slide fader	10/88	562	1 × 16R4	8.75	1.53
µP-controlled radio synthesizer	9/88	564	1 × 27C64	10.00	1.75
Portable MIDI keyboard	11/88	567	1 × 2764	10.00	1.75
Pitch control for CD players	12/88	568	1 × 2764	10.00	1.75
MIDI control unit	1/89	570	1 × 27C64	10.00	1.75
The digital model train	series	572	1 × 2764	10.00	1.75
Darkroom clock	2/90	583	1 × 27128	9.25	1.62
Slave indication unit for I.T.S.	3/88	700	1 × 8748H	15.00	2.63
EPROM emulator	9/87	701	1 × 8748H	15.00	2.63
Micro-controller driven power supply	9/88	702	1 × 8751	47.50	8.31
Autonomous I/O controller	12/88	704	1 × 8751	47.50	8.31
Video mixer	3/90	5861	1 × 2764	10.00	1.75
Four-sensor sunshine recorder	6/90	5921	1 × 27128	10.00	1.75
µP-controlled telephone exchange	10/90	5941	1 × 27128	13.00	2.28
RDS decoder	2/91	5951	1 × 2764	13.00	2.28
MIDI programme changer	4/91	5961	1 × 2764	13.00	2.28
Logic analyser (IBM interface)	6/91	5973	1 × PAL 16L8	7.00	1.23
MIDI-to-CV interface	2/91	5981	1 × 2764	13.00	2.28
Multifunction I/O card for PCs	7-8/91	5991	1 × PAL 16L8	7.00	1.23
Stepper motor board	6/91	6011	1 × PAL 16L8	7.00	1.23
Logic analyser (series)			see under DISKETTES below		
8751 programmer	11/90	7061	1 × 8751	47.50	8.31

DISKETTES

Article/Project	Issue	ESS no.	Disk size	Price (£)	VAT (£)
FAX interface for Atari ST (b/w only)	1/89	102*	3.5-inch	8.00	1.40
FAX interface for Archimedes	1/89	103*	3.5-inch	8.00	1.40
* send us your formatted 3.5 inch diskette					
Digital model train	series	109	5.25-inch	5.75	1.00
Logic Analyser for Atari ST (for monochrome systems only)	10/89	111	3.5 inch	10.00	1.75
Computer-controlled Teletext decoder	10/89	113	5.25-inch	10.00	1.75
Plotter driver	3/90	117	5.25-inch	5.75	1.00
FAX interface for IBM PCs	6/90	119	5.25-inch (2 ×)	7.00	1.23
RAM extension for BBC-B	7-8/89	123	5.25-inch	5.00	0.88
EPROM simulator	12/89	129	5.25-inch	5.75	1.00
RS-232 splitter	4/90	1411	5.25-inch	5.75	1.00
Centronics ADC/DAC	5/90	1421	5.25-inch	5.75	1.00
Transistor characteristic plotting (Atari ST) (for monochrome systems only)	5/90	1431	3.5-inch	6.50	1.14
ROM-copy for BASIC computer	9/90	1441	5.25-inch	6.50	1.14
Multifunction measurement card for PCs	2/91	1461	5.25-inch	6.50	1.14
8751 programmer	11/90	1471	5.25-inch	6.50	1.14
PT100 thermometer	11/90	1481	5.25-inch	6.50	1.14
Logic analyser: IBM software & GAL IC	7-8/91	1491	5.25-inch	16.50	2.89
Logic analyser: Atari software & GAL IC	7-8/91	1501	3.5-inch	16.50	2.89
PC-controlled weather station (1)	3/91	1551	5.25-inch	6.50	1.14
8-bit I/O interface for Atari ST	4/91	1571	3.5-inch	6.50	1.14
Tektronix/Intel file converter	4/91	1581	5.25-inch	6.50	1.14
B/W video digitizer for Archimedes	7-8/91	1591	3.5-inch	9.50	1.66
Real-time clock for Atari ST	6/91	1621	3.5 inch	6.50	1.14

SELF-ADHESIVE FRONT PANEL FOILS

Article/Project	Issue	Order code	Price (£)	VAT (£)
Top-of-the-range preamplifier	12/88	86111-F1	5.60	0.98
Autoranging DMM	6/88	87099-F	2.88	0.50
Preamplifier for purists	10/88	880132-F	8.25	1.44
Autonomous I/O controller	1/89	880184-F	8.50	1.49
Analogue multimeter	5/89	890035-F	7.90	1.38
All-solid state preamplifier	1/90	890170-F1	16.75	2.93
		890170-F2	9.25	1.62
LF/HF signal tracer	12/89	890183-F	8.50	1.49
Simple AC millivoltmeter	1/90	900004-F	Not available	
Video mixer	3/90	87304-F	16.50	2.89
Q meter	4/90	900031-F	11.50	2.01
Budget sweep/function generator	5/90	900040-F	10.00	1.75
High-current hfe tester	9/90	900078-F	14.00	2.45
400-watt laboratory PSU	11/90	900082-F	17.50	3.06
MilliOhmmeter	12/90	910004-F	14.00	2.10
The complete preamp	3/91	890169-F	7.50	1.31
Wattmeter	4/91	910011-F	8.25	1.44
Universal NiCd battery charger	6/91	900134-F	5.50	0.96
Logic analyser (series)		900094-F	8.75	1.53
Digital phase meter	6/91	910045-F	10.00	1.75
Variable AC power supply	6/91	900104-F	14.00	2.45

PROFILE OF MICRO AMPS

by Bernard Hubbard



A COMPANY, opened some time ago by two former University of Surrey students, is breaking new ground in the field of microprocessor hardware and software development.

David Kyte and Richard Marriott established the company only a few miles from the university and are busily becoming the leading technical edge in various areas of development under the name Micro AMPS.

For the former students, it was Surrey University that gave them a flying start to business when, two years ago, a spin-off company placed an order for delivery just two months later.

David told *Elektor Electronics*: "We had to produce a DSP based Vocoder for a satellite system for SPEKA and we had until early February to produce the board that was to be dispatched to Indonesia shortly after that date. We met the deadline and Micro AMPS was in business".

Ironically, the original specification did not entirely satisfy the Indonesian client's requirements and so further development was necessary. The following April, 10 boards, incorporating the additional development, were shipped to the customer.

Having cut its teeth on this contract, the fledgling company was promised a flow of further orders. However, to date this has failed to materialize and instead the young company has been busy spreading its expertise to a wider customer base.

"Our object," says David, "is to increase the profitability per individual and we see licensing coupled with sub-contracting manufacture as the way forward. We are, in fact, a contract research and development unit. We have formulated our strategy, rightly or wrongly. We aim to be involved in the explosive personal satellite communications growth in the next few years".

Initially, Micro AMPS began in David Kyte's spare bedroom. Unfortunately, the company outgrew this space just at the same time as Mrs Kyte was expecting her first baby and the company moved into a converted brick kiln on the outskirts of Cranleigh—see photograph. The family business link has been retained, however, for Mrs Kyte keeps the books after re-training as a bookkeeper/administrator.

Today, the company employs 31/2 people (Mrs Kyte is part-time), and

the company's customer list is beginning to read like a Who's Who of British blue-chip electronics business in the south of England.

In its first year, the young business had a turnover of over £125,000 and hope to increase this to £280,000 to £300,00 for the current year.

Says David: "Half our enquiries are now coming from overseas, from countries as far afield as Hong Kong, Thailand and Finland. Usually, we deal with the business direct, but recently we appointed a distributor in Italy. We have regular enquiries from people who wish to become our distributors, but we are looking for the right people to handle our business. We would rather keep on looking than appoint just anybody".

Members of the Micro AMPS team were enjoying good business growth until the autumn of last year when two of their major customers went into liquidation. Although this did not mean a direct financial loss, it did remove a part of the flow of regular project work.

Locality has been very important to the business for, as David explains: "The very fact that the University of Surrey is on the doorstep has led to the situation where customers drop equipment off at 6 p.m. on their way home and call back at 9 a.m. the following morning to collect the modified boards.

"We are currently working very hard, often until late at night to ensure we carry out project work on time for customers", says David.

Despite the present general economic difficulties, the company is making a modest profit, which should increase as more and more of the licensing fees begin to build up.

Recent work for Rank Xerox should also start sending more money into the Micro AMPS coffers as sales of Rank's new printer begin to mount. "They are forecasting substantial sales in the first year, and we receive a royalty on each unit sold", says David.

The extension of the contract development customer base comes from recommendations from satisfied customers. However, Micro AMPS is not content to leave it there, but is increasingly concentrating on the marketing of its products.

Among the ever-growing list of hardware and software products the company offers are:

ICE 751 – a low-cost development

and programming platform for the Philips 87C751 microcontroller. The ICE 751 uses a bond-out version of the 87C751 processor connected to 1) a dual port memory which emulates the on-chip EPROM and 2) an emulation cable that can be plugged into the user's target board. The ICE 751 has an RS232 buffered serial port to pass data to, and accept commands from, a host PC. Once the application is developed, the emulation cable is removed and an 87C751 device can be programmed using the on-board programmer.

ICE 51 – a low-cost In-Circuit Emulator for the 8031 family of processors. The board offers many features normally only found on expensive ICE systems. Its low power requirements enables the board to be powered from the target system. 32 kbyte of RAM is provided internally within the processor which may be used as internal program, external data memory or a combination of the two. A small monitor program resides in the ICE which is driven by a PC serial port. The PC software provides powerful debugging facilities. All of the internal RAM is available to the user for application software. The host provides tools to single-step through a program, disassemble code, set break points, down- and up-load Intel hex format files, interrogate and assign registers, internal and external, and code memory.

PEB 552 – a low-cost, easily customized single extended eurocard for the Philips high performance PCB80C522 microcontroller. The PEB 552 can be programmed in high level languages such as Forth, Basic, C, PLM, or conventional assemblers. A major design feature is its large, 11x38 wire-wrap prototyping area on a 0.1" grid. All of the microprocessor signals, I/O decoding and an uncommitted 96-pin connector are conveniently routed to the edge of the prototyping area. The fully expanded memory offers 124 bytes of RAM and EPROM and 4 kbytes of reconfigurable decoded I/O space. The PEB 552 has been designed to, program EPROMs or the 87C552 processor via an on-board adaptor.

Micro AMPS, 66 Smithbrook Kilns, Cranleigh, Surrey GU6 8JJ; Telephone (0483) 268999; Fax (0483) 268397.

A list of all PCBs, software products and front panels available through the Readers Services is published in the March, May, September and December issues of *Elektronika*.

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